



# **Agilent EasyEXPERT**

## **Application Library Reference**

# Notices

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## Manual Part Number

B1500-90050

## Edition

Edition 1, August 2006

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## In This Document

Agilent EasyEXPERT software contains the application library which supports the characteristic measurements of CMOS devices, TFT, BJT, diode, resistor, capacitor, varactor, memory, nanotechnology devices such as CNT FET, and so on. The application library includes more than one hundred test definitions. And they are classified into the following categories.

This document consists of the chapters corresponding to the categories. And each chapter lists and describes all test definitions belonging to the category.

1. BJT
2. CMOS
3. Discrete
4. Memory
5. Mixed Signal
6. Nano Tech
7. Power Device
8. Reliability
9. Structure
10. TFT
11. Utility

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### NOTE

#### Application Library

The application library is a set of test definitions effective for the EasyEXPERT application test execution mode. The application test can be performed by selecting a test definition and setting the test condition for the actual DUT (device under test). And the setup can be saved as the dedicated test setup for the DUT.

All test definitions are just sample. If the samples damage your devices, Agilent Technologies is NOT LIABLE for the damage.

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## What is described in the reference sections

Reference section contains detailed description of test definitions. The test definitions are listed in alphabetical order. Each entry explains one test definition and provides the information following to the next terms. Some sections may not follow to some terms and may follow to the terms not in this table.

<b>Term</b>	<b>Description</b>
Description	Brief explanation of the test definition.
Device Under Test	DUT name. The number of terminals, the connection information, and the other information may be included.
Device Parameters	Lists the parameters changeable in the Device Parameters area of the EasyEXPERT Application Test screen.
Test Parameters	Lists the parameters changeable in the Test Parameters area of the EasyEXPERT Application Test screen.
Extended Test Parameters	Lists the parameters changeable in the dialog box opened by clicking the Extended Setup button.
Measurement Parameters	Lists the parameters measured by this test definition.
User Function and Analysis Function	Lists the parameters used for the user function or the analysis function.
X-Y Plot or X-Y Graph	Lists the parameters to be displayed in the X-Y Graph Plot area, List Display area, or Parameters area on the Data Display window.
List Display	
Parameters Display Area	
Auto Analysis	Lists the parameters used for the auto analysis function.
Test Output: X-Y Graph	Lists the parameters defined in the Test Output tab screen of the Test Definition window. The parameters will be displayed in the X-Y Graph Plot area, List Display area, or Parameters area on the Data Display window.
Test Output: List Display	
Test Output: Parameters	

## Revision number

The test definitions are managed by using the revision number shown below.

<b>Revision Number</b>	<b>Description</b>
A.01.xx	Test definitions supported by EasyEXPERT A.01.xx and later.
A.01.20	Test definitions updated from A.01.xx or supported by EasyEXPERT A.02.00 and later.
A.02.00	This number is used by the Subsite move test definition only.

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# 1 BJT

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28. Ic-Vc Pulse Ib[3]: Ic-Vc characteristics, 3-terminal, Ib sweep, SMU Pulse (A.01.11)
29. Ic-Vc Pulse Vb: Ic-Vc characteristics, Vb sweep, SMU Pulse (A.01.11)
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## ***1.1 BC Diode Fwd: Base-Collector junction forward characteristics (A.01.20)***

### [Description]

Measures the Base-Collector junction forward characteristics of BJT. Emitter and Substrate are opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Lb: Base length

Wb: Base width

Temp: Temperature

Imax: Current compliance

### [Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, constant voltage output

### [Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base current Ibase

### [User Function]

$IcPerArea = I_{collector} / Lb / Wb$

$IbPerArea = I_{base} / Lb / Wb$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LOG)

Y2 axis: Collector current Icollector (LINEAR)

Y3 axis: Base current Ibase (LOG)

Y4 axis: Base current Ibase (LINEAR)

## ***1.2 BC Diode Reverse: Base-Collector junction reverse characteristics (A.01.20)***

### [Description]

Measures the Base-Collector junction reverse characteristics of BJT. Emitter and Substrate are opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Lb: Base length

Wb: Base width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

IcLimit: Collector current compliance

Base: SMU connected to Base terminal, constant voltage output

### [Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base current Ibase

### [User Function]

$IcPerArea = I_{collector} / Lb / Wb$

$IbPerArea = I_{base} / Lb / Wb$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LOG)

Y2 axis: Base current Ibase (LOG)

### ***1.3 BVcbo: Base-Collector junction breakdown voltage (A.01.20)***

[Description]

Measures the collector current vs collector voltage characteristics, and extracts the Base-Collector junction breakdown voltage (BVcbo). Emitter and Substrate are opened.

[Device Under Test]

Bipolar transistor

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Lb: Base length

Wb: Base width

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

Ic@BVcbo: Collector current to decide the breakdown

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, constant voltage output

[Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

BaseMinRng: Minimum range for the base current measurement

[Measurement Parameters]

Collector current Icollector

Base current Ibase

For the all terminals, the SMU current compliance is set to Ic@BVcbo\*1.1.

[User Function]

IcPerArea=Icollector/Lb/Wb

IbPerArea=Ibase/Lb/Wb

[Analysis Function]

BVcbo=@L1X (X interrupt of Line1)

[X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LOG)

Y2 axis: Base current Ibase (LOG)

[Parameters Display Area]

Base-Collector junction breakdown voltage BVcbo

[Auto Analysis]

Line1: Vertical line through Y1 data at Icollector=Ic@BVcbo



## ***1.4 BVcei: Emitter-Collector breakdown voltage (A.01.20)***

### [Description]

Measures the collector current vs collector voltage characteristics, and extracts the Emitter-Collector junction breakdown voltage (BVcei). Substrate is opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Ic@BVcei: Collector current to decide the breakdown

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, constant current output

Ib: Base current

VbLimit: Base voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Emitter current Iemitter

Base voltage Vbase

For the all terminals, the SMU current compliance is set to  $Ic@BVcei*1.1$ .

### [User Function]

$IcPerArea = I_{collector} / Le / We$

$IePerArea = I_{emitter} / Le / We$

### [Analysis Function]

$BVcei = @L1X$  (X interrupt of Line1)

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LOG)

Y2 axis: Emitter current Iemitter (LOG)

### [Parameters Display Area]

Emitter-Collector junction breakdown voltage BVcei

[Auto Analysis]

Line1: Vertical line through Y1 data at  $I_{collector}=I_c@BV_{cei}$

## ***1.5 BVceo: Emitter-Collector breakdown voltage, opened base (A.01.20)***

### [Description]

Measures the collector current vs collector voltage characteristics, and extracts the Emitter-Collector junction breakdown voltage (BVceo). Base and Substrate are opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Ic@BVceo: Collector current to decide the breakdown

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Emitter current Iemitter

For the all terminals, the SMU current compliance is set to Ic@BVceo\*1.1.

### [User Function]

IcPerArea=Icollector/Le/We

IePerArea=Iemitter/Le/We

### [Analysis Function]

BVceo=@L1X (X interrupt of Line1)

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LOG)

Y2 axis: Emitter current Iemitter (LOG)

### [Parameters Display Area]

Emitter-Collector junction breakdown voltage BVceo

### [Auto Analysis]

Line1: Vertical line through Y1 data at Icollector=Ic@BVceo

## ***1.6 BVebo: Emitter-Base breakdown voltage (A.01.20)***

### [Description]

Measures the emitter current vs emitter voltage characteristics, and extracts the Emitter-Base junction breakdown voltage (BVebo). Collector and Substrate are opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Ie@BVebo: Emitter current to decide the breakdown

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

Base: SMU connected to Base terminal, constant voltage output

### [Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

EmitterMinRng: Minimum range for the emitter current measurement

BaseMinRng: Minimum range for the base current measurement

### [Measurement Parameters]

Emitter current Iemitter

Base current Ibase

For the all terminals, the SMU current compliance is set to Ie@BVebo\*1.1.

### [User Function]

$IePerArea = Iemitter / Le / We$

$IbPerArea = Ibase / Le / We$

### [Analysis Function]

BVebo=@L1X (X interrupt of Line1)

### [X-Y Plot]

X axis: Emitter voltage Vemitter (LINEAR)

Y1 axis: Emitter current Iemitter (LOG)

Y2 axis: Base current Ibase (LOG)

### [Parameters Display Area]

Emitter-Base junction breakdown voltage BVebo

### [Auto Analysis]

Line1: Vertical line through Y1 data at Iemitter=Ie@BVebo

## ***1.7 CS Diode Fwd: Collector-Substrate junction forward characteristics (A.01.20)***

### [Description]

Measures the Collector-Substrate junction forward characteristics of BJT. Base and Emitter are opened.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Lc: Collector length

Wc: Collector width

Temp: Temperature

Imax: Current compliance

### [Test Parameters]

IntegTime: Integration time

Subs: SMU connected to Substrate, primary sweep voltage output

VsubsStart: Sweep start voltage for Substrate

VsubsStop: Sweep stop voltage for Substrate

VsubsStep: Sweep step voltage for Substrate

Collector: SMU connected to Collector terminal, constant voltage output

### [Extended Test Parameters]

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Substrate current Isubs

Collector current Icollector

### [User Function]

$IcPerArea = Icollector / Lc / Wc$

$IsubsPerArea = Isubs / Lc / Wc$

### [X-Y Plot]

X axis: Substrate voltage Vsubs (LINEAR)

Y1 axis: Substrate current Isubs (LINEAR)

Y2 axis: Substrate current Isubs (LOG)

Y3 axis: Collector current Icollector (LINEAR)

Y4 axis: Collector current Icollector (LOG)

## ***1.8 CS Diode Reverse: Collector-Substrate junction reverse characteristics (A.01.20)***

### [Description]

Measures the Collector-Substrate junction reverse characteristics of BJT. Base and Emitter are opened.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Lc: Collector length

Wc: Collector width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Subs: SMU connected to Substrate, primary sweep voltage output

VsubsStart: Sweep start voltage for Substrate

VsubsStop: Sweep stop voltage for Substrate

VsubsStep: Sweep step voltage for Substrate

IsubsLimit: Substrate current compliance

Collector: SMU connected to Collector terminal, constant voltage output

### [Extended Test Parameters]

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Substrate current Isubs

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Lc / Wc$

$IsubsPerArea = I_{subs} / Lc / Wc$

### [X-Y Plot]

X axis: Substrate voltage Vsubs (LINEAR)

Y1 axis: Substrate current Isubs (LOG)

Y2 axis: Collector current Icollector (LOG)

## 1.9 Ctc-Freq Log: Ctc-f characteristics (A.01.20)

### [Description]

Measures BJT's characteristics of base-to-collector capacitance (Ctc, linear) vs frequency (f, log). The measurement frequency is 10 points per decade.

### [Device Under Test]

Bipolar transistor, 4 terminals  
Connect CMU High and CMU Low to the collector terminal and base terminal respectively. For the emitter and substrate, connect GNDU.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Polarity: NPN (CMU forces the specified value) or PNP (CMU forces the negative specified value)

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Base: CMU connected between Base and Collector

FreqStart: Sweep start frequency

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Vcb: Collector-Base voltage, constant voltage output

### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency Freq (LOG)

Y1 axis: Base-Collector capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[List Display]

Frequency Freq  
Base-Collector capacitance (parallel capacitance) Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Collector voltage Vcollector

[Test Output: X-Y Graph]

X axis: Frequency FreqList (LOG)  
Y1 axis: Base-Collector capacitance (parallel capacitance) CpList (LINEAR)  
Y2 axis: Conductance GList (LINEAR)

[Test Output: List Display]

Frequency FreqList  
Base-Collector capacitance (parallel capacitance) CpList  
Conductance GList  
Series capacitance CsList  
Series resistance RsList  
Parallel resistance RpList  
Dissipation factor DList  
Reactance XList  
Impedance ZList  
Phase ThetaList  
Collector voltage VcList



## ***1.10 Ctc-Vc: Ctc-Vcb characteristics (A.01.20)***

### [Description]

Measures the Base-Collector capacitance (Ctc), and plots the Ctc-Vcb characteristics.

### [Device Under Test]

Bipolar transistor

Connect Base to the CMU Low, Collector to the CMU High, and the other terminals to the GNDU.

### [Device Parameters]

Polarity: NPN (CMU forces the specified value) or PNP (CMU forces the negative specified value).

Le: Emitter length

We: Emitter width

Lb: Base length

Wb: Base width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Base: CMU connected between Base and Collector (CV sweep measurement)

VcbStart: DC bias start voltage

VcbStop: DC bias stop voltage

VcbStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Vcb=Vcollector$

$CtcPerArea=Cp/Lb/Wb$

### [Analysis Function]

$Cj0=@L1Y1$  (Y interrupt of Line1)

### [X-Y Graph]

X axis: Base-Collector voltage Vcb (LINEAR)

Y1 axis: Base-Collector capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[List Display]

Base-Collector voltage  $V_{cb}$   
Base-Collector capacitance (parallel capacitance)  $C_p$   
Conductance  $G$   
Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase Theta

[Parameter Display Area]

Zero bias capacitance  $C_{j0}$

[Auto Analysis]

Line1: Horizontal line through Y1 data at  $V_{cb}=0$

## ***1.11 Cte-Ve: Cte-Veb characteristics (A.01.20)***

### [Description]

Measures the Base-Emitter capacitance (Cte), and plots the Cte-Veb characteristics.

### [Device Under Test]

Bipolar transistor

Connect Base to the CMU Low, Emitter to the CMU High, and the other terminals to the GNDU.

### [Device Parameters]

Polarity: NPN (CMU forces the specified value) or PNP (CMU forces the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Base: CMU connected between Base and Emitter (CV sweep measurement)

VebStart: DC bias start voltage

VebStop: DC bias stop voltage

VebStep: DC bias step voltage

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Veb=Vemitter$

$CtePerArea=Cp/Le/We$

### [Analysis Function]

$Cj0=@L1Y1$  (Y interrupt of Line1)

### [X-Y Graph]

X axis: Base-Emitter voltage Veb (LINEAR)

Y1 axis: Base-Emitter capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

### [List Display]

Base-Emitter voltage Veb

Base-Emitter capacitance (parallel capacitance) Cp

Conductance G

Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $\Theta$

[Parameter Display Area]  
Zero bias capacitance  $C_{j0}$

[Auto Analysis]  
Line1: Horizontal line through Y1 data at  $V_{eb}=0$

## ***1.12 Cts: Cts-Vsc characteristics (A.01.20)***

### [Description]

Measures the Collector-Substrate capacitance (Cts), and plots the Cts-Vsc characteristics.

### [Device Under Test]

Bipolar transistor

Connect Collector to the CMU Low, Substrate to the CMU High, and the other terminals to the GNDU.

### [Device Parameters]

Polarity: NPN (CMU forces the specified value) or PNP (CMU forces the negative specified value).

Le: Emitter length

We: Emitter width

Lc: Collector length

Wc: Collector width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Subs: CMU connected between Collector and Substrate (CV sweep measurement)

VscStart: DC bias start voltage

VscStop: DC bias stop voltage

VscStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Vsc=Vsubs$

$CtsPerArea=Cp/Lc/Wc$

### [Analysis Function]

$Cj0=@L1Y1$  (Y interrupt of Line1)

### [X-Y Graph]

X axis: Collector-Substrate voltage Vsc (LINEAR)

Y1 axis: Collector-Substrate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[List Display]

Collector-Substrate voltage  $V_{sc}$   
Collector-Substrate capacitance (parallel capacitance)  $C_p$   
Conductance  $G$   
Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase Theta

[Parameter Display Area]

Zero bias capacitance  $C_{j0}$

[Auto Analysis]

Line1: Horizontal line through Y1 data at  $V_{sub}(=V_{sc})=0$

### ***1.13 EB Diode Fwd: Emitter-Base junction forward characteristics (A.01.20)***

[Description]

Measures the Emitter-Base junction forward characteristics of BJT. Collector and Substrate are opened.

[Device Under Test]

Bipolar transistor

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

Imax: Current compliance

[Test Parameters]

IntegTime: Integration time

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

Base: SMU connected to Base terminal, constant voltage output

[Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

EmitterMinRng: Minimum range for the emitter current measurement

BaseMinRng: Minimum range for the base current measurement

[Measurement Parameters]

Emitter current Iemitter

Base current Ibase

[User Function]

IePerArea=Iemitter/Le/We

IbPerArea=Ibase/Le/We

[X-Y Plot]

X axis: Emitter voltage Vemitter (LINEAR)

Y1 axis: Emitter current Iemitter (LINEAR)

Y2 axis: Emitter current Iemitter (LOG)

Y3 axis: Base current Ibase (LINEAR)

Y4 axis: Base current Ibase (LOG)

## ***1.14 EB Diode Rev: Emitter-Base junction reverse characteristics (A.01.20)***

### [Description]

Measures the Emitter-Base junction reverse characteristics of BJT. Collector and Substrate are opened.

### [Device Under Test]

Bipolar transistor

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

IeLimit: Emitter current compliance

Base: SMU connected to Base terminal, constant voltage output

### [Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

EmitterMinRng: Minimum range for the emitter current measurement

BaseMinRng: Minimum range for the base current measurement

### [Measurement Parameters]

Emitter current Iemitter

Base current Ibase

### [User Function]

$I_{ePerArea} = I_{emitter} / Le / We$

$I_{bPerArea} = I_{base} / Le / We$

### [X-Y Plot]

X axis: Emitter voltage Vemitter (LINEAR)

Y1 axis: Emitter current Iemitter (LOG)

Y2 axis: Base current Ibase (LOG)



## ***1.15 G-Plot ConstVce Pulse: Ic-Vb characteristics, Vce=const, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs base voltage characteristics. The SMU pulse is used for the Collector voltage output.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

PulsePeriod: Pulse period

PulseWidth: Pulse width

BaseValue: Pulse base value

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

### [X-Y Plot]

X axis: Base voltage Vbase (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.16 G-Plot ConstVce Pulse[3]: Ic-Vb characteristics, Vce=const, 3-terminal, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs base voltage characteristics. The SMU pulse is used for the Collector voltage output.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

PulsePeriod: Pulse period

PulseWidth: Pulse width

BaseValue: Pulse base value

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

### [X-Y Plot]

X axis: Base voltage Vbase (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.17 G-Plot ConstVce: Gummel characteristics, Vce=constant (A.01.20)***

### [Description]

Measures the collector current vs base voltage characteristics and the base current vs base voltage characteristics, extracts the current amplification factor hfe, and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base current Ibase

### [User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$hfeMax = \max(hfe)$

### [X-Y Plot]

X axis: Base voltage Vbase (LINEAR)

Y1 axis: Base current Ibase (LOG)

Y2 axis: Collector current Icollector (LOG)

Y3 axis: Current amplification factor hfe (LINEAR)

### [Parameters Display Area]

Current amplification factor maximum value hfeMax

## ***1.18 G-Plot ConstVce[3]: Gummel characteristics, Vce=constant, 3-terminal (A.01.20)***

### [Description]

Measures the collector current vs base voltage characteristics and the base current vs base voltage characteristics, extracts the current amplification factor hfe, and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base current Ibase

### [User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$hfeMax = \max(hfe)$

### [X-Y Plot]

X axis: Base voltage Vbase (LINEAR)

Y1 axis: Base current Ibase (LOG)

Y2 axis: Collector current Icollector (LOG)

Y3 axis: Current amplification factor hfe (LINEAR)

### [Parameters Display Area]

Current amplification factor maximum value hfeMax

### ***1.19 G-Plot $V_{bc}=0V$ Pulse: $I_c$ - $V_e$ characteristics, $V_{bc}=0$ , SMU Pulse (A.01.11)***

[Description]

Measures the collector current vs emitter voltage characteristics. The SMU pulse is used for the Emitter voltage output.

[Device Under Test]

Bipolar transistor, 4 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

Base: SMU connected to Base terminal, constant voltage output

Collector: SMU connected to Collector terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

[Extended Test Parameters]

BaseValue: Pulse base value

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Collector current Icollector

[User Function]

$I_{cPerArea} = I_{collector} / L_e / W_e$

[X-Y Plot]

X axis: Emitter voltage  $V_{emitter}$  (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.20 G-Plot Vbc=0V Pulse[3]: Ic-Ve characteristics, Vbc=0, 3-terminal, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs emitter voltage characteristics. The SMU pulse is used for the Emitter voltage output.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Base: SMU connected to Base terminal, constant voltage output

Collector: SMU connected to Collector terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

### [Extended Test Parameters]

BaseValue: Pulse base value

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

### [X-Y Plot]

X axis: Emitter voltage Vemitter (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## 1.21 G-Plot $V_{bc}=0V$ : Gummel characteristics, $V_{bc}=0$ (A.01.20)

### [Description]

Measures the collector current vs emitter voltage characteristics and the base current vs emitter voltage characteristics, extracts the current amplification factor  $h_{fe}$ , and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, constant voltage output

Collector: SMU connected to Collector terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current  $I_{collector}$

Base current  $I_{base}$

### [User Function]

$I_{bPerArea} = I_{base} / Le / We$

$I_{cPerArea} = I_{collector} / Le / We$

$h_{fe} = I_{collector} / I_{base}$

$h_{feMax} = \max(h_{fe})$

### [X-Y Plot]

X axis: Emitter voltage  $V_{emitter}$  (LINEAR)

Y1 axis: Base current  $I_{base}$  (LOG)

Y2 axis: Collector current  $I_{collector}$  (LOG)

Y3 axis: Current amplification factor  $h_{fe}$  (LINEAR)

### [Parameters Display Area]

Current amplification factor maximum value  $h_{feMax}$

## ***1.22 G-Plot $V_{bc}=0V[3]$ : Gummel characteristics, $V_{bc}=0$ , 3-terminal (A.01.20)***

### [Description]

Measures the collector current vs emitter voltage characteristics and the base current vs emitter voltage characteristics, extracts the current amplification factor  $h_{fe}$ , and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, constant voltage output

Collector: SMU connected to Collector terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

### [Extended Test Parameters]

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current  $I_{collector}$

Base current  $I_{base}$

Emitter current  $I_{emitter}$

### [User Function]

$I_{bPerArea} = I_{base} / Le / We$

$I_{cPerArea} = I_{collector} / Le / We$

$h_{fe} = I_{collector} / I_{base}$

$h_{feMax} = \max(h_{fe})$

### [X-Y Plot]

X axis: Emitter voltage  $V_{emitter}$  (LINEAR)

Y1 axis: Base current  $I_{base}$  (LOG)

Y2 axis: Collector current  $I_{collector}$  (LOG)

Y3 axis: Current amplification factor  $h_{fe}$  (LINEAR)

### [Parameters Display Area]

Current amplification factor maximum value  $h_{feMax}$



### ***1.23 hfe-Vbe ConstVce: hfe-Ic characteristics, Vce=constant (A.01.20)***

[Description]

Measures the collector current vs base voltage characteristics and the base current vs base voltage characteristics, extracts the current amplification factor hfe, and plots the hfe-Ic characteristics.

[Device Under Test]

Bipolar transistor, 4 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

[Measurement Parameters]

Collector current Icollector

Base current Ibase

[User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$hfeMax = \max(hfe)$

[Analysis Function]

$Ic@hfeMax = @L1X$  (X intercept of Line1)

[X-Y Plot]

X axis: Collector current Icollector (LOG)

Y1 axis: Current amplification factor hfe (LINEAR)

[Parameters Display Area]

Current amplification factor maximum value  $h_{feMax}$   
Collector current at  $h_{feMax}$   $I_{c@h_{feMax}}$

[Auto Analysis]

Line1: Vertical line through Y1 data at  $h_{fe}=h_{feMax}$

## ***1.24 hfe-Vbe Vbc=0V: hfe-Ic characteristics, Vbc=0 (A.01.20)***

### [Description]

Measures the collector current vs emitter voltage characteristics and the base current vs emitter voltage characteristics, extracts the current amplification factor hfe, and plots the hfe-Ic characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, constant voltage output

Collector: SMU connected to Collector terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base current Ibase

### [User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$hfeMax = \max(hfe)$

### [Analysis Function]

$Ic@hfeMax = @L1X$  (X intercept of Line1)

### [X-Y Plot]

X axis: Collector current Icollector (LOG)

Y1 axis: Current amplification factor hfe (LINEAR)

### [Parameters Display Area]

Current amplification factor maximum value  $h_{feMax}$   
Collector current at  $h_{feMax}$   $I_{c@h_{feMax}}$

[Auto Analysis]

Line1: Vertical line through Y1 data at  $h_{fe}=h_{feMax}$

## ***1.25 Ic-Vc Ib: Ic-Vc characteristics, Ib sweep (A.01.20)***

### [Description]

Measures the collector current vs collector voltage characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, secondary sweep voltage output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

VbLimit: Base voltage compliance

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Collector current Icollector

Base voltage Vbase

Substrate current Isubs

### [User Function]

$IbPerArea = I_{base} / Le / We$

$IcPerArea = I_{collector} / Le / We$

$hfe = I_{collector} / I_{base}$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.26 Ic-Vc Ib[3]: Ic-Vc characteristics, 3-terminal, Ib sweep (A.01.20)***

### [Description]

Measures the collector current vs collector voltage characteristics.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, secondary sweep voltage output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

VbLimit: Base voltage compliance

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current Icollector

Base voltage Vbase

### [User Function]

$IbPerArea = I_{base} / Le / We$

$IcPerArea = I_{collector} / Le / We$

$hfe = I_{collector} / I_{base}$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.27 Ic-Vc Pulse Ib: Ic-Vc characteristics, Ib sweep, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs collector voltage characteristics. The SMU pulse is used for the collector voltage output.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Base: SMU connected to Base terminal, secondary sweep voltage output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

BaseValue: Pulse base value

VbLimit: Base voltage compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

## ***1.28 Ic-Vc Pulse Ib[3]: Ic-Vc characteristics, 3-terminal, Ib sweep, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs collector voltage characteristics. The SMU pulse is used for the collector voltage output.

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Base: SMU connected to Base terminal, secondary sweep voltage output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

BaseValue: Pulse base value

VbLimit: Base voltage compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)



## ***1.29 Ic-Vc Pulse Vb: Ic-Vc characteristics, Vb sweep, SMU Pulse (A.01.11)***

### [Description]

Measures the collector current vs collector voltage characteristics. The SMU pulse is used for the collector voltage output.

### [Device Under Test]

Bipolar transistor, 4 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Base: SMU connected to Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

BaseValue: Pulse base value

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Collector current Icollector

### [User Function]

$IcPerArea = I_{collector} / Le / We$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

### [X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

### ***1.30 Ic-Vc Pulse Vb[3]: Ic-Vc characteristics, 3-terminal, Vb sweep, SMU Pulse (A.01.11)***

[Description]

Measures the collector current vs collector voltage characteristics. The SMU pulse is used for the collector voltage output.

[Device Under Test]

Bipolar transistor, 3 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Base: SMU connected to Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

[Extended Test Parameters]

Ve: Emitter voltage

BaseValue: Pulse base value

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Collector current Icollector

[User Function]

$IcPerArea = I_{collector} / Le / We$

$VA = I_{collector} * diff(V_{collector}, I_{collector}) - V_{collector}$

[X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

### ***1.31 Ic-Vc Vb: Ic-Vc characteristics, Vb sweep (A.01.20)***

[Description]

Measures the collector current vs collector voltage characteristics.

[Device Under Test]

Bipolar transistor, 4 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

BaseMinRng: Minimum range for the base current measurement

SubsMinRng: Minimum range for the substrate current measurement

[Measurement Parameters]

Collector current Icollector

Base current Ibase

[User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$VA = Icollector * diff(Vcollector, Icollector) - Vcollector$

[X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

### ***1.32 Ic-Vc Vb[3]: Ic-Vc characteristics, 3-terminal, Vb sweep (A.01.20)***

[Description]

Measures the collector current vs collector voltage characteristics.

[Device Under Test]

Bipolar transistor, 3 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

BaseMinRng: Minimum range for the base current measurement

[Measurement Parameters]

Collector current Icollector

Base current Ibase

[User Function]

$IbPerArea = Ibase / Le / We$

$IcPerArea = Icollector / Le / We$

$hfe = Icollector / Ibase$

$VA = Icollector * diff(Vcollector, Icollector) - Vcollector$

[X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

### ***1.33 Rb: Base resistance (flyback method, 4-terminal) (A.01.20)***

[Description]

Measures the base voltage, collector voltage vs base current characteristics, and extracts the Base resistance in the high current region. Uses the flyback method.

[Device Under Test]

Bipolar transistor, 4 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep current output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

VbLimit: Base voltage compliance

Collector: SMU connected to Collector terminal, constant current output

VcLimit: Collector voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

[Extended Test Parameters]

Ve: Emitter voltage

Ic: Collector current

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Base voltage Vbase

Collector voltage Vcollector

[User Function]

$Rb = (V_{base} - V_{collector}) / I_{base}$

$Inv\_I_{base} = 1 / I_{base}$

[X-Y Plot]

X axis: Inversed Base current  $Inv\_I_{base}$  (LINEAR)

Y1 axis: Base resistance  $Rb$  (LINEAR)

Y2 axis: Base current  $I_{base}$  (LINEAR)

### ***1.34 $R_e+R_c$ : Collector resistance (including Emitter resistance, flyback method, 4-terminal) (A.01.20)***

#### [Description]

Measures the collector voltage vs collector current characteristics, and extracts the combined resistance of the collector resistance and the emitter resistance. Uses the flyback method.

#### [Device Under Test]

Bipolar transistor, 4 terminals

#### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

#### [Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep current output

IcStart: Sweep start current for Collector terminal

IcStop: Sweep stop current for Collector terminal

IcStep: Sweep step current for Collector terminal

VcLimit: Collector voltage compliance

Base: SMU connected to Base terminal, constant current output

Ib: Base current

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

#### [Extended Test Parameters]

Ve: Emitter voltage

VbLimit: Base voltage compliance

HoldTime: Hold time

DelayTime: Delay time

EmitterMinRng: Minimum range for the emitter current measurement

SubsMinRng: Minimum range for the substrate current measurement

#### [Measurement Parameters]

Collector voltage Vcollector

#### [User Function]

$I_{ePerArea} = I_{emitter} / L_e / W_e$

$I_{bPerArea} = I_{base} / L_e / W_e$

$I_{sPerArea} = I_{subs} / L_e / W_e$

$R_{c\_Re} = \text{diff}(V_{collector}, I_{collector})$

#### [X-Y Plot]

X axis: Collector current Icollector (LINEAR)

Y1 axis: Collector voltage Vcollector (LINEAR)

Y2 axis: Combined resistance of Collector resistance and Emitter resistance

### ***1.35 Re: Emitter resistance (flyback method, 4-terminal) (A.01.20)***

[Description]

Measures the collector voltage vs base current characteristics, and extracts the Emitter resistance. Uses the flyback method.

[Device Under Test]

Bipolar transistor, 4 terminals

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep current output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

VbLimit: Base voltage compliance

Collector: SMU connected to Collector terminal, constant current output

Ic: Collector current

VcLimit: Collector voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

EmitterMinRng: Minimum range for the emitter current measurement

SubsMinRng: Minimum range for the substrate current measurement

[Measurement Parameters]

Collector voltage Vcollector

[User Function]

Emitter current per emitter unit area  $IePerArea = Iemitter / Le / We$

Base current per emitter unit area  $IbPerArea = Ibase / Le / We$

Substrate current per emitter unit area  $IsPerArea = Isubs / Le / We$

Emitter resistance  $Re = diff(Vcollector, Ibase)$

[X-Y Plot]

X axis: Base current Ibase (LINEAR)

Y1 axis: Collector voltage Vcollector (LINEAR)

Y2 axis: Emitter resistance Re (LINEAR)

### ***1.36 Simple Gummel Plot: Evaluation of Gummel characteristics ( $V_{ce}=\text{const}$ ) (A.01.10)***

[Application]

This application evaluates the Gummel characteristics of a NPN BJT with three terminals.

[Device Measured]

Single NPN device with three terminals.

[Parameter Setting]

Test parameters are specified for NPN device under test.

[Description of Measurement]

Base and Collector voltage, referenced to emitter voltage (0 V), sweeps synchronously in accordance with the test parameter setting.

Currents flowing in base and collector terminals are measured while the synchronized voltages sweep.

[Plot Display]

Collector and base currents in log scale, as well as the current amplification factor (Beta) in linear scale, are plotted versus base voltage on the linear horizontal axis.



### ***1.37 Vbe-Le: hfe, Vbe-Le characteristics (A.01.20)***

[Description]

Measures hfe (current amplification factor)-Vbe (voltage between base and emitter) characteristics of BJT with different Le (emitter length) and plots hfe and Vbe's dependency on Le.

[Device Under Test]

Bipolar transistor, 4 terminals

[Required Modules and Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with measurement cables and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the B#/C#/E#/Sb# field (# is an integer from 1 to 12) of Test Parameters area.

The maximum number of devices connected at once depends on the number of matrix modules mounted on B2200A/B2201A. Maximum three devices can be connected to one module at once.

[Setting of Le#/B#/C#/E#/Sb# field (# is an integer from 1 to 12)]

Set one device for Le#(emitter length)/B#(base)/C#(collector)/E#(emitter)/Sb#(substrate).  
Le1&lt;Le2&lt;Le3... must be satisfied. Enter zero for a field with no device.

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)  
Temp: Temperature  
IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time  
BaseSMU: SMU connected to Base terminal, constant voltage output  
CollectorSMU: SMU connected to Collector terminal, constant voltage output  
SbSMU: SMU connected to Substrate terminal, constant voltage output  
EmitterSMU: SMU connected to Emitter terminal, primary sweep voltage output  
VeStart: Sweep start voltage for Emitter terminal  
VeStop: Sweep stop voltage for Emitter terminal  
VeStep: Sweep step voltage for Emitter terminal  
Vsubs: Substrate voltage  
Ic@hfe: Collector current determining the hfe (Calculates hfe on a particular Ic)  
Ie@Vbe: Emitter current determining the Vbe voltage (Calculates Vbe on a particular Ie)  
We: Emitter width  
Le1 - Le12: Emitter length  
B1 - B12: SWM Pin Assign setting for Base of devices  
C1 - C12: SWM Pin Assign setting for Collector of devices  
E1 - E12: SWM Pin Assign setting for Emitter of devices  
Sb1 - Sb12: SWM Pin Assign setting for Subs of devices

[Extended Test Parameters]

Vb: Base voltage  
Vc: Collector voltage  
IsubsLimit: Substrate current compliance  
HoldTime: Hold time

DelayTime: Delay time  
hfe\_Min: Minimum hfe value for graph scale  
hfe\_Max: Maximum hfe value for graph scale  
BaseMinRng: Minimum range for base current measurement  
CollectorMinRng: Minimum range for collector current measurement  
EmitterMinRng: Minimum range for emitter current measurement

[Measurement Parameters]

Collector current Icollector  
Base current Ibase  
Emitter current Iemitter

[User Function]

$hfe = I_{collector} / I_{base}$

[Analysis Function]

$I_c @ hfeVal = @L1X$  (X intercept of Line1)  
 $I_e @ VbeVal = @L2X$  (X intercept of Line2)

[Auto Analysis]

Line1: Vertical line for Y1 at  $hfe = I_c @ hfe * Ratio$   
Line2: Vertical line for Y2 at  $V_{emitter} = I_e @ Vbe * Ratio$

[X-Y Plot]

X axis: Emitter voltage  $V_{emitter}$  (LINEAR)  
Y1 axis: Base current  $I_{base}$  (LOG)  
Y2 axis: Current amplification factor  $hfe$  (LINEAR)  
Y3 axis: Collector current  $I_{collector}$  (LOG)  
Y4 axis: Emitter current  $I_{emitter}$  (LOG)

[List Display]

Emitter voltage  $V_{emitter}$   
Collector current  $I_{collector}$   
Emitter current  $I_{emitter}$   
Base current  $I_{base}$   
Current amplification factor  $hfe$

[Parameters Display Area]

Collector current determining the  $hfe$  (Calculates  $hfe$  on a particular  $I_c$ )  $I_c @ hfeVal$   
Emitter current determining the  $V_{be}$  voltage (Calculates  $V_{be}$  on a particular  $I_e$ )  $I_e @ VbeVal$

[Test Output: X-Y Graph]

X axis: Emitter length (Le size)  $LeList$  (LINEAR)  
Y1 axis: Current amplification factor at  $I_c @ hfe$   $I_c @ hfeList$  (LINEAR)  
Y2 axis: Emitter voltage at  $I_e @ Vbe$   $I_e @ VbeList$  (LINEAR)

[Test Output: List Display]

Emitter length (Le size)  $LeList$   
Current amplification factor  $I_c @ hfeList$   
Emitter voltage  $I_e @ VbeList$

### ***1.38 Vbe-We: hfe, Vbe-Le characteristics (A.01.20)***

[Description]

Measures the hfe (current amplification factor) vs Vbe (voltage between base and emitter) characteristics of BJT with different We (emitter width) and plots hfe and Vbe's dependency on We.

[Device Under Test]

Bipolar transistor, 4 terminals

[Required Modules and Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the B#/C#/E#/Sb# field (# is an integer from 1 to 12) of Test Parameters area.

The maximum number of devices connected at once depends on the number of matrix modules mounted on B2200A/B2201A. Maximum three devices can be connected to one module at once.

[Setting of We#/B#/C#/E#/Sb# field (# is an integer from 1 to 12)]

Set one device for We#(emitter width)/B#(base)/C#(collector)/E#(emitter)/Sb#(sub strate).  
We1&lt;We2&lt;We3... must be satisfied. Enter zero for a field with no device.

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time

BaseSMU: SMU connected to Base terminal, constant voltage output

CollectorSMU: SMU connected to Collector terminal, constant voltage output

SbSMU: SMU connected to Substrate terminal, constant voltage output

EmitterSMU: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

Vsubs: Substrate voltage

Ic@hfe: Collector current determining the hfe (Calculates hfe on a particular Ic)

Ie@Vbe: Emitter current determining the Vbe voltage (Calculates Vbe on a particular Ie)

Le: Emitter length

We1 - We12: Emitter width

B1 - B12: SWM Pin Assign setting for Base of devices

C1 - C12: SWM Pin Assign setting for Collector of devices

E1 - E12: SWM Pin Assign setting for Emitter of devices

Sb1 - Sb12: SWM Pin Assign setting for Subs of devices

[Extended Test Parameters]

Vb: Base voltage

Vc: Collector voltage

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time  
hfe\_Min: Minimum hfe value for graph scale  
hfe\_Max: Maximum hfe value for graph scale  
BaseMinRng: Minimum range for base current measurement  
CollectorMinRng: Minimum range for collector current measurement  
EmitterMinRng: Minimum range for emitter current measurement

[Measurement Parameters]

Collector current Icollector  
Base current Ibase  
Emitter current Iemitter

[User Function]

$hfe = I_{collector} / I_{base}$

[Analysis Function]

$I_c @ hfeVal = @L1X$  (X intercept of Line1)  
 $I_e @ VbeVal = @L2X$  (X intercept of Line2)

[Auto Analysis]

Line1: Vertical line for Y1 at  $hfe = I_c @ hfe * Ratio$   
Line2: Vertical line for Y2 at  $V_{emitter} = I_e @ Vbe * Ratio$

[X-Y Plot]

X axis: Emitter voltage  $V_{emitter}$  (LINEAR)  
Y1 axis: Base current  $I_{base}$  (LOG)  
Y2 axis: Current amplification factor  $hfe$  (LINEAR)  
Y3 axis: Collector current  $I_{collector}$  (LOG)  
Y4 axis: Emitter current  $I_{emitter}$  (LOG)

[List Display]

Emitter voltage  $V_{emitter}$   
Collector current  $I_{collector}$   
Emitter current  $I_{emitter}$   
Base current  $I_{base}$   
Current amplification factor  $hfe$

[Parameters Display Area]

Collector current determining the  $hfe$  (Calculates  $hfe$  on a particular  $I_c$ )  $I_c @ hfeVal$   
Emitter current determining the  $V_{be}$  voltage (Calculates  $V_{be}$  on a particular  $I_e$ )  $I_e @ VbeVal$

[Test Output: X-Y Graph]

X axis: Emitter width ( $W_e$  size)  $W_eList$  (LINEAR)  
Y1 axis: Current amplification factor at  $I_c @ hfe$   $I_c @ hfeList$  (LINEAR)  
Y2 axis: Emitter voltage at  $I_e @ Vbe$   $I_e @ VbeList$  (LINEAR)

[Test Output: List Display]

Emitter width ( $W_e$  size)  $W_eList$   
Current amplification factor  $I_c @ hfeList$   
Emitter voltage  $I_e @ VbeList$

## 2 CMOS

1. BVdss:	Breakdown voltage between source and drain (A.01.20)
2. BVgso:	Breakdown voltage between gate and source (A.01.20)
3. Cgb-AC Level:	Cgb-Vosc characteristics (A.01.11)
4. Cgb-Freq Log:	Cgb-f characteristics (A.01.20)
5. Cgb-Vg HighVoltage:	Cgb-Vg characteristics using SCUU (A.01.11)
6. Cgb-Vg:	Cgb-Vg characteristics (A.01.11)
7. Cgc-Freq Log:	Cgc-f characteristics (A.01.20)
8. Cgc-Vg:	Cgc-Vg characteristics (A.01.11)
9. Cgg-Freq Linear:	Cgg-f characteristics (A.01.20)
10. Cgg-Freq Log:	Cgg-f characteristics (A.01.20)
11. Cgg-Vg 2Freq:	Cgg-Vg characteristics, 2-frequency method (A.01.11)
12. Cgg-Vg:	Cgg-Vg characteristics (A.01.11)
13. IdRdsGds:	Drain resistance/conductance (A.01.20)
14. Id-Vd pulse:	Id-Vd characteristics, SMU Pulse (A.01.11)
15. Id-Vd pulse[3] :	Id-Vd characteristics (3-terminal), SMU Pulse (A.01.11)
16. Id-Vd:	Id-Vd Characteristics (A.01.20)
17. Id-Vd[3]:	Id-Vd Characteristics (3-terminal) (A.01.20)
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22. IonIoffSlope:	On current, off current, and subthreshold slope (A.01.20)
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27. Vth gmMax :	Linear region Vth (A.01.20)
28. VthAndCgg-Vg ASU:	Cgg-Vg, Id-Vg, using ASU (A.01.20)
29. VthAndCgg-Vg SCUU:	Cgg-Vg, Id-Vg, using SCUU (A.01.20)
30. Vth-Lg:	Vth-Lg characteristics (A.01.20)
31. Vth-Wg:	Vth-Wg characteristics (A.01.20)

## **2.1 *BVdss: Breakdown voltage between source and drain (A.01.20)***

### [Description]

Measures the breakdown voltage between source and drain of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Is@BVdss: Source current to decide the breakdown

Drain: SMU connected to Drain, primary sweep voltage output

VdStart: Sweep start voltage for Drain

VdStop: Sweep stop voltage for Drain

VdStep: Sweep step voltage for Drain

Gate: SMU connected to Gate, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Source: SMU connected to Source, constant voltage output

### [Extended Test Parameters]

Vg: Gate voltage

Vs: Source voltage

Vsubs: Substrate voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Drain current I<sub>drain</sub>

Source current I<sub>source</sub>

Gate current I<sub>gate</sub>

Substrate current I<sub>subs</sub>

For the source terminal, the SMU current compliance is set to  $I_{s@BVdss} * 1.1$ .

### [User Function]

Source current per unit gate width  $I_{sourcePerWg} = I_{source} / Wg$

Drain current per unit gate width  $I_{drainPerWg} = I_{drain} / Wg$

### [Analysis Function]

$BVdss = @L1X$  (X intercept of Line1)

### [X-Y Plot]

X axis: Drain voltage V<sub>drain</sub> (LINEAR)

Y1 axis: Drain current I<sub>drain</sub> (LOG)

Y2 axis: Source current I<sub>source</sub> (LOG)

[List Display]

Gate current  $I_{gate}$

Substrate current  $I_{subs}$

[Parameters Display Area]

Breakdown voltage between source and drain  $BV_{dss}$

[Auto Analysis]

Line1: Vertical line through Y2 data at  $I_{source}=I_s@BV_{dss}$

## 2.2 *BVgso: Breakdown voltage between gate and source (A.01.20)*

### [Description]

Measures the breakdown voltage between gate and source of MOSFET when drain is opened.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Is@BVgso: Source current to decide the breakdown

Gate: SMU connected to Gate, primary sweep voltage output

VgStart: Sweep start voltage for Gate

VgStop: Sweep stop voltage for Gate

VgStep: Sweep step voltage for Gate

Subs: SMU connected to Substrate, constant voltage output

Source: SMU connected to Source, constant voltage output

### [Extended Test Parameters]

Vsubs: Substrate voltage

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

SourceMinRng: Minimum range for the source current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Source current Isource

Gate current Igate

Substrate current Isubs

For the all terminals, the SMU current compliance is set to  $I_s@BVgso * 1.1$ .

### [User Function]

Gate current per Gate unit area  $I_{gatePerGateArea} = I_{gate} / L_g / W_g$

### [Analysis Function]

$BVgso = @L1X$  (X intercept of Line1)

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Source current Isource (LOG)

Y2 axis: Gate current Igate (LOG)

### [List Display]

Substrate current Isubs

### [Parameters Display Area]



Breakdown voltage between gate and source  $BV_{gso}$

[Auto Analysis]

Line1: Vertical line through Y1 data at  $I_{source}=I_s@BV_{gso}$

## 2.3 Cgb-AC Level: Cgb-Vosc characteristics (A.01.11)

### [Description]

Measures the Gate-Substrate capacitance (Cgs), and plots the Cgs-Vosc characteristics.

DC bias output is fixed at -Vgs. Oscillator level (Vosc) is changed from -OscStart to -OscStop in -OscStep steps. The CMU performs spot measurement of the parallel capacitance (Cp) and conductance (G) at each oscillator level.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low and Substrate to the CMU High. And connect Drain and Source to the specified SMU.

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

OscStart: Oscillator level (Vosc) start voltage

OscStop: Vosc stop voltage

OscStep: Vosc step voltage

FREQ: Measurement frequency

Gate: CMU connected between Gate and Substrate (CV spot measurement)

Vgs: DC bias. Gate-Substrate voltage.

Source: SMU connected to Source terminal (constant voltage output)

### [Extended Test Parameters]

Vs: Source voltage

IsLimit: Source current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance cp

Conductance g

### [User Function]

PI=3.141592653589

$d=g/(2*PI*FREQ*cp)$

$rp=1/g$

$cs=(1+d^2)*cp$

$x=-1/(2*PI*FREQ*cs)$

$rs=d*abs(x)$

$z=sqrt(rs^2+x^2)$

$theta=atan(x/rs)$

$V\_gs=-Vsubs$

osclevel=OscLevel

### [Display Setup: X-Y Graph]

X axis: Oscillator level Vosc (LINEAR)

Y1 axis: Gate-Substrate capacitance (parallel capacitance) cp (LINEAR)

Y2 axis: Conductance  $g$  (LINEAR)

[Display Setup: List Display]

Oscillator level  $osclevel$

Oscillator level  $V_{osc}$

Gate-Substrate capacitance (parallel capacitance)  $cp$

Conductance  $g$

Gate-Substrate voltage  $V_{gs}$

[Test Output: X-Y Graph]

X axis: Oscillator level OSCLEVEL (LINEAR)

Y1 axis: Gate-Substrate capacitance (parallel capacitance)  $C_p$  (LINEAR)

Y2 axis: Conductance  $G$  (LINEAR)

[Test Output: List Display]

Oscillator level OSCLEVEL

Parallel capacitance  $C_p$

Conductance  $G$

Series capacitance  $C_s$

Series resistance  $R_s$

Parallel resistance  $R_p$

Dissipation factor  $D$

Reactance  $X$

Impedance  $Z$

Phase  $\theta$

## 2.4 Cgb-Freq Log: Cgb-f characteristics (A.01.20)

### [Description]

Measures MOSFET's characteristics of gate-to-substrate capacitance (Cgb, linear) vs frequency (f, log). The measurement frequency is 10 points per decade.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low and Substrate to the CMU High. And connect Drain and Source to the GNDU.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: CMU connected to Gate terminal, CV sweep measurement

Source: SMU connected to Source terminal, constant voltage output

FreqStart: Sweep start frequency

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Vgs: Voltage for Gate terminal, constant voltage output

### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

Vs: Voltage for Source terminal

IsLimit: Source current compliance

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency Freq (LOG)

Y1 axis: Gate-Substrate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[List Display]

Frequency Freq  
Gate-Substrate capacitance Cp  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Substrate voltage Vsubs  
Conductance G

[Test Output: X-Y Graph]

X axis: Frequency list FreqList (LOG)  
Y1 axis: Gate-Substrate capacitance (parallel capacitance) list CpList (LINEAR)  
Y2 axis: Conductance list GList (LINEAR)

[Test Output: List Display]

Frequency FreqList  
Gate-Substrate capacitance (parallel capacitance) CpList  
Conductance GList  
Series capacitance CsList  
Series resistance RsList  
Parallel resistance RpList  
Dissipation factor DList  
Reactance XList  
Impedance ZList  
Phase ThetaList  
Substrate voltage VsubsList

## 2.5 Cgb-Vg HighVoltage: Cgb-Vg characteristics using SCUU (A.01.11)

### [Description]

Measures the Gate-Substrate capacitance (Cgs), and plots the Cgs-Vg characteristics.

DC bias output is performed from -VgsStart to -VgsStop in -VgsStep steps. The CMU performs spot measurement of the parallel capacitance (Cp) and conductance (G) at each bias output. SCUU enables the maximum 100 V DC bias.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate and Substrate to the SCUU. And connect Drain and Source to the specified SMU.

### [Required Modules and Accessories]

One MFCMU module, three SMU modules, and a set of SCUU/GSWU are required.

SCUU connections: Output1: Substrate, Output2: Gate

Connection wire must be connected between the GSWU and the DUT interface High/Low guard lines.

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Gate: CMU connected between Gate and Substrate (CV spot measurement)

VgsStart: DC bias start voltage

VgsStop: DC bias stop voltage

VgsStep: DC bias step voltage

Source: SMU connected to Source terminal (constant voltage output)

### [Extended Test Parameters]

IsLimit: Source current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Subs=Vstart*Polarity$

### [Display Setup: X-Y Graph]

X axis: Gate voltage  $V_{gate}$  (LINEAR)  
Y1 axis: Gate-Substrate capacitance (parallel capacitance)  $C_p$  (LINEAR)  
Y2 axis: Conductance  $G$  (LINEAR)

[Display Setup: List Display]

Substrate voltage Subs  
Gate voltage  $V_{gate}$   
Gate-Substrate capacitance (parallel capacitance)  $C_p$

[Test Output: X-Y Graph]

X axis: Gate voltage  $V_{gList}$  (LINEAR)  
Y1 axis: Gate-Substrate capacitance (parallel capacitance)  $C_{pList}$  (LINEAR)  
Y2 axis: Conductance  $G_{List}$  (LINEAR)

[Test Output: List Display]

Gate voltage  $V_{gList}$   
Gate-Substrate capacitance (parallel capacitance)  $C_{pList}$   
Conductance  $G_{List}$   
Series capacitance  $C_{sList}$   
Series resistance  $R_{sList}$   
Parallel resistance  $R_{pList}$   
Dissipation factor  $D_{List}$   
Reactance  $X_{List}$   
Impedance  $Z_{List}$   
Phase  $\Theta_{List}$

## 2.6 Cgb-Vg: Cgb-Vg characteristics (A.01.11)

### [Description]

Measures the Gate-Substrate capacitance (Cgs), and plots the Cgs-Vg characteristics.

DC bias output is performed from -VgsStart to -VgsStop in -VgsStep steps. The CMU performs spot measurement of the parallel capacitance (Cp) and conductance (G) at each bias output.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and Substrate to the CMU High. And connect Drain and Source to the specified SMU.

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Gate: CMU connected between Gate and substrate (CV spot measurement)

VgsStart: DC bias start voltage

VgsStop: DC bias stop voltage

VgsStep: DC bias step voltage

Source: SMU connected to Source terminal (constant voltage output)

### [Extended Test Parameters]

Vs: Source voltage

IsLimit: Source current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Vsubs=Vstart*Polarity$

### [Display Setup: X-Y Graph]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Gate-Substrate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)



[Display Setup: List Display]

Substrate voltage  $V_{\text{subs}}$

Source voltage  $V_{\text{source}}$

Gate-Substrate capacitance (parallel capacitance)  $C_p$

[Test Output: X-Y Graph]

X axis: Gate voltage  $V_{gList}$  (LINEAR)

Y1 axis: Gate-Substrate capacitance (parallel capacitance)  $C_{pList}$  (LINEAR)

Y2 axis: Conductance  $G_{List}$  (LINEAR)

[Test Output: List Display]

Gate voltage  $V_{gList}$

Gate-Substrate capacitance (parallel capacitance)  $C_{pList}$

Conductance  $G_{List}$

Series capacitance  $C_{sList}$

Series resistance  $R_{sList}$

Parallel resistance  $R_{pList}$

Dissipation factor  $D_{List}$

Reactance  $X_{List}$

Impedance  $Z_{List}$

Phase  $\Theta_{List}$

## 2.7 Cgc-Freq Log: Cgc-f characteristics (A.01.20)

### [Description]

Measures MOSFET's characteristics of gate-to-channel capacitance (Cgc, linear) vs frequency (f, log). The measurement frequency is 10 points per decade.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and Drain-Source to the CMU High. And connect Substrate to the GNDU.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: CMU connected to Gate terminal, CV sweep measurement

Subs: SMU connected to Substrate terminal, constant voltage output

FreqStart: Sweep start frequency

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Vgs: Voltage for Gate terminal, constant voltage output

### [Extended Test Parameters]

Vsubs: Voltage for Substrate terminal

IsubsLimit: Substrate current compliance

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency Freq (LOG)

Y1 axis: Gate-Channel capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[List Display]

Frequency Freq  
Gate-Channel capacitance Cp  
Gate voltage G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Source voltage Vsource

[Test Output: X-Y Graph]

X axis: Frequency list FreqList (LOG)  
Y1 axis: Gate-Channel capacitance (parallel capacitance) list CpList (LINEAR)  
Y2 axis: Conductance list GList (LINEAR)

[Test Output: List Display]

Frequency FreqList  
Gate-Channel capacitance (parallel capacitance) CpList  
Conductance GList  
Series capacitance CsList  
Series resistance RsList  
Parallel resistance RpList  
Dissipation factor DList  
Reactance XList  
Impedance ZList  
Phase ThetaList  
Source voltage VsourceList

## 2.8 Cgc-Vg: Cgc-Vg characteristics (A.01.11)

### [Description]

Measures the Gate-Channel capacitance (Cgc), and plots the Cgc-Vg characteristics.

DC bias output is performed from -VgsStart to -VgsStop in -VgsStep steps. The CMU performs spot measurement of the parallel capacitance (Cp) and conductance (G) at each bias output. The substrate voltage is changed simultaneously with the DC bias output to keep the Channel-Substrate voltage constant. The SMU works as the constant voltage source and realizes the secondary sweep by repeating the output change every DC bias sweep.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and Drain-Source to the CMU High. And connect Substrate to the specified SMU.

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Gate: CMU connected between Gate and channel (CV spot measurement)

VgsStart: DC bias start voltage (primary sweep)

VgsStop: DC bias stop voltage (primary sweep)

VgsStep: DC bias step voltage (primary sweep)

Subs: SMU connected to Substrate terminal (constant voltage output)

VbsStart: Substrate start voltage (secondary sweep)

VbsStop: Substrate stop voltage (secondary sweep)

VbsStep: Substrate step voltage (secondary sweep)

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$Vgate=-Vsource$

[Display Setup: X-Y Graph]

X axis: Gate voltage  $V_{gate}$  (LINEAR)

Y1 axis: Gate-Channel capacitance (parallel capacitance)  $C_p$  (LINEAR)

Y2 axis: Conductance  $G$  (LINEAR)

[Display Setup: List Display]

Gate voltage  $V_{gate}$

Substrate voltage  $V_{subs}$

Gate-Channel capacitance (parallel capacitance)  $C_p$

Conductance  $G$

[Test Output: X-Y Graph]

X axis: Gate voltage  $V_{gList}$  (LINEAR)

Y1 axis: Gate-Channel capacitance (parallel capacitance)  $C_{pList}$  (LINEAR)

Y2 axis: Conductance  $G_{List}$  (LINEAR)

[Test Output: List Display]

Gate voltage  $V_{gList}$

Channel-Substrate voltage  $V_{bsList}$

Gate-Channel capacitance (parallel capacitance)  $C_{pList}$

Conductance  $G_{List}$

Series capacitance  $C_{sList}$

Series resistance  $R_{sList}$

Parallel resistance  $R_{pList}$

Dissipation factor  $D_{List}$

Reactance  $X_{List}$

Impedance  $Z_{List}$

Phase  $\Theta_{List}$

## 2.9 Cgg-Freq Linear: Cgg-f characteristics (A.01.20)

### [Description]

Measures the gate capacitance (Cgg, linear) vs frequency (f, linear) characteristics of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and Drain-Source-Substrate to the CMU High.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FreqStart: Sweep start frequency

NoOfPoint: Number of measurement points

OscLevel: Measurement signal level

Gate: CMU connected to Gate terminal, CV sweep measurement

Vgs: Voltage for Gate terminal, constant voltage output

### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency Freq (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

### [List Display]

Frequency Freq

Gate capacitance (parallel capacitance) Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Substrate voltage Vsubs

[Test Output: X-Y Graph]

X axis: Frequency list FreqList (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) list CpList (LINEAR)

Y2 axis: Conductance list GList (LINEAR)

[Test Output: List Display]

Frequency FreqList

Gate capacitance (parallel capacitance) CpList

Conductance GList

Series capacitance CsList

Series resistance RsList

Parallel resistance RpList

Dissipation factor DList

Reactance XList

Impedance ZList

Phase ThetaList

Substrate voltage VsubsList

## 2.10 Cgg-Freq Log: Cgg-f characteristics (A.01.20)

### [Description]

Measures the gate capacitance (Cgg, linear) vs frequency (f, log) characteristics of MOSFET. The measurement frequency is 10 points per decade.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and Drain-Source-Substrate to the CMU High.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FreqStart: Sweep start frequency

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Gate: CMU connected to Gate terminal, CV sweep measurement

Vgs: Voltage for Gate terminal, constant voltage output

### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency Freq (LOG)

Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

### [List Display]



Frequency Freq  
Gate capacitance (parallel capacitance) Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Substrate voltage Vsubs

[Test Output: X-Y Graph]

X axis: Frequency measurement list FreqList (LOG)  
Y1 axis: Gate capacitance (parallel capacitance) list CpList (LINEAR)  
Y2 axis: Conductance list GList (LINEAR)

[Test Output: List Display]

Frequency FreqList  
Gate capacitance (parallel capacitance) CpList  
Conductance GList  
Series capacitance CsList  
Series resistance RsList  
Parallel resistance RpList  
Dissipation factor DList  
Reactance XList  
Impedance ZList  
Phase ThetaList  
Substrate voltage VsubsList

## 2.11 Cgg-Vg 2Freq: Cgg-Vg characteristics, 2-frequency method (A.01.11)

### [Description]

Measures the Gate capacitance (Cgg), and plots the Cgg-Vg characteristics. The Cgg value is given by the following formula. Then C1 and C2 are capacitance, D1 and D2 are dissipation factor measured at the frequency (f1 and f2).

$$C_{gg} = [f_1^2 * C_1 * (1 + D_1^2) - f_2^2 * C_2 * (1 + D_2^2)] / [f_2^2 - f_1^2]$$

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and the other terminals to the CMU High.

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

OscLevel: Measurement signal level

FREQ1: Measurement frequency

FREQ2: Measurement frequency

Gate: CMU connected to Gate terminal (CV sweep measurement)

VgsStart: DC bias start voltage

VgsStop: DC bias stop voltage

VgsStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Dissipation factor D

### [User Function]

Vgs=-Vsubs

### [Display Setup: X-Y Graph]

X axis: Gate voltage Vgs (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

### [Display Setup: List Display]

Gate voltage Vgs

Gate capacitance (parallel capacitance) Cp

Dissipation factor D

### [Test Output: X-Y Graph]

X axis: Gate voltage VGS (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cgg (LINEAR)

Y2 axis: Gate capacitance (parallel capacitance) Cp\_FREQ1 (LINEAR)

Y3 axis: Gate capacitance (parallel capacitance) Cp\_FREQ2 (LINEAR)

[Test Output: List Display]

Gate voltage VGS

Gate capacitance (parallel capacitance) Cgg

Gate capacitance (parallel capacitance) Cp\_FREQ1

Gate capacitance (parallel capacitance) Cp\_FREQ2

Dissipation factor D\_FREQ1

Dissipation factor D\_FREQ2

## 2.12 Cgg-Vg: Cgg-Vg characteristics (A.01.11)

### [Description]

Measures the Gate capacitance (Cgg), and plots the Cgg-Vg characteristics.

### [Device Under Test]

MOSFET, 4 terminals

Connect Gate to the CMU Low, and the other terminals to the CMU High.

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Gate: CMU connected to Gate terminal (CV sweep measurement)

VgsStart: DC bias start voltage

VgsStop: DC bias stop voltage

VgsStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$Dval=Gval/(2*PI*FREQ*Cpval)$

$Rpval=1/Gval$

$Csval=(1+Dval^2)*Cpval$

$Xval=-1/(2*PI*FREQ*Csval)$

$Rsval=Dval*abs(Xval)$

$Zval=sqrt(Rsval^2+Xval^2)$

$Thetaval=atan(Xval/Rsval)$

$Vgateval=-Vsubs$

### [X-Y Graph]

X axis: Gate voltage Vgateval (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cpval (LINEAR)

Y2 axis: Conductance Gval (LINEAR)

### [List Display]

Gate voltage Vgateval

Gate capacitance (parallel capacitance) Cpval

Conductance Gval

Series capacitance Csval

Series resistance Rsval

Parallel resistance  $R_{pval}$   
Dissipation factor  $D_{val}$   
Reactance  $X_{val}$   
Impedance  $Z_{val}$   
Phase  $\theta_{taval}$

## 2.13 *IdRdsGds: Drain resistance/conductance (A.01.20)*

### [Description]

Extracts the early voltage, drain resistance, and drain conductance from the drain current vs drain voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

Drain resistance Rds

Early voltage VA

Drain conductance gds

### [User Function]

$gds = \text{diff}(\text{Idrain}, \text{Vdrain})$

$Rds = 1/gds$

$VA = Rds * (\text{abs}(\text{Idrain}) - \text{abs}(\text{Vdrain}))$

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain resistance Rds (LOG)

Y3 axis: Early voltage VA (LINEAR)

[List Display]  
Drain conductance gds

## **2.14 Id-Vd pulse: Id-Vd characteristics, SMU Pulse (A.01.11)**

### [Description]

Measures the drain current vs drain voltage characteristics of MOSFET. SMU pulse output is used for applying the drain voltage.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

BaseValue: Pulse base voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{drainPerWg} = I_{drain}/W_g$

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg



## **2.15 Id-Vd pulse[3] : Id-Vd characteristics (3-terminal), SMU Pulse (A.01.11)**

### [Description]

Measures the drain current vs drain voltage characteristics of MOSFET. SMU pulse is used for the drain voltage output.

### [Device Under Test]

MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

BaseValue: Pulse base voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg

## 2.16 Id-Vd: Id-Vd Characteristics (A.01.20)

### [Description]

Measures the drain current vs drain voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

IntegTime: Integration time

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg

## **2.17 Id-Vd[3]: Id-Vd Characteristics (3-terminal) (A.01.20)**

### [Description]

Measures the drain current vs drain voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IntegTime: Integration time

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg

## 2.18 Id-Vg pulse: Id-Vg characteristics, SMU Pulse (A.01.12)

### [Description]

Measures the drain current vs gate voltage characteristics of MOSFET by using SMU pulse.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

PulsePeriod: Pulse period

PulseWidth: Pulse width

Subs: SMU connected to Substrate, secondary sweep voltage output

VsubsStart: Sweep start voltage for Substrate terminal

VsubsStop: Sweep stop voltage for Substrate terminal

VsubsStep: Sweep step voltage for Substrate terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

BaseValue: Pulse base voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

gm: Transconductance  $g_{\text{m}} = \text{diff}(I_{\text{drain}}, V_{\text{gate}})$

gmPerWg: Transconductance per unit gate width  $g_{\text{mPerWg}} = \text{diff}(I_{\text{drainPerWg}}, V_{\text{gate}})$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Transconductance gm (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg

Transconductance per unit gate width gmPerWg

## 2.19 Id-Vg Vpulse[3]: Id-Vg characteristics (3-terminal), SMU Pulse (A.01.11)

### [Description]

Measures the drain current vs gate voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

BaseValue: Pulse base voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

gm: Transconductance  $g_{\text{m}} = \text{diff}(I_{\text{drain}}, V_{\text{gate}})$

gmPerWg: Transconductance per unit gate width  $g_{\text{mPerWg}} = \text{diff}(I_{\text{drainPerWg}}, V_{\text{gate}})$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Transconductance gm (LINEAR)

### [List Display]

Drain current per unit gate width IdrainPerWg

Transconductance per unit gate width gmPerWg

## 2.20 Id-Vg: Id-Vg Characteristics (A.01.20)

### [Description]

Measures the drain current vs gate voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

Subs: SMU connected to Substrate, secondary sweep voltage output

VsubsStart: Sweep start voltage for Substrate terminal

VsubsStop: Sweep stop voltage for Substrate terminal

VsubsStep: Sweep step voltage for Substrate terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Measurement minimum range of drain current

SubsMinRng: Measurement minimum range of substrate current

### [Measurement Parameters]

Drain current Idrain

Substrate current Isubs

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

IsubsPerWg: Substrate current per unit gate width  $I_{\text{subsPerWg}} = I_{\text{subs}} / W_{\text{g}}$

gm: Transconductance  $g_{\text{m}} = \text{diff}(I_{\text{drain}}, V_{\text{gate}})$

gmPerWg: Transconductance per unit gate width  $g_{\text{mPerWg}} = \text{diff}(I_{\text{drainPerWg}}, V_{\text{gate}})$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

Y3 axis: Substrate current Isubs (LINEAR)

Y4 axis: Substrate current Isubs (LOG)

[List Display]

Drain current per unit gate width  $I_{\text{drainPerWg}}$

Substrate current per unit gate width  $I_{\text{subsPerWg}}$

Transconductance  $g_m$

Transconductance per unit gate width  $g_{m\text{PerWg}}$

## 2.21 Id-Vg[3]: Id-Vg Characteristics (3-terminal) (A.01.20)

### [Description]

Measures the drain current vs gate voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

gm: Transconductance  $g_{\text{m}} = \text{diff}(I_{\text{drain}}, V_{\text{gate}})$

gmPerWg: Transconductance per unit gate width  $g_{\text{mPerWg}} = \text{diff}(I_{\text{drainPerWg}}, V_{\text{gate}})$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

### [List Display]

Drain current per unit gate width IdrainPerWg

Transconductance gm

Transconductance per unit gate width gmPerWg



## 2.22 IonIoffSlope: On current, off current, and subthreshold slope (A.01.20)

### [Description]

Extracts the on current, off current, and subthreshold slope from the Id-Vg characteristics.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal,  $V_{gStart} < 0$

VgStop: Sweep stop voltage for Gate terminal,  $V_{gStop} = V_d$

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

Slope=1/diff(lgt(Idrain),Vgate)

SlopeMin=min(abs(Slope))

### [Analysis Function]

Ion=@L1Y1 (Y1 intercept of Line1)

Ioff=@L2Y1 (Y1 intercept of Line2)

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LOG)

Y2 axis: Slope (LINEAR)

### [Parameters Display Area]

SlopeMin: minimum Slope value

Ion: on current (drain current at  $V_g = V_{gStop}$ )

Ioff: off current (drain current at  $V_g=0$ )

[Auto Analysis]

Line1: Horizontal line through the Y1 data at  $V_{gate}=V_d(=V_{gStop})$

Line2: Horizontal line through the Y1 data at  $V_{gate}=0$

Marker: Point of Slope=SlopeMin

## 2.23 *Isub-Vg: Isub-Lg characteristics (A.01.20)*

### [Description]

Measures the substrate current vs gate voltage characteristics of MOSFET.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG) default: MEDIUM

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, secondary sweep voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

Vsubs: Substrate terminal voltage

IgLimit: Gate current compliance

IdLimit: Drain current compliance

IsubsLimit: Substrate current compliance

Vs: Source terminal voltage

DrainMinRng: Minimum range for drain current measurement

SubsMinRng: Minimum range for substrate current measurement

GateMinRng: Minimum range for gate current measurement

### [Measurement Parameters]

Substrate current Isubs

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Substrate current Isubs (LOG)

### [List Display]

Gate voltage Vgate

Substrate current Isubs

Drain current Idrain

Gate current Igate

## ***2.24 Simple Cgb : Evaluation of gate-substrate capacitance versus gate voltage (A.01.10)***

### **[Application]**

This application evaluates the gate-substrate capacitance of a Nch MOSFET.

### **[Device Measured]**

Single device with four terminals.

### **[Parameter Setting]**

Test parameters are specified for NMOS device under test.

Swept bias voltage parameters are specified by the gate voltage referenced to the source voltage ( $V_{gs}$ ).

### **[Description of Measurement]**

Gate voltage ( $V_{gs}$ ) sweeps in accordance with the test parameter setting.

Gate capacitances are measured with Cp-G model applied while the bias voltage sweeps.

### **[Plot Display]**

Measured gate capacitances in linear scale are plotted versus substrate voltage on the linear horizontal axis.

## ***2.25 Simple $V_{th}$ : Evaluation of Threshold Voltage ( $V_{th}$ ) (A.01.10)***

### **[Application]**

This application evaluates the threshold voltage ( $V_{th}$ ) of a Nch MOSFET.

### **[Device Measured]**

Single device with four terminals.

### **[Parameter Setting]**

Test parameters are specified for NMOS device under test.

Swept bias voltage parameters are specified by the gate voltage referenced to the source voltage ( $V_g$ ).

### **[Description of Measurement]**

Gate voltage ( $V_g$ ) sweeps in accordance with the test parameter setting.

Currents flowing in drain terminal are measured while the gate voltage sweeps.

### **[Plot Display]**

Measured drain currents and transconductance in linear scale are plotted versus gate voltage on the linear horizontal axis.

Maximum transconductance value ( $G_{mmax}$ ) and threshold voltage ( $V_{th}$ ) are extracted from the measurement data, then displayed in the parameters display area.

## 2.26 *Vth Const Id: Constant current Vth (A.01.20)*

### [Description]

Measures the drain current vs gate voltage characteristics, and extracts the threshold voltage ( $V_{th}$ ) by using the constant current method.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Id@Vth: Drain current to decide the  $V_{th}$

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

gm=diff(Idrain,Vgate)

### [Analysis Function]

Vth=@L1X (X intercept of Line1)

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

### [List Display]

Transconductance gm

[Parameters Display Area]  
Threshold voltage  $V_{th}$

[Auto Analysis]  
Line1: Vertical line for Y1 at  $I_{drain}=I_d@V_{th}$

## 2.27 *Vth gmMax : Linear region Vth (A.01.20)*

### [Description]

Extracts the threshold voltage ( $V_{th}$ ) by using the extrapolation method for the linear region of the drain current vs gate voltage characteristics.

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$gm = \text{diff}(\text{Idrain}, \text{Vgate})$

### [Analysis Function]

$gmMax = \max(gm)$

$Von = @L1X$  (X intercept of Line 1)

$Vth = Von - Vd/2$

$V_{th}$  is given by the following formula.

$V_{th} = V_g(gmMax) - I_d(gmMax)/gmMax$

$Vd/2$  is necessary to compensate the secondary term of  $Vd$  in theory.

### [X-Y Plot]

X axis: Gate voltage  $V_{gate}$  (LINEAR)

Y1 axis: Drain current  $I_{drain}$  (LINEAR)



Y2 axis: Transconductance gm (LINEAR)

Y3 axis: Drain current Idrain (LOG)

[Parameters Display Area]

Threshold voltage Vth

Maximum gm value gmMax

[Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

## 2.28 *VthAndCgg-Vg ASU: Cgg-Vg, Id-Vg, using ASU (A.01.20)*

### [Description]

Measures the gate capacitance vs gate voltage characteristics, the drain current vs gate voltage measurement by using one MFCMU, two sets of HRSMU/ASU, and one SMU.

### [Device Under Test]

MOSFET, 4 terminals

### [Required Modules and Accessories]

One MFCMU module, two sets of HRSMU/ASU, and one SMU module are required.

ASU#1 connections: Output: Gate, SMU: HRSMU, AUX: MFCMU Low

ASU#2 connections for Cgg-Vg: Output: other 3 terminals, SMU: HRSMU, AUX: MFCMU High

ASU#2 connections for Id-Vg: Output: Source and Substrate, SMU: HRSMU, AUX: MFCMU High

Connection wire must be connected between the CMU Return terminals of ASUs.

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

GateAC: CMU connected to Gate terminal (CV sweep measurement)

GateDC: SMU connected to Gate terminal (primary sweep, voltage output)

SourceDC: SMU connected to Source and Substrate terminal (constant voltage output)

Drain: SMU connected to Drain terminal (constant voltage output)

IntegTime: Integration time

IgLimit: Gate current compliance

IdLimit: Drain current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

VgsBiasStart: Cgg-Vg measurement start voltage

VgsBiasStop: Cgg-Vg measurement stop voltage

VgsBiasStep: Cgg-Vg measurement step voltage

OscLevel: Cgg-Vg measurement signal level

FREQ: Cgg-Vg measurement frequency

VgsStartDC: Id-Vg measurement start voltage

VgsStopDC: Id-Vg measurement stop voltage

VgsStepDC: Id-Vg measurement step voltage

Vd: Drain current

### [Extended Test Parameters]

DrainMinRng: Minimum range for the drain current measurement

GateMinRng: Minimum range for the gate current measurement

### [Cgg-Vg: Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [Cgg-Vg: User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$   
 $Rp=1/G$   
 $Cs=(1+D^2)*Cp$   
 $X=-1/(2*PI*FREQ*Cs)$   
 $Rs=D*abs(X)$   
 $Z=sqrt(Rs^2+X^2)$   
 $Theta=atan(X/Rs)$   
 $Vgate=-Vsource$   
 $Cp\_S=Cp/Lg/Wg$   
 $Cp\_W=Cp/Wg$

[Cgg-Vg: X-Y Graph]

X axis: Gate voltage Vgate (LINEAR)  
Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)  
Y2 axis: Conductance G (LINEAR)

[Cgg-Vg: List Display]

Gate voltage Vgate  
Parallel capacitance Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta

[Id-Vg: Measurement Parameters]

Drain current Idrain

[Id-Vg: User Function]

$gm=\Delta(I_{drain})/\Delta(V_{gate})$   
 $gmMax=\max(gm)$

[Id-Vg: Analysis Function]

$V_{th}=@L1X$  (X intercept of Line1)

[Id-Vg: X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)  
Y1 axis: Drain current Idrain (LINEAR)  
Y2 axis: Transconductance gm (LINEAR)

[Id-Vg: List Display]

Gate current Igate

[Id-Vg: Parameters Display Area]

Maximum gm value gmMax  
Threshold voltage Vth

[Id-Vg: Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

## 2.29 VthAndCgg-Vg SCUU: Cgg-Vg, Id-Vg, using SCUU (A.01.20)

### [Description]

Measures the gate capacitance vs gate voltage characteristics, the drain current vs gate voltage measurement by using one MFCMU, three SMUs, and a set of SCUU/GSWU.

### [Device Under Test]

MOSFET, 4 terminals

### [Required Modules and Accessories]

One MFCMU module, three SMU modules, and a set of SCUU/GSWU are required.

SCUU connections (Cgg-Vg): Output1: terminals other than Gate, Output2: Gate

SCUU connections (Id-Vg): Output1: Source and Substrate, Output2: Gate

Connection wire must be connected between the GSWU and the DUT interface High/Low guard lines for the capacitance measurements.

### [Device Parameters]

Polarity: Nch (CMU/SMU forces the specified value) or Pch (CMU/SMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

GateAC: CMU connected to Gate terminal (CV sweep measurement)

GateDC: SMU connected to Gate terminal (primary sweep, voltage output)

SourceDC: SMU connected to Source and Substrate terminal (constant voltage output)

Drain: SMU connected to Drain terminal (constant voltage output)

Vd: Drain current

IntegTime: Integration time

IgLimit: Gate current compliance

IdLimit: Drain current compliance

IsLimit: Source current compliance

HoldTime: Hold time

DelayTime: Delay time

VgsBiasStart: Cgg-Vg measurement start voltage

VgsBiasStop: Cgg-Vg measurement stop voltage

VgsBiasStep: Cgg-Vg measurement step voltage

OscLevel: Cgg-Vg measurement signal level

FREQ: Cgg-Vg measurement frequency

VgsStartDC: Id-Vg measurement start voltage

VgsStopDC: Id-Vg measurement stop voltage

VgsStepDC: Id-Vg measurement step voltage

### [Extended Test Parameters]

DrainMinRng: Minimum range for the drain current measurement

GateMinRng: Minimum range for the gate current measurement

### [Cgg-Vg: Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [Cgg-Vg: User Function]

PI=3.141592653589

D=G/(2\*PI\*FREQ\*Cp)

$R_p=1/G$   
 $C_s=(1+D^2)*C_p$   
 $X=-1/(2*PI*FREQ*C_s)$   
 $R_s=D*abs(X)$   
 $Z=sqrt(R_s^2+X^2)$   
 $Theta=atan(X/R_s)$   
 $V_{gate}=-V_{source}$   
 $C_{p\_S}=C_p/L_g/W_g$   
 $C_{p\_W}=C_p/W_g$

[Cgg-Vg: X-Y Graph]

X axis: Gate voltage  $V_{gate}$  (LINEAR)  
Y1 axis: Gate capacitance (parallel capacitance)  $C_p$  (LINEAR)  
Y2 axis: Conductance  $G$  (LINEAR)

[Cgg-Vg: List Display]

Gate voltage  $V_{gate}$   
Parallel capacitance  $C_p$   
Conductance  $G$   
Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $Theta$

[Id-Vg: Measurement Parameters]

Drain current  $I_{drain}$

[Id-Vg: User Function]

$gm=\Delta(I_{drain})/\Delta(V_{gate})$   
 $gmMax=\max(gm)$

[Id-Vg: Analysis Function]

$V_{th}=@L1X$  (X intercept of Line1)

[Id-Vg: X-Y Plot]

X axis: Gate voltage  $V_{gate}$  (LINEAR)  
Y1 axis: Drain current  $I_{drain}$  (LINEAR)  
Y2 axis: Transconductance  $gm$  (LINEAR)

[Id-Vg: List Display]

Gate current  $I_{gate}$

[Id-Vg: Parameters Display Area]

Maximum  $gm$  value  $gmMax$   
Threshold voltage  $V_{th}$

[Id-Vg: Auto Analysis]

Line1: Tangent line for Y1 at  $gm=gmMax$

## 2.30 Vth-Lg: Vth-Lg characteristics (A.01.20)

### [Description]

Measures the Id-Vg characteristics of MOSFET with different Lg (gate length) and plots the Vth's dependency on Lg (threshold voltage).

### [Device Under Test]

MOSFET, 4 terminals

### [Required Modules and Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the G#/D#/E#/S#/Sb# field (# is an integer from 1 to 12) of Test Parameters area.

The maximum number of devices connected at once depends on the number of matrix modules mounted on B2200A/B2201A. Maximum three devices can be connected to one module at once.

### [Setting of Lg#/G#/D#/S#/Sb# field (# is an integer from 1 to 12)]

Set one device for Lg#(gate length)/G#(gate)/D#(drain)/S#(source)/Sb#(substrate). Lg1&lt;Lg2&lt;Lg3... must be satisfied. Enter zero for a field with no device.

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Temp: Temperature (deg)

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

GateSMU: SMU connected to Gate terminal, primary sweep voltage output

DrainSMU: SMU connected to Drain terminal, constant voltage output

SbSMU: SMU connected to Substrate, constant voltage output

SourceSMU: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage, ideally at around 100mV

Vsubs: Substrate voltage

Wg: Gate width

Lg1 - Lg12: Gate length for MOSFETs

G1 - G12: SWM Pin Assign setting for Gate of devices

D1 - D12: SWM Pin Assign setting for Drain of devices

S1 - S12: SWM Pin Assign setting for Source of devices

Sb1 - Sb12: SWM Pin Assign setting for Subs of devices

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time

Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
gmMax\_Min: Minimum gmMax value for graph scale  
gmMax\_Max: Maximum gmMax value for graph scale  
DrainMinRng: Minimum range for drain current measurement

[Measurement Parameters]

Idrain: Drain current

[User Function]

gm=diff(Idrain,Vgate)

[Analysis Function]

gmMax=max(gm)

Von=@L1X (X intercept of Line1)

Vth=Von-Vd/2

Vth is given by the following formula.

$V_{th} = V_g(gm_{Max}) - I_d(gm_{Max})/gm_{Max}$

Vd/2 is for compensation of the secondary term of Vd in the theoretical formula.

[Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

[X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Transconductance gm (LINEAR)

Y3 axis: Drain current Idrain (LOG)

[List Display]

Gate voltage Vgate

Source voltage Vsource

Drain voltage Vdrain

Substrate voltage Vsubs

Drain current Idrain

Transconductance gm

[Parameters Display Area]

Threshold voltage Vth

Maximum transconductance value gmMax

[Test Output: X-Y Graph]

X axis: Gate length LgList (LINEAR)

Y1 axis: Threshold voltage VthList (LINEAR)

Y2 axis: Maximum transconductance value gmMaxList (LINEAR)

[Test Output: List Display]

Gate length LgList

Threshold voltage VthList

Maximum transconductance value gmMaxList

## 2.31 Vth-Wg: Vth-Wg characteristics (A.01.20)

### [Description]

Measures the Id-Vg characteristics of MOSFET with different Wg (gate width) and plots the Vth's dependency on Wg (threshold voltage).

### [Device Under Test]

MOSFET, 4 terminals

### [Required Modules and Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the G#/D#/E#/S#/Sb# field (# is an integer from 1 to 12) of Test Parameters area.

The maximum number of devices connected at once depends on the number of matrix modules mounted on B2200A/B2201A. Maximum three devices can be connected to one module at once.

### [Setting of Wg#/G#/D#/S#/Sb# field (# is an integer from 1 to 12)]

Set one device for Wg#(gate width)/G#(gate)/D#(drain)/S#(source)/Sb#(substrate). Wg1<Wg2<Wg3... must be satisfied. Enter zero for a field with no device.

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Temp: Temperature (deg)

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

GateSMU: SMU connected to Gate terminal, primary sweep voltage output

DrainSMU: SMU connected to Drain terminal, constant voltage output

SbSMU: SMU connected to Substrate, constant voltage output

SourceSMU: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage, ideally at around 100mV

Vsubs: Substrate voltage

Lg: Gate length

Wg1 - Wg12: Gate width for MOSFETs

G1 - G12: SWM Pin Assign setting for Gate of devices

D1 - D12: SWM Pin Assign setting for Drain of devices

S1 - S12: SWM Pin Assign setting for Source of devices

Sb1 - Sb12: SWM Pin Assign setting for Subs of devices

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

IsubsLimit: Substrate current compliance

HoldTime: Hold time

DelayTime: Delay time



Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
gmMax\_Min: Minimum gmMax value for graph scale  
gmMax\_Max: Maximum gmMax value for graph scale  
DrainMinRng: Minimum range for drain current measurement

[Measurement Parameters]

Idrain: Drain current

[User Function]

gm=diff(Idrain,Vgate)

[Analysis Function]

gmMax=max(gm)

Von=@L1X (X intercept of Line1)

Vth=Von-Vd/2

Vth is given by the following formula.

$V_{th} = V_g(gm_{Max}) - I_d(gm_{Max}) / gm_{Max}$

Vd/2 is for compensation of the secondary term of Vd in the theoretical formula.

[Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

[X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Transconductance gm (LINEAR)

Y3 axis: Drain current Idrain (LOG)

[List Display]

Gate voltage Vgate

Source voltage Vsource

Drain voltage Vdrain

Substrate voltage Vsubs

Drain current Idrain

Transconductance gm

[Parameters Display Area]

Threshold voltage Vth

Maximum transconductance value gmMax

[Test Output: X-Y Graph]

X axis: Gate width WgList (LINEAR)

Y1 axis: Threshold voltage VthList (LINEAR)

Y2 axis: Maximum transconductance value gmMaxList (LINEAR)

[Test Output: List Display]

Gate width WgList

Threshold voltage VthList

Maximum transconductance value gmMaxList



### 3 Discrete

1. BJT GummelPlot: Bipolar transistor gummel characteristics (A.01.20)
2. BJT  $I_c$ - $V_c$   $I_b$  : Bipolar transistor  $I_c$ - $V_c$  characteristics (A.01.20)
3. Diode IV Fwd: Diode forward bias characteristics (A.01.20)
4. Diode IV Rev: Diode reverse bias characteristics (A.01.20)
5. FET  $I_d$ - $V_d$ : MOSFET  $I_d$ - $V_d$  characteristics (A.01.20)
6. FET  $I_d$ - $V_g$  : MOSFET  $I_d$ - $V_g$  characteristics (A.01.20)

### 3.1 *BJT GummelPlot: Bipolar transistor gummel characteristics (A.01.20)*

[Description]

Measures the gummel characteristics of bipolar transistor.

[Device Under Test]

Bipolar junction transistor

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

Pmax: Power compliance

[Test Parameters]

IntegTime: Integration time

Base: SMU connected to Base terminal, primary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Collector: SMU connected to Collector terminal, constant voltage output

Vc: Collector voltage

Emitter: SMU connected to Emitter terminal, constant voltage output

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

[Measurement Parameters]

Base current Ibase

Collector current Icurrent

[User Function]

$I_{ePerArea} = I_{emitter} / Le / We$

$I_{bPerArea} = I_{base} / Le / We$

$I_{cPerArea} = I_{collector} / Le / We$

$hfe = I_{collector} / I_{base}$

[Analysis Function]

$hf_{max} = \max(hfe)$

[X-Y Plot]

X axis: Base voltage Vbase (LINEAR)

Y1 axis: Base current Ibase (LOG)

Y2 axis: Collector current Icollector (LOG)

Y3 axis: Current amplification factor hfe (LINEAR)

[User Function]

Emitter current per unit area of Emitter  $I_{ePerArea}$

Base current per unit area of Emitter  $I_{bPerArea}$   
Collector current per unit area of Emitter  $I_{cPerArea}$

[Parameters Display Area]  
hfe maximum value hfemax

### 3.2 BJT $I_c$ - $V_c$ $I_b$ : Bipolar transistor $I_c$ - $V_c$ characteristics (A.01.20)

[Description]

Measures the collector current vs collector voltage characteristics of bipolar transistor.

[Device Under Test]

Bipolar junction transistor

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Temp: Temperature

IcMax: Collector current compliance

Pmax: Power compliance

[Test Parameters]

IntegTime: Integration time

Collector: SMU connected to Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

Base: SMU connected to Base terminal, secondary sweep voltage output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

VbLimit: Base voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

[Measurement Parameters]

Collector current Icollector

Base current Ibase

[User Function]

$hfe = I_{collector} / I_{base}$

$V_A = I_{collector} * \text{diff}(V_{collector}, I_{collector}) - V_{collector}$

[X-Y Plot]

X axis: Collector voltage Vcollector (LINEAR)

Y1 axis: Collector current Icollector (LINEAR)

[User Function]

Current amplifier factor hfe

Early voltage VA

[List Display]

Base current Ibase

### **3.3 Diode IV Fwd: Diode forward bias characteristics (A.01.20)**

[Description]

Measures the forward bias anode voltage vs anode current characteristics.

[Device Under Test]

Diode

[Device Parameters]

Temp: Temperature

Imax: Current compliance

[Test Parameters]

IntegTime: Integration time

Anode: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Cathode: SMU connected to Cathode terminal, constant voltage output

[Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

[Measurement Parameters]

Anode current Ianode

[X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Anode current Ianode (LINEAR)

Y2 axis: Anode current Ianode (LOG)

### ***3.4 Diode IV Rev: Diode reverse bias characteristics (A.01.20)***

[Description]

Measures the reverse bias anode voltage vs anode current characteristics.

[Device Under Test]

Diode

[Device Parameters]

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

Anode: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

IanodeLimit: Anode current compliance

Cathode: SMU connected to Cathode terminal, constant voltage output

[Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

[Measurement Parameters]

Anode current Ianode

[X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Anode current Ianode (LOG)



### **3.5 FET Id-Vd: MOSFET Id-Vd characteristics (A.01.20)**

[Description]

Measures the drain current vs drain voltage characteristics of MOSFET.

[Device Under Test]

MOSFET, 3 terminals

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Source: SMU connected to Source terminal, constant voltage output

[Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

[Measurement Parameters]

Drain current Idrain

[X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### 3.6 *FET Id-Vg : MOSFET Id-Vg characteristics (A.01.20)*

[Description]

Measures the drain current vs gate voltage characteristics of MOSFET.

[Device Under Test]

MOSFET, 3 terminals

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Source: SMU connected to Source terminal, constant voltage output

[Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

[Measurement Parameters]

Drain current Idrain

[User Function]

gm: Transconductance  $gm = \text{diff}(\text{Idrain}, \text{Vgate})$

[X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

Y3 axis: Transconductance gm (LINEAR)

## 4 Memory

1. Flash Ccf-V: Flash memory cell Control Gate to Floating Gate capacitance (A.01.11)
2. Flash Cfb-V: Flash memory cell Floating Gate-Substrate capacitance (A.01.11)
3. Flash Cgg-Vcg: Flash memory cell Gate capacitance (A.01.11)
4. NandFlash2 Endurance 3devices:  
Repeatedly tests write/erase on a NAND-type flash memory cell, simultaneously using three devices (A.01.20).
5. NandFlash2 Endurance: NAND flash memory cell endurance test (A.01.20)
6. NandFlash2 IV-Erase-IV: NAND flash memory cell Id-Vg, Erase, Id-Vg (A.01.20)
7. NandFlash2 IV-Write-IV: NAND flash memory cell Id-Vg, Write, Id-Vg (A.01.20)
8. NandFlash2 Retention(ErasedCell):  
NAND flash memory cell Data retention test after Erase (A.01.20)
9. NandFlash2 Retention(WrittenCell):  
NAND flash memory cell Data retention test after Write (A.01.20)
10. NandFlash2 Vth(ErasingTimeDependence):  
NAND flash memory cell erasing time dependence test (A.01.20)
11. NandFlash2 Vth(WritingTimeDependence):  
NAND flash memory cell writing time dependence test (A.01.20)
12. NandFlash2 WordDisturb(ErasedCell):  
NAND flash memory cell erase-disturb test (A.01.20)
13. NandFlash2 WordDisturb(WrittenCell):  
NAND flash memory cell read-disturb test (A.01.20)

## 4.1 *Flash Ccf-V: Flash memory cell Control Gate to Floating Gate capacitance (A.01.11)*

### [Description]

Measures the Control Gate to Floating Gate capacitance (Ccf), and plots the Ccf-V characteristics.

### [Device Under Test]

Flash memory cell

Connect the Control Gate to CMU High and the Floating Gate to CMU Low.

Connect the other terminals to the ground unit (GNDU).

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

M: Number of cells connected in parallel. M=1 for the single cell.

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

ControlGate: CMU connected between Control Gate and Floating Gate (CV sweep measurement)

VcfStart: DC bias start voltage

VcfStop: DC bias stop voltage

VcfStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

Theta=atan(X/Rs)

CsPerCell=Cs/M

CpPerCell=Cp/M

### [X-Y Graph]

X axis: DC bias Vcontrolgate (LINEAR)

Y1 axis: Control Gate to Floating Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

Y3 axis: Conductance G (LINEAR)

### [List Display]

Measurement frequency Freq  
DC bias Vcontrolgate  
Control Gate to Floating Gate capacitance (parallel capacitance) Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Series capacitance per cell CsPerCell  
Parallel capacitance per cell CpPerCell

## 4.2 *Flash Cfb-V: Flash memory cell Floating Gate-Substrate capacitance (A.01.11)*

### [Description]

Measures the Floating Gate-Substrate capacitance (Ccf), and plots the Cfb-V characteristics.  
DC bias output is performed from -VfbStart to -VfbStop in -VfbStep steps.

### [Device Under Test]

Flash memory cell

Connect the Control Gate to ground unit (GNDU), the Floating Gate to CMU Low, and the other terminals to CMU High.

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

M: Number of cells connected in parallel. M=1 for the single cell.

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

FloatingGate: CMU connected between Floating Gate and Substrate (CV sweep measurement)

VfbStart: DC bias start voltage

VfbStop: DC bias stop voltage

VfbStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

$PI=3.141592653589$

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$CsPerCell=Cs/M$

$CpPerCell=Cp/M$

$Vfb=-Vsubs$

### [X-Y Graph]

X axis: DC bias Vfb (LINEAR)

Y1 axis: Floating Gate-Substrate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

Y3 axis: Conductance G (LINEAR)

[List Display]

Measurement frequency Freq

DC bias Vfb

Floating Gate-Substrate capacitance (parallel capacitance) Cp

Conductance G

Series capacitance Cs

Series resistance Rs

Parallel resistance Rp

Dissipation factor D

Reactance X

Impedance Z

Phase Theta

Series capacitance per cell CsPerCell

Parallel capacitance per cell CpPerCell

### 4.3 *Flash Cgg-Vcg: Flash memory cell Gate capacitance (A.01.11)*

[Description]

Measures the Gate capacitance (Cgg), and plots the Cgg-Vcs characteristics.  
DC bias output is performed from -VcsStart to -VcsStop in -VcsStep steps.

[Device Under Test]

Flash memory cell  
Open the Floating Gate, and connect the Control Gate to CMU Low and the other terminals to CMU High.

[Device Parameters]

Lg: Gate length  
Wg: Gate width  
Temp: Temperature  
M: Number of cells connected in parallel. M=1 for the single cell.

[Test Parameters]

IntegTime: Integration time  
FREQ: Measurement frequency  
OscLevel: Measurement signal level  
ControlGate: CMU connected between Control Gate and Substrate (CV sweep measurement)  
VcsStart: DC bias start voltage  
VcsStop: DC bias stop voltage  
VcsStep: DC bias step voltage

[Extended Test Parameters]

HoldTime: Hold time  
DelayTime: Delay time

[Measurement Parameters]

Parallel capacitance Cp  
Conductance G

[User Function]

$PI=3.141592653589$   
 $D=G/(2*PI*FREQ*Cp)$   
 $Rp=1/G$   
 $Cs=(1+D^2)*Cp$   
 $X=-1/(2*PI*FREQ*Cs)$   
 $Rs=D*abs(X)$   
 $Z=sqrt(Rs^2+X^2)$   
 $Theta=atan(X/Rs)$   
 $CsPerCell=Cs/M$   
 $CpPerCell=Cp/M$   
 $Vcs=-Vsubs$

[X-Y Graph]

X axis: DC bias Vcs (LINEAR)  
Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)  
Y2 axis: Dissipation factor D (LINEAR)  
Y3 axis: Conductance G (LINEAR)

[List Display]

Measurement frequency Freq



DC bias  $V_{cs}$   
Gate capacitance (parallel capacitance)  $C_p$   
Conductance  $G$   
Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $\Theta$   
Series capacitance per cell  $C_{sPerCell}$   
Parallel capacitance per cell  $C_{pPerCell}$

#### **4.4 NandFlash2 Endurance 3devices: Repeatedly tests write/erase on a NAND-type flash memory cell, simultaneously using three devices (A.01.20)**

[Description]

Repeatedly tests write/erase on a NAND-type flash memory cell. Plots the number of writes/erases vs threshold voltage characteristic. Maximum three devices can be measured at once.

[Device Under Test]

NAND-type flash memory cell, 4 terminals x 3 devices

When some device is destroyed during write/erase, a desired voltage may not be applied to other devices.

[Required Modules and Accessories]

Agilent B2200A or B2201A switching matrix 1 unit

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

GPIB cable

Connect 81110A, B2200A/B2201A and B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set information on 811100A output channel's connection to B2200A/B2201A input port properly in the Parameters area of PulseGate and PulseDrain fields. Set B2200A/B2201A input ports connected to the output channel of a gate pulse and drain pulse in these fields.

Set the output channel number of B2200A/B2201A connected to each terminal of a measured device properly in the Tr#Gate/Tr#Drain/Tr#Source/Tr#Subs field (# is an integer from 1 to 3) of the Test Parameters area.

[Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

TotalWriteAndEraseCycles: Number of write/erase cycles

Tr1Gate - Tr3Gate: SWM Pin Assign setting for Gate of devices

Tr1Drain - Tr3Drain: SWM Pin Assign setting for Drain of devices

Tr1Source - Tr3Source: SWM Pin Assign setting for Source of devices

Tr1Subs - Tr3Subs: SWM Pin Assign setting for Subs of devices

PgAdd: GPIB address of pulse generator

PulseGate: SMU connected to Gate terminal

PulseDrain: SMU connected to Drain terminal

ErasePeriod: Write/Erase pulse period

EraseDelay: Write/Erase pulse delay

EraseWidth: Write/Erase pulse width

EraseLeadTime: Pulse leading edge transition time

EraseTrailTime: Pulse trailing edge transition time

Verase: Pulse voltage output level, High

BaseValue: Pulse voltage output level, Low

[Test Parameters for Vth Acquisition]

MeasGate: SMU connected to Gate terminal

MeasDrain: SMU connected to Drain terminal

MeasSource: SMU connected to Source terminal  
VgStart: Sweep start voltage for Gate terminal  
VgStop: Sweep stop voltage for Gate terminal  
VgStep: Sweep step voltage for Gate terminal  
Vd: Drain voltage  
IgLimit: Gate current compliance  
Id@Vth: Current determining the threshold voltage

[Extended Test Parameters for Vth Acquisition]

Vs: Source voltage  
HoldTime: Hold time  
DelayTime: Delay time  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 2  
DrainMinRng3: Minimum range for drain current measurement on device 3

[Measurement Parameters]

[Measurement Parameters for Vth Acquisition after Write Operation]  
Drain current: Idrain

[Measurement Parameters for Vth Acquisition after Erase Operation]  
Drain current: Idrain

[Analysis Function]

[Analysis Function for Vth Acquisition after Write Operation]  
Vth@Id=@L1X (X intercept of Line1)

[Analysis Function for Vth Acquisition after Erase Operation]  
Vth@Id=@L1X (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for Vth Acquisition after Write Operation]  
Line1: Idrain=X intercept of Id@Vth

[Auto Analysis for Vth Acquisition after Erase Operation]  
Line1: Idrain=X intercept of Id@Vth

[X-Y Plot]

[X-Y Plot for Vth Acquisition after Write Operation]  
X axis: Gate voltage Vgate (LINEAR)  
Y1 axis: Drain current Idrain (LOG)

[X-Y Plot for Vth Acquisition after Erase Operation]  
X axis: Gate voltage Vgate (LINEAR)  
Y1 axis: Drain current Idrain (LOG)

[List Display]

[List Display for Vth Acquisition after Write Operation]  
Gate voltage Vgate  
Drain current Idrain

[List Display for Vth Acquisition after Erase Operation]  
Gate voltage Vgate

Drain current I<sub>drain</sub>

[Test Output: X-Y Graph]

X axis: Number of write/erase cycles CycleList (LOG)

Y1 axis: V<sub>th</sub> value after write operation on device 1 Dev1\_VthWrittenList (LINEAR)

Y2 axis: V<sub>th</sub> value after write operation on device 2 Dev2\_VthWrittenList (LINEAR)

Y3 axis: V<sub>th</sub> value after write operation on device 3 Dev3\_VthWrittenList (LINEAR)

Y4 axis: V<sub>th</sub> value after erase operation on device 1 Dev1\_VthErasedList (LINEAR)

Y5 axis: V<sub>th</sub> value after erase operation on device 2 Dev2\_VthErasedList (LINEAR)

Y6 axis: V<sub>th</sub> value after erase operation on device 3 Dev3\_VthErasedList (LINEAR)

[Test Output: List Display]

Number of write/erase cycles CycleList

V<sub>th</sub> value after write operation on device 1 Dev1\_VthWrittenList

V<sub>th</sub> value after write operation on device 2 Dev2\_VthWrittenList

V<sub>th</sub> value after write operation on device 3 Dev3\_VthWrittenList

V<sub>th</sub> value after erase operation on device 1 Dev1\_VthErasedList

V<sub>th</sub> value after erase operation on device 2 Dev2\_VthErasedList

V<sub>th</sub> value after erase operation on device 3 Dev3\_VthErasedList

[Test Setup Details]

Refer to "NandFlash2 IV-Write-IV" and "NandFlash2 IV-Erase-IV."

## 4.5 *NandFlash2 Endurance: NAND flash memory cell endurance test (A.01.20)*

### [Description]

Performs the endurance test for the NAND type flash memory cell and plots the number of write/erase operation vs threshold voltage characteristics.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU1 Output, and the Drain to the ASU2 Output.

Open the Floating Gate, and connect the other terminals to the ASU3 Output.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 3 sets (ASU1, ASU2, and ASU3)

ASU1 connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

ASU2 connections: Output: Drain, SMU: HRSMU, AUX: PGU2

ASU3 connections: Output: Source and Substrate, SMU: HRSMU, AUX: PGU2

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source and Substrate terminals, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

TotalWriteAndEraseCycles: Total number of write/erase operation

WritePulsePeriod: Write pulse period

WritePulseDelay: Write pulse delay

WritePulseWidth: Write pulse width

WriteLeadingTime: Write pulse leading edge transition time

WriteTrailingTime: Write pulse trailing edge transition time

Vwrite: Write pulse output level

ErasePulsePeriod: Erase pulse period

ErasePulseDelay: Erase pulse delay

ErasePulseWidth: Erase pulse width

EraseLeadingTime: Erase pulse leading edge transition time

EraseTrailingTime: Erase pulse trailing edge transition time

Verase: Erase pulse output level

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time  
PgAdd: GPIB address of pulse generator  
BaseValue: Pulse base value  
NoOfPulse: Number of output pulses

[Test Output: X-Y Graph]

X axis: Number of write/erase operation (LOG)  
Y1 axis: Threshold voltage after write VthWrittenList (LINEAR)  
Y2 axis: Threshold voltage after erase VthErasedList (LINEAR)

[Test Setup Details]

See NandFlash2 IV-Write-IV and NandFlash2 IV-Erase-IV.

## **4.6 *NandFlash2 IV-Erase-IV: NAND flash memory cell Id-Vg, Erase, Id-Vg (A.01.20)***

### [Description]

Measures the Id-Vg characteristics of NAND-type flash memory cell, performs the data erase operation, measures the Id-Vg characteristics again, and plots the both Id-Vg characteristics on a graph. Uses pulse generator (2-output) 1 unit and HRSMU/ASU 2 sets.

Before the Id-Vg measurements, the initial pulse will be applied to the device under test.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to a SMU and the Drain to the ASU1 Output.

Open the Floating Gate. And connect the other terminals to the ASU2 Output.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 2 sets (ASU1 and ASU2)

ASU1 connections: Output: Drain, SMU: HRSMU, AUX: PGU1

ASU2 connections: Output: Source and Substrate, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

PGU1 is connected to keep the setup for the data write operation.

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Id@Vth: Drain current to decide the Vth

Source: SMU connected to Source and Substrate terminals, constant voltage output

PulsePeriod: Erase pulse period

PulseDelay: Erase pulse delay

PulseWidth: Erase pulse width

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

Verase: Erase pulse output level

### [Extended Test Parameters]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Erase pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the erase operation

[Initial pulse setup parameters]

Pulse period Period2=50 s

Pulse delay Delay2=0 s

Pulse duty cycle Dcyc2=50 %

Pulse output level Level2=0 V

Pulse base value Base2=200 mV

Number of output pulses TrigCount=1

The parameters are defined in the ForcePG2 setup of the Test Contents, and can be changed by using the Test Definition editor.

[Measurement Parameters]

Drain current Idrain (defined in Id-Vg\_Initial and Id-Vg\_Erased setup)

[User Function]

IdrainPerWg=Idrain/Wg (defined in Id-Vg\_Initial and Id-Vg\_Erased setup)

[Analysis Function]

VthBefore=@L1X (X intercept of Line1, defined in Id-Vg\_Initial setup)

VthAfter=@L1X (X intercept of Line1, defined in Id-Vg\_Erased setup)

[Auto Analysis]

Line1: Vertical line for Y1 at Idrain=Id@Vth

[Test Output: X-Y Graph]

X axis: Gate voltage VgateList (LINEAR)

Y1 axis: Drain current before Erase operation IdInitialList (LOG)

Y2 axis: Drain current after Erase operation IdErasedList (LOG)

[Test Output: Parameters]

Threshold voltage before Erase operation VthInitial

Threshold voltage after Erase operation VthErased



## **4.7 *NandFlash2 IV-Write-IV: NAND flash memory cell Id-Vg, Write, Id-Vg (A.01.20)***

### [Description]

Measures the Id-Vg characteristics of NAND-type flash memory cell, performs the data write operation, measures the Id-Vg characteristics again, and plots the both Id-Vg characteristics on a graph. Uses pulse generator (2-output) 1 unit and HRSMU/ASU 1 set.

Before the Id-Vg measurements, the initial pulse will be applied to the device under test.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU Output, and the Drain to a SMU.

Open the Floating Gate. And connect the other terminals to a SMU.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 1 set

ASU connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Id@Vth: Drain current to decide the Vth

Source: SMU connected to Source and Substrate terminals, constant voltage output

PulsePeriod: Write pulse period

PulseDelay: Write pulse delay

PulseWidth: Write pulse width

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

Vwrite: Write pulse output level

### [Extended Test Parameters]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Write pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the write operation

### [Initial pulse setup parameters]

Pulse period  $\text{Period2}=50$  s  
Pulse delay  $\text{Delay2}=0$  s  
Pulse duty cycle  $\text{Dcyc2}=50$  %  
Pulse output level  $\text{Level2}=0$  V  
Pulse base value  $\text{Base2}=200$  mV  
Number of output pulses  $\text{TrigCount}=1$

The parameters are defined in the ForcePG2 setup of the Test Contents, and can be changed by using the Test Definition editor.

[Measurement Parameters]

Drain current  $\text{Idrain}$  (defined in  $\text{Id-Vg\_Initial}$  and  $\text{Id-Vg\_Written}$  setup)

[User Function]

$\text{IdrainPerWg}=\text{Idrain}/\text{Wg}$  (defined in  $\text{Id-Vg\_Initial}$  and  $\text{Id-Vg\_Written}$  setup)

[Analysis Function]

$\text{VthBefore}=@\text{L1X}$  (X intercept of Line1, defined in  $\text{Id-Vg\_Initial}$  setup)

$\text{VthAfter}=@\text{L1X}$  (X intercept of Line1, defined in  $\text{Id-Vg\_Written}$  setup)

[Auto Analysis]

Line1: Vertical line for Y1 at  $\text{Idrain}=\text{Id@Vth}$

[Test Output: X-Y Graph]

X axis: Gate voltage  $\text{VgateList}$  (LINEAR)

Y1 axis: Drain current before Write operation  $\text{IdInitialList}$  (LOG)

Y2 axis: Drain current after Write operation  $\text{IdWrittenList}$  (LOG)

[Test Output: Parameters]

Threshold voltage before Write operation  $\text{VthInitial}$

Threshold voltage after Write operation  $\text{VthWritten}$

## 4.8 *NandFlash2 Retention(ErasedCell): NAND flash memory cell Data retention test after Erase (A.01.20)*

### [Description]

Performs the data retention test for the NAND type flash memory cell after the erase operation, and plots the accumulated time vs threshold voltage characteristics. The test is performed as follows.

1. Applies the erase pulse.
2. Measures the Id-Vg characteristics, and extracts the threshold voltage (Vth).
3. If the accumulated time is 100 seconds or less:  
Performs the drain current sampling measurement, 10 seconds in 1 second step.  
After the sampling measurement, measures the Id-Vg characteristics and extracts Vth.
4. If the accumulated time is more than 100 seconds:  
Performs the drain current sampling measurement, 100 seconds in 10 seconds step.  
After the sampling measurement, measures the Id-Vg characteristics and extracts Vth.
5. Repeats 3 or 4 until that the accumulated time overs the specified TotalRetentionTime.  
The available TotalRetentionTime value is 10 to 10000 seconds.

### [Device Under Test]

NAND-type flash memory cell

Connect the Source and Substrate to the ASU1 Output, and the Drain to the ASU2 Output.

Open the Floating Gate, and connect the other terminals to the PGU2 output terminal.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 2 sets (ASU1 and ASU2)

ASU1 connections: Output: Source and Substrate, SMU: HRSMU, AUX: PGU1

ASU2 connections: Output: Drain, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

PGU1 is connected to keep the setup for the data write operation.

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source and Substrate terminals, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

PulsePeriod: Erase pulse period

PulseDelay: Erase pulse delay

PulseWidth: Erase pulse width

Verase: Erase pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

TotalRetentionTime: Time to continue the test. 10 to 10000 seconds.

[Extended Test Parameters]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Erase pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the erase operation

[Test Output: X-Y Graph]

X axis: Time TimeList (LOG)

Y1 axis: Threshold voltage VthList (LINEAR)

[Test Setup Details]

See NandFlash2 IV-Erase-IV.

## **4.9 NandFlash2 Retention(WrittenCell): NAND flash memory cell Data retention test after Write (A.01.20)**

### [Description]

Performs the data retention test for the NAND type flash memory cell after the write operation, and plots the accumulated time vs threshold voltage characteristics. The test is performed as follows.

1. Applies the write pulse.
2. Measures the Id-Vg characteristics, and extracts the threshold voltage (Vth).
3. If the accumulated time is 100 seconds or less:  
Performs the drain current sampling measurement, 10 seconds in 1 second step.  
After the sampling measurement, measures the Id-Vg characteristics and extracts Vth.
4. If the accumulated time is more than 100 seconds:  
Performs the drain current sampling measurement, 100 seconds in 10 seconds step.  
After the sampling measurement, measures the Id-Vg characteristics and extracts Vth.
5. Repeats 3 or 4 until that the accumulated time overs the specified TotalRetentionTime.  
The available TotalRetentionTime value is 10 to 10000 seconds.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU Output, and the Drain to a SMU.

Open the Floating Gate, and connect the other terminals to a SMU.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 1 set

ASU connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source and Substrate terminals, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

PulsePeriod: Write pulse period

PulseDelay: Write pulse delay

PulseWidth: Write pulse width

Vwrite: Write pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

TotalRetentionTime: Time to continue the test. 10 to 10000 seconds.

[Extended Test Parameters]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

PgAdd: GPIB address of pulse generator

BaseValue: Write pulse base value

NoOfPulse: Number of output pulses for the write operation

[Test Output: X-Y Graph]

X axis: Time TimeList (LOG)

Y1 axis: Threshold voltage VthList (LINEAR)

[Test Setup Details]

See NandFlash2 IV-Write-IV.

## ***4.10 NandFlash2 Vth(ErasingTimeDependence): NAND flash memory cell erasing time dependence test (A.01.20)***

### [Description]

Performs the erasing time dependence test of the NAND-type flash memory cell, and plots the accumulated erasing time (accumulated pulse width) vs threshold voltage characteristics.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to a SMU, and the Drain to the ASU2 Output.

Open the Floating Gate, and connect the other terminals to the ASU1 Output.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 2 sets (ASU1 and ASU2)

ASU1 connections: Output: Source and Substrate, SMU: HRSMU, AUX: PGU1

ASU2 connections: Output: Drain, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Vs: Source voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

PulsePeriod: Erase pulse period

PulseDelay: Erase pulse delay

PulseWidth: Total accumulated pulse width

CheckNoOfTimes: Number of Vth measurement operation

Verase: Erase pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

### [Extended Test Parameter]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Erase pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the erase operation

[Measurement Parameters]

Drain current  $I_{\text{drain}}$

[Analysis Function]

$V_{\text{th}} = @L1X$  (X intercept of Line1)

[Auto Analysis]

Line1: Vertical line for Y1 at  $I_{\text{drain}} = I_{\text{d}} @ V_{\text{th}}$

[Test Output: X-Y Graph]

X axis: Accumulated erasing pulse width EraseTimeList (LOG)

Y1 axis: Threshold voltage  $V_{\text{th}}$  (LINEAR)



## ***4.11 NandFlash2 Vth(WritingTimeDependence): NAND flash memory cell writing time dependence test (A.01.20)***

### [Description]

Performs the writing time dependence test of the NAND-type flash memory cell, and plots the accumulated writing time (accumulated pulse width) vs threshold voltage characteristics.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU Output, and the Drain to a SMU.

Open the Floating Gate, and connect the other terminals to a SMU.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 1 set

ASU connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Vs: Source voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

PulsePeriod: Write pulse period

PulseDelay: Write pulse delay

PulseWidth: Total accumulated pulse width

CheckNoOfTimes: Number of Vth measurement operation

Vwrite: Write pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

### [Extended Test Parameter]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Write pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the write operation

### [Measurement Parameters]

Drain current  $I_{\text{drain}}$

[Analysis Function]

$V_{\text{th}} = @L1X$  (X intercept of Line1)

[Auto Analysis]

Line1: Vertical line for Y1 at  $I_{\text{drain}} = I_{\text{d}} @ V_{\text{th}}$

[Test Output: X-Y Graph]

X axis: Accumulated writing pulse width WriteTimeList (LOG)

Y1 axis: Threshold voltage  $V_{\text{th}}$  (LINEAR)

## **4.12 NandFlash2 WordDisturb(ErasedCell): NAND flash memory cell erase-disturb test (A.01.20)**

### [Description]

Performs the erase-disturb test of the NAND-type flash memory cell, and plots the accumulated stress time vs threshold voltage characteristics.

### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU1 Output, and the Drain to the ASU2 Output.

Open the Floating Gate, and connect the other terminals to the ASU3 Output.

### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 3 sets (ASU1, ASU2, and ASU3)

ASU1 connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

ASU2 connections: Output: Drain, SMU: HRSMU, AUX: PGU2

ASU3 connections: Output: Source and Substrate, SMU: HRSMU, AUX: PGU2

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Vs: Source voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

TotalStressTime: Total accumulated stress time

CheckNoOfTimes: Number of Vth measurement operation

PulsePeriod: Erase pulse period

PulseDelay: Erase pulse delay

PulseWidth: Erase pulse width

Verase: Erase pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

### [Extended Test Parameter]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Erase pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the erase operation

[Measurement Parameters]

Drain current Idrain

[Analysis Function]

Vth=@L1X (X intercept of Line1)

[Auto Analysis]

Line1: Vertical line for Y1 at Idrain=Id@Vth

[Test Output: X-Y Graph]

X axis: Accumulated stress time StressTimeList (LOG)

Y1 axis: Threshold voltage Vth (LINEAR)

### **4.13 NandFlash2 WordDisturb(WrittenCell): NAND flash memory cell read-disturb test (A.01.20)**

#### [Description]

Performs the read-disturb test of the NAND-type flash memory cell, and plots the accumulated stress time vs threshold voltage characteristics.

#### [Device Under Test]

NAND-type flash memory cell

Connect the Control Gate to the ASU Output, and the Drain to a SMU.

Open the Floating Gate, and connect the other terminals to a SMU.

#### [Required Modules and Accessories]

Agilent 81110A pulse generator (2-output, PGU1 and PGU2) 1 unit

HRSMU/ASU 1 set

ASU connections: Output: Control Gate, SMU: HRSMU, AUX: PGU1

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

#### [Device Parameters]

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

#### [Test Parameters]

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Vd: Drain voltage

Vs: Source voltage

Id@Vth: Drain current to decide the Vth

IntegTime: Integration time

TotalStressTime: Total accumulated stress time

CheckNoOfTimes: Number of Vth measurement operation

PulsePeriod: Write pulse period

PulseDelay: Write pulse delay

PulseWidth: Write pulse width

Vwrite: Write pulse output level

LeadingTime: Pulse leading edge transition time

TrailingTime: Pulse trailing edge transition time

#### [Extended Test Parameter]

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

BaseValue: Write pulse base value

PgAdd: GPIB address of pulse generator

NoOfPulse: Number of output pulses for the write operation

[Measurement Parameters]

Drain current  $I_{\text{drain}}$

[Analysis Function]

$V_{\text{th}} = @L1X$  (X intercept of Line1)

[Auto Analysis]

Line1: Vertical line for Y1 at  $I_{\text{drain}} = I_{\text{d}} @ V_{\text{th}}$

[Test Output: X-Y Graph]

X axis: Accumulated stress time StressTimeList (LOG)

Y1 axis: Threshold voltage  $V_{\text{th}}$  (LINEAR)

## 5 Mixed Signal

1. BJT Varactor CV Mismatch: BJT Varactor capacitance CV characteristics mismatch (A.01.11)
2. Diff-R Mismatch: Diffusion resistor R-I characteristics mismatch, Kelvin connection (A.01.11)
3. Diode IV Fwd Mismatch: Diode forward bias characteristics mismatch (A.01.20)
4. Diode IV Rev Mismatch: Diode reverse bias characteristics mismatch (A.01.20)
5. G-Plot ConstVce Mismatch: Gummel characteristics mismatch, Vce=Const (A.01.20)
6. G-Plot ConstVce Mismatch[3]: Gummel characteristics mismatch, Vce=Const, 3-terminal (A.01.20)
7. G-Plot Vbc=0V Mismatch: Gummel characteristics mismatch, Vbc=0 V (A.01.20)
8. G-Plot Vbc=0V Mismatch[3]: Gummel characteristics mismatch, Vbc=0, 3-terminal (A.01.20)
9. Ic-Vc Ib Mismatch: Ic-Vce characteristics mismatch, Ib sweep (A.01.20)
10. Ic-Vc Ib Mismatch[3]: Ic-Vce characteristics mismatch, Ib sweep, 3-terminal (A.01.20)
11. Ic-Vc Vb Mismatch: Ic-Vce characteristics mismatch, Vb sweep (A.01.20)
12. Ic-Vc Vb Mismatch[3]: Ic-Vce characteristics mismatch, Vb sweep, 3-terminal (A.01.20)
13. Id-Vd Mismatch: Id-Vd characteristics mismatch (A.01.20)
14. Id-Vd Mismatch[3]: Id-Vd characteristics mismatch, 3-terminal (A.01.20)
15. Id-Vg Mismatch: Id-Vg characteristics mismatch (A.01.20)
16. Id-Vd Mismatch[3]: Id-Vd characteristics mismatch, 3-terminal (A.01.20)
17. MIM CV Mismatch: MIM capacitor C-V characteristics mismatch (A.01.11)
18. MOS Varactor CV Mismatch: MOS Varactor capacitance CV characteristics mismatch (A.01.11)
19. Poly-R Mismatch: Resistor R-I characteristics mismatch, Kelvin connection (A.01.11)

## 5.1 BJT Varactor CV Mismatch: BJT Varactor capacitance CV characteristics mismatch (A.01.11)

### [Description]

Measures the BJT varactor capacitance (C-Vce characteristics) of device A, and measures the C-Vce characteristics of device B. After that, calculates the differences between capacitance values by using the following formula, and plots the results.

$\Delta C_p = (C_{pBList} - C_{pAList}) / C_{pAList} * 100$  for parallel capacitance

$\Delta C_s = (C_{sBList} - C_{sAList}) / C_{sAList} * 100$  for series capacitance

### [Device Under Test]

Bipolar junction transistor, 4 terminals, 2 ea.

Connect Base to the CMU Low, Collector to the CMU High, and the other terminals to the GNDU.

### [Device Parameters]

Polarity: NPN (CMU forces the specified value) or PNP (CMU forces the negative specified value).

Lb: Base length

Wb: Base width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Collector: CMU connected between Collector and Base (CV sweep measurement)

VcbStart: DC bias start voltage

VcbStop: DC bias stop voltage

VcbStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

To specify the device, A or B is added to the actual variable names.

$PI = 3.141592653589$

$Dval = Gval / (2 * PI * FREQ * Cpval)$

$Rpval = 1 / Gval$

$Csval = (1 + Dval^2) * Cpval$

$Xval = -1 / (2 * PI * FREQ * Csval)$

$Rsvall = Dval * abs(Xval)$

$Zval = \sqrt{Rsvall^2 + Xval^2}$

$Thetaval = atan(Xval / Rsvall)$

$Vceval = Vcollector$

### [X-Y Graph]

To specify the device, A or B is added to the actual variable names.

X axis: Collector-Emitter voltage Vceval (LINEAR)

Y1 axis: Collector capacitance (parallel capacitance) Cpval (LINEAR)



Y2 axis: Conductance Gval (LINEAR)

[List Display]

To specify the device, A or B is added to the actual variable names.

Collector-Emitter voltage Vceval

Parallel capacitance Cpval

Conductance Gval

Series capacitance Csval

Series resistance Rsval

Parallel resistance Rpval

Dissipation factor Dval

Reactance Xval

Impedance Zval

Phase Thetaval

[Test Output: X-Y Graph]

X axis: Collector-Emitter voltage VceList (LINEAR)

Y1 axis: Collector capacitance (parallel capacitance) CpAList (LINEAR)

Y2 axis: Collector capacitance (parallel capacitance) CpBList (LINEAR)

Y3 axis: Differences between Cp DeltaCp (LINEAR)

## **5.2 Diff-R Mismatch: Diffusion resistor R-I characteristics mismatch, Kelvin connecton (A.01.11)**

### [Description]

Measures the resistance vs input current characteristics of diffusion resistors, and plots the differences between the devices.

### [Device Under Test]

Resistor, 2 terminals, 2 ea.  
with substrate

### [Device Parameters]

Polarity: Ntype (SMUs force the specified value) or Ptype (SMUs force the negative specified value).  
L: Resistor length  
W: Resistor width  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration Time  
Port1: SMU connected to device A high terminal, primary sweep current output  
Port2: SMU connected to device B high terminal, synchronous sweep current output  
I1Start: Port1/Port2 sweep start current  
I1Stop: Port1/Port2 sweep stop current  
I1Step: Port1/Port2 sweep step current  
Port3: SMU connected to device A/B low terminal, constant voltage output  
Subs: SMU connected to Substrate, constant voltage output  
VM1: SMU connected to device A high terminal, constant current output  
VM2: SMU connected to device A low terminal, constant current output  
VM3: SMU connected to device B high terminal, constant current output  
VM4: SMU connected to device B low terminal, constant current output

### [Extended Test Parameters]

IM1: VM1 output current  
IM2: VM2 output current  
IM3: VM3 output current  
IM4: VM4 output current  
V3: Port3 output voltage  
Vsubs: Substrate voltage  
V1Limit: Port1 voltage compliance  
VM1Limit: VM1 voltage compliance  
I3Limit: Port3 current compliance  
IsubsLimit: Substrate current compliance  
HoldTime: Hold time  
DelayTime: Deley time

### [Measurement Parameters]

Device A input current Iport1  
Device B input current Iport2  
Device A terminal voltage Vvm1, Vvm2  
Device B terminal voltage Vvm3, Vvm4

### [User Function]

$\Delta V\_A = Vvm1 - Vvm2$

$\Delta V_B = V_{m3} - V_{m4}$   
 $R_A = \Delta V_A / I_{port1}$   
 $R_B = \Delta V_B / I_{port2}$   
 $R_{sheet\_A} = R_A / (W/L)$   
 $R_{sheet\_B} = R_B / (W/L)$   
 $\Delta R = (R_A - R_B) / R_A * 100$

[X-Y Plot]

X axis: Device input current  $I_{port1}$  (LINEAR)  
Y1 axis: Device A voltage between terminals  $\Delta V_A$  (LINEAR)  
Y2 axis: Device B voltage between terminals  $\Delta V_B$  (LINEAR)  
Y3 axis: Device A resistance  $R_A$  (LINEAR)  
Y4 axis: Device A resistance  $R_B$  (LINEAR)  
Y5 axis: Rate-of-change between  $R_A$  and  $R_B$   $\Delta R$  (LINEAR)

### **5.3 Diode IV Fwd Mismatch: Diode forward bias characteristics mismatch (A.01.20)**

[Description]

Measures the forward bias anode voltage vs anode current characteristics, and plots the differences between the devices.

[Device Under Test]

Diode, 2 ea.

[Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature

IMax: Current compliance

[Test Parameters]

IntegTime: Integration time

AnodeA: SMU connected to the device A Anode terminal, primary sweep voltage output

AnodeB: SMU connected to the device B Anode terminal, synchronous sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Cathode: SMU connected to Cathode terminal, constant voltage output

[Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

[Measurement Parameters]

Anode current I<sub>anodeA</sub>, I<sub>anodeB</sub>

[User Function]

$\Delta_{I_{anode}} = (I_{anodeA} - I_{anodeB}) / I_{anodeA} * 100$

[X-Y Plot]

X axis: Anode voltage VanodeA (LINEAR)

Y1 axis: Anode current I<sub>anodeA</sub> (LINEAR)

Y2 axis: Anode current I<sub>anodeB</sub> (LINEAR)

Y3 axis: Differences between anode current  $\Delta_{I_{anode}}$  (LINEAR)

## **5.4 Diode IV Rev Mismatch: Diode reverse bias characteristics mismatch (A.01.20)**

### [Description]

Measures the reverse bias anode voltage vs anode current characteristics, and plots the differences between the devices.

### [Device Under Test]

Diode, 2 ea.

### [Device Parameters]

L: Junction length  
W: Junction width  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration time  
AnodeA: SMU connected to the device A Anode terminal, primary sweep voltage output  
AnodeB: SMU connected to the device B Anode terminal, synchronous sweep voltage output  
VanodeStart: Sweep start voltage for Anode terminal  
VanodeStop: Sweep stop voltage for Anode terminal  
VanodeStep: Sweep step voltage for Anode terminal  
IanodeLimit: Anode current compliance  
Cathode: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

Vcathode: Cathode voltage  
HoldTime: Hold time  
DelayTime: Delay time  
AnodeMinRng: Minimum range for the anode current measurement

### [Measurement Parameters]

Anode current IanodeA, IanodeB

### [User Function]

$\Delta\_I_{anode} = (I_{anodeA} - I_{anodeB}) / I_{anodeA} * 100$

### [X-Y Plot]

X axis: Anode voltage VanodeA (LINEAR)  
Y1 axis: Anode current IanodeA (LINEAR)  
Y2 axis: Anode current IanodeB (LINEAR)  
Y3 axis: Differences between anode current  $\Delta\_I_{anode}$  (LINEAR)

## 5.5 *G-Plot ConstVce Mismatch: Gummel characteristics mismatch, Vce=Const (A.01.20)*

### [Description]

Measures the collector current vs base voltage characteristics and the base current vs base voltage characteristics, extracts the current amplification factor hfe, and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

BaseA: SMU connected to Device A Base terminal, primary sweep voltage output

BaseB: SMU connected to Device B Base terminal, synchronous sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

CollectorA: SMU connected to Device A Collector terminal, constant voltage output

CollectorB: SMU connected to Device B Collector terminal, constant voltage output

Vc: Collector voltage

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current IcollectorA

Collector current IcollectorB

Base current IbaseA

Base current IbaseB

### [User Function]

$hfe\_A = I_{collectorA} / I_{baseA}$

$hfe\_B = I_{collectorB} / I_{baseB}$

$\Delta\_hfe = (hfe\_A - hfe\_B) / hfe\_A * 100$

$\Delta\_I_{collector} = (I_{collectorA} - I_{collectorB}) / I_{collectorA} * 100$

$V_{be} = V_{baseA}$

### [X-Y Plot]

X axis: Base-Emitter voltage  $V_{be}$  (LINEAR)  
Y1 axis: Collector current  $I_{collectorA}$  (LOG)  
Y2 axis: Base current  $I_{baseA}$  (LOG)  
Y3 axis: Collector current  $I_{collectorB}$  (LOG)  
Y4 axis: Base current  $I_{baseB}$  (LOG)  
Y5 axis: Current amplification factor  $h_{fe\_A}$  (LINEAR)  
Y6 axis: Current amplification factor  $h_{fe\_B}$  (LINEAR)  
Y7 axis: Differences of  $h_{fe}$   $\Delta_{h_{fe}}$  (LINEAR)

## 5.6 *G-Plot ConstVce Mismatch[3]: Gummel characteristics mismatch, Vce=Const, 3-terminal (A.01.20)*

### [Description]

Measures the collector current vs base voltage characteristics and the base current vs base voltage characteristics, extracts the current amplification factor hfe, and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 3 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

BaseA: SMU connected to Device A Base terminal, primary sweep voltage output

BaseB: SMU connected to Device B Base terminal, synchronous sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

CollectorA: SMU connected to Device A Collector terminal, constant voltage output

CollectorB: SMU connected to Device B Collector terminal, constant voltage output

Vc: Collector voltage

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current IcollectorA

Collector current IcollectorB

Base current IbaseA

Base current IbaseB

### [User Function]

$hfe\_A = I_{collectorA} / I_{baseA}$

$hfe\_B = I_{collectorB} / I_{baseB}$

$\Delta\_hfe = (hfe\_A - hfe\_B) / hfe\_A * 100$

$\Delta\_I_{collector} = (I_{collectorA} - I_{collectorB}) / I_{collectorA} * 100$

$V_{be} = V_{baseA}$

### [X-Y Plot]

X axis: Base-Emitter voltage Vbe (LINEAR)

Y1 axis: Collector current IcollectorA (LOG)

Y2 axis: Base current IbaseA (LOG)



Y3 axis: Collector current  $I_{\text{collectorB}}$  (LOG)  
Y4 axis: Base current  $I_{\text{baseB}}$  (LOG)  
Y5 axis: Current amplification factor  $h_{fe\_A}$  (LINEAR)  
Y6 axis: Current amplification factor  $h_{fe\_B}$  (LINEAR)  
Y7 axis: Differences of  $h_{fe}$   $\Delta_{hfe}$  (LINEAR)

## 5.7 *G-Plot Vbc=0V Mismatch: Gummel characteristics mismatch, Vbc=0 V (A.01.20)*

### [Description]

Measures the collector current vs emitter voltage characteristics and the base current vs emitter voltage characteristics, extracts the current amplification factor hfe, and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 4 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

BaseA: SMU connected to Device A Base terminal, constant voltage output

BaseB: SMU connected to Device B Base terminal, constant voltage output

CollectorA: SMU connected to Device A Collector terminal, constant voltage output

CollectorB: SMU connected to Device B Collector terminal, constant voltage output

Vc: Collector voltage

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Vb: Base voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current IcollectorA

Collector current IcollectorB

Base current IbaseA

Base current IbaseB

### [User Function]

$hfe\_A = I_{collectorA} / I_{baseA}$

$hfe\_B = I_{collectorB} / I_{baseB}$

$\Delta\_hfe = (hfe\_A - hfe\_B) / hfe\_A * 100$

$\Delta\_I_{collector} = (I_{collectorA} - I_{collectorB}) / I_{collectorA} * 100$

$Vbe = -V_{emitter}$

### [X-Y Plot]

X axis: Base-Emitter voltage  $V_{be}$  (LINEAR)  
Y1 axis: Collector current  $I_{collectorA}$  (LOG)  
Y2 axis: Base current  $I_{baseA}$  (LOG)  
Y3 axis: Collector current  $I_{collectorB}$  (LOG)  
Y4 axis: Base current  $I_{baseB}$  (LOG)  
Y5 axis: Current amplification factor  $h_{fe\_A}$  (LINEAR)  
Y6 axis: Current amplification factor  $h_{fe\_B}$  (LINEAR)  
Y7 axis: Differences of  $h_{fe}$   $\Delta_{hfe}$  (LINEAR)

## 5.8 G-Plot $V_{bc}=0V$ Mismatch[3]: Gummel characteristics mismatch, $V_{bc}=0$ , 3-terminal (A.01.20)

### [Description]

Measures the collector current vs emitter voltage characteristics and the base current vs emitter voltage characteristics, extracts the current amplification factor  $h_{fe}$ , and plots the gummel characteristics.

### [Device Under Test]

Bipolar transistor, 3 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

VeStart: Sweep start voltage for Emitter terminal

VeStop: Sweep stop voltage for Emitter terminal

VeStep: Sweep step voltage for Emitter terminal

BaseA: SMU connected to Device A Base terminal, constant voltage output

BaseB: SMU connected to Device B Base terminal, constant voltage output

CollectorA: SMU connected to Device A Collector terminal, constant voltage output

CollectorB: SMU connected to Device B Collector terminal, constant voltage output

### [Extended Test Parameters]

Vb: Base voltage

Vc: Collector voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Measurement Parameters]

Collector current IcollectorA

Collector current IcollectorB

Base current IbaseA

Base current IbaseB

### [User Function]

$h_{fe\_A} = I_{collectorA} / I_{baseA}$

$h_{fe\_B} = I_{collectorB} / I_{baseB}$

$\Delta_{hf} = (h_{fe\_A} - h_{fe\_B}) / h_{fe\_A} * 100$

$\Delta_{I_{collector}} = (I_{collectorA} - I_{collectorB}) / I_{collectorA} * 100$

$V_{be} = -V_{emitter}$

### [X-Y Plot]

X axis: Base-Emitter voltage  $V_{be}$  (LINEAR)

Y1 axis: Collector current IcollectorA (LOG)

Y2 axis: Base current IbaseA (LOG)

Y3 axis: Collector current  $I_{\text{collectorB}}$  (LOG)  
Y4 axis: Base current  $I_{\text{baseB}}$  (LOG)  
Y5 axis: Current amplification factor  $h_{fe\_A}$  (LINEAR)  
Y6 axis: Current amplification factor  $h_{fe\_B}$  (LINEAR)  
Y7 axis: Differences of  $h_{fe}$   $\Delta_{h_{fe}}$  (LINEAR)

## 5.9 *Ic-Vc Ib Mismatch: Ic-Vce characteristics mismatch, Ib sweep (A.01.20)*

### [Description]

Measures the collector current vs collector voltage (Ic-Vce) characteristics of device A, and measures the Ic-Vce characteristics of device B. After that, calculates the differences between Ic values by using the following formula, and plots the results.

$$\text{Delta\_Ic} = (\text{Icollector\_A} - \text{Icollector\_B}) / \text{Icollector\_A} * 100$$

### [Device Under Test]

Bipolar transistor, 4 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

CollectorA: SMU connected to Device A Collector terminal, primary sweep voltage output

CollectorB: SMU connected to Device B Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

BaseA: SMU connected to Device A Base terminal, secondary sweep current output

BaseB: SMU connected to Device B Base terminal, secondary sweep current output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

VbLimit: Base voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

### [Device A: Measurement Parameters]

Collector current IcollectorA

### [Device A: User Function]

hfe\_A = IcollectorA / IbaseA

### [Device A: X-Y Plot]

X axis: Collector voltage VcollectorA (LINEAR)

Y1 axis: Collector current IcollectorA (LINEAR)

### [Device B: Measurement Parameters]

Collector current IcollectorB

[Device B: User Function]  
 $hfe\_B = I_{collectorB} / I_{baseB}$

[Device B: X-Y Plot]  
X axis: Collector voltage  $V_{collectorB}$  (LINEAR)  
Y1 axis: Collector current  $I_{collectorB}$  (LINEAR)

[Test Output: X-Y Graph]  
X axis: Collector-Emitter voltage  $V_{ce}$  (LINEAR)  
Y1 axis: Collector current  $I_{collector\_A}$  (LINEAR)  
Y2 axis: Collector current  $I_{collector\_B}$  (LINEAR)  
Y3 axis: Differences between  $I_c$   $\Delta I_c$  (LINEAR)

### **5.10 Ic-Vc Ib Mismatch[3]: Ic-Vce characteristics mismatch, Ib sweep, 3-terminal (A.01.20)**

[Description]

Measures the collector current vs collector voltage (Ic-Vce) characteristics of device A, and measures the Ic-Vce characteristics of device B. After that, calculates the differences between Ic values by using the following formula, and plots the results.

$$\text{Delta\_Ic} = (\text{Icollector\_A} - \text{Icollector\_B}) / \text{Icollector\_A} * 100$$

[Device Under Test]

Bipolar transistor, 3 terminals, 2 ea.

[Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

[Test Parameters]

IntegTime: Integration time

CollectorA: SMU connected to Device A Collector terminal, primary sweep voltage output

CollectorB: SMU connected to Device B Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

BaseA: SMU connected to Device A Base terminal, secondary sweep current output

BaseB: SMU connected to Device B Base terminal, secondary sweep current output

IbStart: Sweep start current for Base terminal

IbStop: Sweep stop current for Base terminal

IbStep: Sweep step current for Base terminal

VbLimit: Base voltage compliance

Emitter: SMU connected to Emitter terminal, constant voltage output

[Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

CollectorMinRng: Minimum range for the collector current measurement

[Device A: Measurement Parameters]

Collector current IcollectorA

[Device A: User Function]

hfe\_A = IcollectorA / IbaseA

[Device A: X-Y Plot]

X axis: Collector voltage VcollectorA (LINEAR)

Y1 axis: Collector current IcollectorA (LINEAR)

[Device B: Measurement Parameters]

Collector current IcollectorB



[Device B: User Function]  
 $h_{fe\_B} = I_{collectorB} / I_{baseB}$

[Device B: X-Y Plot]  
X axis: Collector voltage  $V_{collectorB}$  (LINEAR)  
Y1 axis: Collector current  $I_{collectorB}$  (LINEAR)

[Test Output: X-Y Graph]  
X axis: Collector-Emitter voltage  $V_{ce}$  (LINEAR)  
Y1 axis: Collector current  $I_{collector\_A}$  (LINEAR)  
Y2 axis: Collector current  $I_{collector\_B}$  (LINEAR)  
Y3 axis: Differences between  $I_c$   $\Delta I_c$  (LINEAR)

## 5.11 Ic-Vc Vb Mismatch: Ic-Vce characteristics mismatch, Vb sweep (A.01.20)

### [Description]

Measures the collector current vs collector voltage (Ic-Vce) characteristics of device A, and measures the Ic-Vce characteristics of device B. After that, calculates the differences between Ic values by using the following formula, and plots the results.

$$\Delta I_c = (I_{c\_A} - I_{c\_B}) / I_{c\_A} * 100$$

### [Device Under Test]

Bipolar transistor, 4 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

CollectorA: SMU connected to Device A Collector terminal, primary sweep voltage output

CollectorB: SMU connected to Device B Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

BaseA: SMU connected to Device A Base terminal, secondary sweep voltage output

BaseB: SMU connected to Device B Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Device A: Measurement Parameters]

Collector current IcollectorA

Base current IbaseA

### [Device A: User Function]

hfe\_A = IcollectorA / IbaseA

### [Device A: X-Y Plot]

X axis: Collector voltage VcollectorA (LINEAR)

Y1 axis: Collector current IcollectorA (LINEAR)

### [Device B: Measurement Parameters]

Collector current  $I_{\text{collectorB}}$   
Base current  $I_{\text{baseB}}$

[Device B: User Function]  
 $h_{fe\_B} = I_{\text{collectorB}} / I_{\text{baseB}}$

[Device B: X-Y Plot]  
X axis: Collector voltage  $V_{\text{collectorB}}$  (LINEAR)  
Y1 axis: Collector current  $I_{\text{collectorB}}$  (LINEAR)

[Test Output: X-Y Graph]  
X axis: Collector-Emitter voltage  $V_{ce}$  (LINEAR)  
Y1 axis: Collector current  $I_{\text{collector\_A}}$  (LINEAR)  
Y2 axis: Collector current  $I_{\text{collector\_B}}$  (LINEAR)  
Y3 axis: Differences between  $I_c$   $\Delta I_c$  (LINEAR)

## **5.12 Ic-Vc Vb Mismatch[3]: Ic-Vce characteristics mismatch, Vb sweep, 3-terminal (A.01.20)**

### [Description]

Measures the collector current vs collector voltage (Ic-Vce) characteristics of device A, and measures the Ic-Vce characteristics of device B. After that, calculates the differences between Ic values by using the following formula, and plots the results.

$$\Delta I_c = (I_{c\_A} - I_{c\_B}) / I_{c\_A} * 100$$

### [Device Under Test]

Bipolar transistor, 3 terminals, 2 ea.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value).

Le: Emitter length

We: Emitter width

Temp: Temperature

IcMax: Collector current compliance

### [Test Parameters]

IntegTime: Integration time

CollectorA: SMU connected to Device A Collector terminal, primary sweep voltage output

CollectorB: SMU connected to Device B Collector terminal, primary sweep voltage output

VcStart: Sweep start voltage for Collector terminal

VcStop: Sweep stop voltage for Collector terminal

VcStep: Sweep step voltage for Collector terminal

BaseA: SMU connected to Device A Base terminal, secondary sweep voltage output

BaseB: SMU connected to Device B Base terminal, secondary sweep voltage output

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Emitter: SMU connected to Emitter terminal, constant voltage output

### [Extended Test Parameters]

Ve: Emitter voltage

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for the base current measurement

CollectorMinRng: Minimum range for the collector current measurement

### [Device A: Measurement Parameters]

Collector current IcollectorA

Base current IbaseA

### [Device A: User Function]

$$hfe\_A = I_{c\_A} / I_{b\_A}$$

### [Device A: X-Y Plot]

X axis: Collector voltage VcollectorA (LINEAR)

Y1 axis: Collector current IcollectorA (LINEAR)

### [Device B: Measurement Parameters]

Collector current IcollectorB

Base current  $I_{baseB}$

[Device B: User Function]  
 $hfe\_B = I_{collectorB} / I_{baseB}$

[Device B: X-Y Plot]  
X axis: Collector voltage  $V_{collectorB}$  (LINEAR)  
Y1 axis: Collector current  $I_{collectorB}$  (LINEAR)

[Test Output: X-Y Graph]  
X axis: Collector-Emitter voltage  $V_{ce}$  (LINEAR)  
Y1 axis: Collector current  $I_{collector\_A}$  (LINEAR)  
Y2 axis: Collector current  $I_{collector\_B}$  (LINEAR)  
Y3 axis: Differences between  $I_c$   $\Delta I_c$  (LINEAR)

### 5.13 Id-Vd Mismatch: Id-Vd characteristics mismatch (A.01.20)

[Description]

Measures the drain current vs drain voltage characteristics of two MOSFETs, and plots the differences of them.

[Device Under Test]

MOSFET, 4 terminals, 2 ea.

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

DrainA: SMU connected to the device A Drain terminal, primary sweep voltage output

DrainB: SMU connected to the device B Drain terminal, synchronous sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

Source: SMU connected to Source terminal, constant voltage output

[Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

SubsMinRng: Minimum range for the substrate current measurement

[Measurement Parameters]

Device A Drain current IdrainA

Device B Drain current IdrainB

Substrate current Isubs

Source current Isource

[User Function]

Drain conductance  $gds\_A = \text{diff}(\text{IdrainA}, \text{VdrainA})$

Drain conductance  $gds\_B = \text{diff}(\text{IdrainB}, \text{VdrainB})$

Drain resistance  $Rds\_A = 1/gds\_A$

Drain resistance  $Rds\_B = 1/gds\_B$

$\Delta\_Ids = (\text{IdrainA} - \text{IdrainB}) / \text{IdrainA} * 100$

$\Delta\_gds = (gds\_A - gds\_B) / gds\_A * 100$

$\Delta\_Rds = (Rds\_A - Rds\_B) / Rds\_A * 100$

[X-Y Graph]

X axis: Drain voltage VdrainA (LINEAR)

Y1 axis: Device A Drain current IdrainA (LINEAR)

Y2 axis: Device B Drain current IdrainB (LINEAR)

Y3 axis: Difference of Drain current Delta\_Ids (LINEAR)

[List Display]

Drain voltage VdrainA

Gate voltage Vgate

Device A Drain current IdrainA

Device B Drain current IdrainB

Differences of Drain current Delta\_Ids

Substrate current Isubs

Source current Isource

### **5.14 Id-Vd Mismatch[3]: Id-Vd characteristics mismatch, 3-terminal (A.01.20)**

#### [Description]

Measures the drain current vs drain voltage characteristics of two MOSFETs, and plots the differences of them.

#### [Device Under Test]

MOSFET, 3 terminals, 2 ea.

#### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

#### [Test Parameters]

IntegTime: Integration time

DrainA: SMU connected to the device A Drain terminal, primary sweep voltage output

DrainB: SMU connected to the device B Drain terminal, synchronous sweep voltage output

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Source: SMU connected to Source terminal, constant voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

#### [Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

#### [Measurement Parameters]

Device A Drain current IdrainA

Device B Drain current IdrainB

#### [User Function]

Drain conductance  $gds\_A = \text{diff}(\text{IdrainA}, \text{VdrainA})$

Drain conductance  $gds\_B = \text{diff}(\text{IdrainB}, \text{VdrainB})$

Drain resistance  $Rds\_A = 1/gds\_A$

Drain resistance  $Rds\_B = 1/gds\_B$

$\Delta\_Ids = (\text{IdrainA} - \text{IdrainB}) / \text{IdrainA} * 100$

$\Delta\_gds = (gds\_A - gds\_B) / gds\_A * 100$

$\Delta\_Rds = (Rds\_A - Rds\_B) / Rds\_A * 100$

#### [X-Y Graph]

X axis: Drain voltage VdrainA (LINEAR)

Y1 axis: Device A Drain current IdrainA (LINEAR)

Y2 axis: Device B Drain current IdrainB (LINEAR)

Y3 axis: Difference of Drain current  $\Delta\_Ids$  (LINEAR)



[List Display]

Drain voltage  $V_{\text{drainA}}$

Gate voltage  $V_{\text{gate}}$

Device A Drain current  $I_{\text{drainA}}$

Device B Drain current  $I_{\text{drainB}}$

Differences of Drain current  $\Delta I_{\text{ds}}$

### 5.15 Id-Vg Mismatch: Id-Vg characteristics mismatch (A.01.20)

[Description]

Measures the drain current vs gate voltage characteristics of two MOSFETs, and plots the differences of them.

[Device Under Test]

MOSFET, 4 terminals, 2 ea.

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

DrainA: SMU connected to the device A Drain terminal, constant voltage output

DrainB: SMU connected to the device B Drain terminal, constant voltage output

Vd: Drain voltage

Subs: SMU connected to Substrate, secondary sweep voltage output

VsubsStart: Sweep start voltage for Substrate terminal

VsubsStop: Sweep stop voltage for Substrate terminal

VsubsStep: Sweep step voltage for Substrate terminal

IsubsLimit: Substrate current compliance

Source: SMU connected to Source terminal, constant voltage output

[Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the Substrate current measurement

[Measurement Parameters]

Device A Drain current IdrainA

Device B Drain current IdrainB

Gate current Igate

Substrate current Isubs

[User Function]

$gm\_A = \text{diff}(\text{IdrainA}, V_{\text{gate}})$

$gm\_B = \text{diff}(\text{IdrainB}, V_{\text{gate}})$

$\Delta\_Id = (\text{IdrainA} - \text{IdrainB}) / \text{IdrainA} * 100$

$\Delta\_gm = (gm\_A - gm\_B) / gm\_A * 100$

[X-Y Graph]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Device A Drain current  $I_{\text{drainA}}$  (LINEAR)  
Y2 axis: Device B Drain current  $I_{\text{drainB}}$  (LINEAR)  
Y3 axis: Difference of Drain current  $\Delta_{\text{Id}}$  (LINEAR)

[List Display]

Gate voltage  $V_{\text{gate}}$   
Drain voltage  $V_{\text{drainA}}$   
Device A Drain current  $I_{\text{drainA}}$   
Device B Drain current  $I_{\text{drainB}}$   
Differences of Drain current  $\Delta_{\text{Id}}$   
Gate current  $I_{\text{gate}}$   
Substrate current  $I_{\text{subs}}$

### **5.16 Id-Vd Mismatch[3]: Id-Vd characteristics mismatch, 3-terminal (A.01.20)**

[Description]

Measures the drain current vs drain voltage characteristics of two MOSFETs, and plots the differences of them.

[Device Under Test]

MOSFET, 3 terminals, 2 ea.

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

DrainA: SMU connected to the device A Drain terminal, primary sweep voltage output

DrainB: SMU connected to the device B Drain terminal, synchronous sweep voltage output

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Source: SMU connected to Source terminal, constant voltage output

Vd: Drain voltage

[Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

[Measurement Parameters]

Device A Drain current IdrainA

Device B Drain current IdrainB

[User Function]

Drain conductance  $gds\_A = \text{diff}(\text{IdrainA}, \text{VdrainA})$

Drain conductance  $gds\_B = \text{diff}(\text{IdrainB}, \text{VdrainB})$

Drain resistance  $Rds\_A = 1/gds\_A$

Drain resistance  $Rds\_B = 1/gds\_B$

$\Delta\_Ids = (\text{IdrainA} - \text{IdrainB}) / \text{IdrainA} * 100$

$\Delta\_gds = (gds\_A - gds\_B) / gds\_A * 100$

$\Delta\_Rds = (Rds\_A - Rds\_B) / Rds\_A * 100$

[X-Y Graph]

X axis: Drain voltage VdrainA (LINEAR)

Y1 axis: Device A Drain current IdrainA (LINEAR)

Y2 axis: Device B Drain current IdrainB (LINEAR)

Y3 axis: Difference of Drain current  $\Delta\_Ids$  (LINEAR)

[List Display]

Drain voltage VdrainA

Gate voltage  $V_{gate}$   
Device A Drain current  $I_{drainA}$   
Device B Drain current  $I_{drainB}$   
Differences of Drain current  $\Delta I_{ds}$

## 5.17 MIM CV Mismatch: MIM capacitor C-V characteristics mismatch (A.01.11)

### [Description]

Measures the MIM capacitance (C-V characteristics) of device A, and measures the C-V characteristics of device B. After that, calculates the differences between capacitance values by using the following formula, and plots the results.

$\Delta C_p = (C_{pBList} - C_{pAList}) / C_{pAList} * 100$  for parallel capacitance

$\Delta C_s = (C_{sBList} - C_{sAList}) / C_{sAList} * 100$  for series capacitance

### [Device Under Test]

MIM capacitor, 2 terminals, 2 ea.

### [Device Parameters]

Lg: Device length

Wg: Device width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Port1: CMU connected to the device (CV sweep measurement)

V1Start: DC bias start voltage

V1Stop: DC bias stop voltage

V1Step: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

To specify the device, A or B is added to the actual variable names.

$PI = 3.141592653589$

$Dval = Gval / (2 * PI * FREQ * Cpval)$

$Rpval = 1 / Gval$

$Csval = (1 + Dval^2) * Cpval$

$Xval = -1 / (2 * PI * FREQ * Csval)$

$Rsvall = Dval * abs(Xval)$

$Zval = \sqrt{Rsvall^2 + Xval^2}$

$Thetaval = \text{atan}(Xval / Rsvall)$

### [X-Y Graph]

To specify the device, A or B is added to the actual variable names.

X axis: DC bias Vport1 (LINEAR)

Y1 axis: MIM capacitance (parallel capacitance) Cpval (LINEAR)

Y2 axis: Conductance Gval (LINEAR)

### [List Display]

To specify the device, A or B is added to the actual variable names.

DC bias Vport1

Parallel capacitance  $C_{pval}$   
Conductance  $G_{val}$   
Series capacitance  $C_{sval}$   
Series resistance  $R_{sval}$   
Parallel resistance  $R_{pval}$   
Dissipation factor  $D_{val}$   
Reactance  $X_{val}$   
Impedance  $Z_{val}$   
Phase  $\Theta_{val}$

[Test Output: X-Y Graph]

X axis: DC bias  $V_{port1List}$  (LINEAR)

Y1 axis: MIM capacitance (parallel capacitance)  $C_{pAList}$  (LINEAR)

Y2 axis: MIM capacitance (parallel capacitance)  $C_{pBList}$  (LINEAR)

Y3 axis: Differences between  $C_p$   $\Delta C_p$  (LINEAR)

## 5.18 MOS Varactor CV Mismatch: MOS Varactor capacitance CV characteristics mismatch (A.01.11)

### [Description]

Measures the MOS varactor capacitance (C-Vg characteristics) of device A, and measures the C-Vg characteristics of device B. After that, calculates the differences between capacitance values by using the following formula, and plots the results.

$\Delta C_p = (C_{pBList} - C_{pAList}) / C_{pAList} * 100$  for parallel capacitance

$\Delta C_s = (C_{sBList} - C_{sAList}) / C_{sAList} * 100$  for series capacitance

### [Device Under Test]

MOSFET, 4 terminals, 2 ea.

Connect Gate to the CMU Low, and the other terminals to the CMU High.

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Gate: CMU connected to Gate terminal (CV sweep measurement)

VgsStart: DC bias start voltage

VgsStop: DC bias stop voltage

VgsStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

To specify the device, A or B is added to the actual variable names.

$PI = 3.141592653589$

$Dval = Gval / (2 * PI * FREQ * Cpval)$

$Rpval = 1 / Gval$

$Csval = (1 + Dval^2) * Cpval$

$Xval = -1 / (2 * PI * FREQ * Csval)$

$Rsvl = Dval * abs(Xval)$

$Zval = \sqrt{Rsvl^2 + Xval^2}$

$Thetaval = atan(Xval / Rsvl)$

$Vgateval = -Vsubs$

### [X-Y Graph]

To specify the device, A or B is added to the actual variable names.

X axis: Gate voltage Vgateval (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cpval (LINEAR)



Y2 axis: Conductance Gval (LINEAR)

[List Display]

To specify the device, A or B is added to the actual variable names.

Gate voltage Vgateval

Parallel capacitance Cpval

Conductance Gval

Series capacitance Csvall

Series resistance Rsvall

Parallel resistance Rpval

Dissipation factor Dval

Reactance Xval

Impedance Zval

Phase Thetaval

[Test Output: X-Y Graph]

X axis: Gate voltage VgList (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) CpAList (LINEAR)

Y2 axis: Gate capacitance (parallel capacitance) CpBList (LINEAR)

Y3 axis: Differences between Cp DeltaCp (LINEAR)

## **5.19 Poly-R Mismatch: Resistor R-I characteristics mismatch, Kelvin connection (A.01.11)**

### [Description]

Measures the resistance vs input current characteristics of resistors, and plots the differences between the devices.

### [Device Under Test]

Resistor, 2 terminals, 2 ea.

### [Device Parameters]

L: Resistor length  
W: Resistor width  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration Time  
Port1: SMU connected to device A high terminal, primary sweep current output  
Port2: SMU connected to device B high terminal, synchronous sweep current output  
I1Start: Port1/Port2 sweep start current  
I1Stop: Port1/Port2 sweep stop current  
I1Step: Port1/Port2 sweep step current  
V1Limit: Maximum voltage  
Port3: SMU connected to device A/B low terminal, constant voltage output  
VM1: SMU connected to device A high terminal, constant current output  
VM2: SMU connected to device A low terminal, constant current output  
VM3: SMU connected to device B high terminal, constant current output  
VM4: SMU connected to device B low terminal, constant current output

### [Extended Test Parameters]

V3: Port3 output voltage  
IM1: VM1 output current  
IM2: VM2 output current  
IM3: VM3 output current  
IM4: VM4 output current  
HoldTime: Hold time  
DelayTime: Deley time

### [Measurement Parameters]

Device A input current Iport1  
Device B input current Iport2  
Device A terminal voltage Vvm1, Vvm2  
Device B terminal voltage Vvm3, Vvm4

### [User Function]

$\Delta V_A = V_{vm1} - V_{vm2}$   
 $\Delta V_B = V_{vm3} - V_{vm4}$   
 $R_A = \Delta V_A / I_{port1}$   
 $R_B = \Delta V_B / I_{port2}$   
 $R_{sheet\_A} = R_A / (W/L)$   
 $R_{sheet\_B} = R_B / (W/L)$   
 $\Delta R = (R_A - R_B) / R_A * 100$

[X-Y Plot]

X axis: Device A input current Iport1 (LINEAR)

Y1 axis: Device A resistance R\_A (LINEAR)

Y2 axis: Device B resistance R\_B (LINEAR)

Y3 axis: Rate-of-change between R\_A and R\_B Delta\_R (LINEAR)

Y4 axis: Device A voltage between terminals DeltaV\_A (LINEAR)

Y5 axis: Device B voltage between terminals DeltaV\_B (LINEAR)



## 6 NanoTech

1. CNT Differential R[AC]: CNT Differential R-V characteristics (A.01.20)
2. CNT Gate Leak: CNT FET Ig-Vg characteristics (A.01.20)
3. CNT Id-Time: CNT FET Id-Time Characteristic (A.01.20)
4. CNT Id-Vd: CNT FET Id-Vd characteristics (A.01.20)
5. CNT Id-Vg: Carbon Nano Tube FET Id-Vg characteristics (A.01.20)
6. CNT Id-Vg-Time: CNT FET Ig-Vg characteristics (A.01.20)
7. CNT IV Sweep: CNT Differential I-V characteristics (A.01.20)
8. CNT R-I Kelvin 2SMU: CNT R-I characteristics, Kelvin connection (A.01.20)
9. CNT R-V Kelvin 2SMU: CNT R-V characteristics, Kelvin connection (A.01.20)
10. CNT Vth gmMax: CNT FET linear region Vth (A.01.20)

## **6.1 CNT Differential R[AC]: CNT Differential R-V characteristics (A.01.20)**

### [Description]

Measures the conductance of a CNT 2-terminal device and plots differential R-V (resistance vs voltage) characteristics. This test is designed to calculate resistance as the inverse of conductance. Additionally, the level of a measurement signal is specified by a peak-to-peak value (normally effective value).

### [Device Under Test]

Carbon Nano Tube FET, 2 terminals

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: CMU connected to device under test, CV sweep measurement

V1Start: Sweep output start voltage

V1Stop: Sweep output stop voltage

V1Step: Sweep output step voltage

FREQ: Measurement frequency

Meas\_Vpp: Measurement signal level, Peak to Peak value of oscillation

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

AxisY\_RMin: Minimum Y axis (resistance) value

AxisY\_RMax: Maximum Y axis (resistance) value

### [Measurement Parameters]

Conductance G

### [User Function]

Differential resistance  $R=1/G$

### [X-Y Plot]

X axis: Port1 input voltage Vport1 (LINEAR)

Y1 axis: Differential resistance R (LINEAR)

### [List Display]

Port1 input voltage Vport1

Differential resistance R

Conductance G

## 6.2 CNT Gate Leak: CNT FET $I_g$ - $V_g$ characteristics (A.01.20)

### [Description]

Measures the gate current vs gate voltage ( $I_g$ - $V_g$ ) characteristics of CNT FET.

Measures  $I_g$  before and after applying  $V_g$  by using the primary sweep SMU that forces the start and stop voltages only, and extracts the  $I_g$ - $V_g$  characteristics by altering the stop value repeatedly.

### [Device Under Test]

Carbon Nano Tube FET capacitor, 2 terminals

Connect SMU to the back gate and side gate and make the source and drain open.

### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value)

L: CNT length

D: CNT diameter

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

BackGate: SMU connected to Back Gate terminal, primary sweep voltage output

SideGate: SMU connected to Side Gate terminal, constant voltage output

VbgStart: Pulse peak start (sweep start) voltage for Back Gate terminal

VbgStop: Pulse peak stop (sweep stop) voltage for Back Gate terminal

VbgStep: Pulse peak step (sweep step) voltage for Back Gate terminal

VbgLow: Pulse base voltage (primary sweep start voltage)

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

Vsg: Side Gate terminal voltage

IbgLimit: Back Gate current compliance

BackGateMinRng: Minimum range for Back Gate current measurement

SideGateMinRng: Minimum range for Side Gate current measurement

### [Measurement Parameters]

Ibackgate: Back Gate current

### [X-Y Plot]

X axis: Back Gate voltage Vbackgate (LINEAR)

Y1 axis: Back Gate current Ibackgate (LOG)

### [List Display]

Vbackgate: Back Gate voltage

Ibackgate: Back Gate current

### [Test Output: X-Y Graph]

X axis: Back Gate voltage Vbackgate (LINEAR)

Y1 axis: Back Gate current Ibackgate (LOG)

Y2 axis: Back Gate current with pulse base voltage applied Ibackgate@LowVbg (LOG)

### [Test Output: List Display]

V\_backgate: Back Gate voltage

I\_backgate: Back Gate current

I\_backgate@LowVbg: Back Gate current with pulse base voltage applied

[Test Output: Parameters]

V\_backgate: Back Gate voltage

I\_backgate: Back Gate current

I\_backgate@LowVbg: Back Gate current with pulse base voltage applied



### 6.3 CNT Id-Time: CNT FET Id-Time Characteristic (A.01.20)

#### [Description]

This Algorithm evaluates the drain current with drain voltage for the gate condition change which is used as the DNA or the antibody sensor.

The IV curves between drain and source is measured with the gate condition change which indicate amount of the DNA or the antibody on the gate surface as a sensor.

The Algorithm is applied the time dependent measurement.

#### [Device Under Test]

CNT FET, 4 terminals

#### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value).

L: CNT length

D: CNT diameter

Temp: Temperature

IdMax: Drain current compliance

#### [Test Parameters]

BackGate: SMU connected to Backgate terminal, secondary sweep voltage output

Source: SMU connected to Source terminal, constant voltage output

Drain: SMU connected to Drain terminal, primary sweep voltage output

SideGate: SMU connected to Sidegate, constant voltage output

VbgStart: Sweep start voltage for Backgate terminal

VbgStop: Sweep stop voltage for Backgate terminal

VbgStep: Sweep step voltage for Backgate terminal

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Vsg: Sidegate voltage

IntegTime: Integration time

T1Stop: T1 stop time

T1Step: T1 step time

T2Stop: T2 stop time

T2Step: T2 step time

#### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Backgate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

#### [Measurement Parameters]

Drain current Idrain

Time ACC\_TIME

ACC\_TIME shows total time of T1Step or T2Step and measured time.

$ACC\_TIME = ACC\_TIME + T1Step \text{ or } T2Step + \text{Measured time of Id-Vd}$

#### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

## 6.4 CNT Id-Vd: CNT FET Id-Vd characteristics (A.01.20)

### [Description]

Measures the drain current vs drain voltage characteristics of Carbon Nano Tube FET.

### [Device Under Test]

Carbon Nano Tube FET, 4 terminals

### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value).

L: CNT length

D: CNT diameter

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain, primary sweep voltage output

VdStart: Sweep start voltage for Drain

VdStop: Sweep stop voltage for Drain

VdStep: Sweep step voltage for Drain

BackGate: SMU connected to Backgate, secondary sweep voltage output

VbgStart: Sweep start voltage for Backgate

VbgStop: Sweep stop voltage for Backgate

VbgStep: Sweep step voltage for Backgate

IgLimit: Backgate current compliance

SideGate: SMU connected to Sidegate, constant voltage output

Source: SMU connected to Source, constant voltage output

### [Extended Test Parameters]

Vsg: Sidegate voltage

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

## 6.5 CNT Id-Vg: Carbon Nano Tube FET Id-Vg characteristics (A.01.20)

### [Description]

Measures the drain current vs gate voltage characteristics of Carbon Nano Tube FET.

### [Device Under Test]

Carbon Nano Tube FET, 4 terminals

### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value).

L: CNT length

D: CNT diameter

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

BackGate: SMU connected to Backgate, primary sweep voltage output

VbgStart: Sweep start voltage for Backgate

VbgStop: Sweep stop voltage for Backgate

VbgStep: Sweep step voltage for Backgate

IgLimit: Backgate current compliance

Drain: SMU connected to Drain, secondary sweep voltage output

VdStart: Sweep start voltage for Drain

VdStop: Sweep stop voltage for Drain

VdStep: Sweep step voltage for Drain

SideGate: SMU connected to Sidegate, constant voltage output

Source: SMU connected to Source, constant voltage output

### [Extended Test Parameters]

Vsg: Sidegate voltage

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [X-Y Plot]

X axis: Backgate voltage Vbackgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

## 6.6 CNT Id-Vg-Time: CNT FET Ig-Vg characteristics (A.01.20)

### [Description]

Measures the Id-Vg characteristics of CNT FET repeatedly at a specified interval until specified time elapses. This test is designed to use a gate electrode as a sensor and consider the adsorption of DNA and antibody to the gate electrode as a change in Ids. Used for evaluation of a time change in characteristics.

### [Device Under Test]

Carbon Nano Tube FET, 4 terminals

### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value)

L: CNT length

D: CNT diameter

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain, primary sweep voltage output

VdStart: Sweep start voltage for Drain

VdStop: Sweep stop voltage for Drain

VdStep: Sweep step voltage for Drain

BackGate: SMU connected to Back Gate, secondary sweep voltage output

VbgStart: Sweep start voltage for Back Gate

VbgStop: Sweep stop voltage for Back Gate

VbgStep: Sweep step voltage for Back Gate

SideGate: SMU connected to Side Gate, constant voltage output

Vsg: Side Gate voltage

Source: SMU connected to Source, constant voltage output

T1Stop: T1 stop time

T1Step: T1 step time

T2Stop: T2 stop time

T2Step: T2 step time

### [Extended Test Parameters]

Vs: Source voltage

IbgLimit: Back Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

Time ACC\_TIME

ACC\_TIME is displayed after adding the sum of T1Step (or T2Step) and the actual measurement time.

$ACC\_TIME = ACC\_TIME + T1Step \text{ (or } T2Step) + Id\text{-}Vg \text{ measurement time}$

### [User Function]

ACC\_TIME: Elapsed time

MaxTS: Maximum time stamp value

### [X-Y Plot]

X axis: Back Gate voltage  $V_{backgate}$  (LINEAR)

Y1 axis: Drain current  $I_{drain}$  (LINEAR)

[List Display]

$V_{backgate}$ : Back Gate voltage

$I_{drain}$ : Drain current

$V_{sidegate}$ : Side Gate voltage

ACC\_TIME: Elapsed time

[Test Setup Details]

Refer to "CNT Id\_Vg."

## 6.7 CNT IV Sweep: CNT Differential I-V characteristics (A.01.20)

### [Description]

Measures the I-V (current vs voltage) characteristics of a CNT 2-terminal device.

This test definition allows one to select the direction of a sweep from "Single" and "Double." When the sweep start/stop value is not 0 V, outputs a sweep from 0 V to the start value or from the stop value to 0 V to protect a device.

### [Device Under Test]

Carbon Nano Tube FET, 2 terminals

### [Device Parameters]

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to device under test, primary sweep voltage output

Port2: SMU connected to device under test, constant voltage output

V1Start: Sweep output start voltage

V1Stop: Sweep output stop voltage

V1Step: Sweep output step voltage

IILimit: Port1 current compliance

SweepDirection: Sweep direction

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

V2: Port2 voltage

Y\_Min: Minimum Y axis value

Y\_Max: Maximum Y axis value

R\_Max: Maximum Y axis resistance value

Port1MinRng: Minimum range for Port1 current measurement

### [Measurement Parameters]

Iport1: Port1 current

### [User Function]

Resistor terminal voltage  $\Delta V = V_{port1} - V_{port2}$

Resistance  $R = \Delta V / I_{port1}$

### [X-Y Plot]

X axis: Voltage  $\Delta V$  (LINEAR)

Y1 axis: Measured current  $I_{port1}$  (LINEAR)

Y2 axis: Resistance  $R$  (LINEAR)

### [List Display]

$\Delta V$ : Voltage

$I_{port1}$ : Measured current

$R$ : Resistance value

## 6.8 CNT R-I Kelvin 2SMU: CNT R-I characteristics, Kelvin connection (A.01.20)

### [Description]

Measures the electric resistance of a CNT 2-terminal device and plots R-I (resistance vs current) characteristics. This test is designed to apply a current between terminals of devices, measure a voltage and calculate resistance. Kelvin connection is used for connecting SMU to a device.

### [Device Under Test]

Carbon Nano Tube FET, 2 terminals

### [Device Parameters]

L: CNT length  
D: CNT diameter  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration time  
Port1: SMU connected to resistor, primary sweep current output  
I1Start: Sweep output start current  
I1Stop: Sweep output stop current  
I1Step: Sweep output step current  
V1Limit: Port1 voltage compliance  
Port2: SMU connected to resistor, constant voltage output

### [Extended Test Parameters]

HoldTime: Hold time  
DelayTime: Delay time  
V2: Port2 voltage

### [Measurement Parameters]

Vport1: Port1 voltage

### [User Function]

Circular constant  $PI=3.141592653589$   
Resistor terminal voltage  $\Delta V=V_{port1}-V_{port2}$   
Resistance  $R=\Delta V/I_{port1}$   
Sheet resistance  $R_{sheet}=R*((PI*D)/L)$

### [X-Y Plot]

X axis: Current  $I_{port1}$  (LINEAR)  
Y1 axis: Resistance R (LINEAR)  
Y2 axis: Measured voltage  $\Delta V$  (LINEAR)

### [List Display]

$I_{port1}$ : Input current  
R: Resistance value  
 $\Delta V$ : Resistor terminal voltage  
 $R_{sheet}$ : Sheet resistance

## 6.9 CNT R-V Kelvin 2SMU: CNT R-V characteristics, Kelvin connection (A.01.20)

### [Description]

Measures the electric resistance of a CNT 2-terminal device and plots R-V (resistance vs voltage) characteristics. This test is designed to apply a voltage between terminals of devices, measure a current and calculate the resistance. Kelvin connection is used for connecting SMU to a device.

### [Device Under Test]

Carbon Nano Tube FET, 2 terminals

### [Device Parameters]

L: CNT length  
D: CNT diameter  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration time  
Port1: SMU connected to resistor, primary sweep voltage output  
V1Start: Sweep output start voltage  
V1Stop: Sweep output stop voltage  
V1Step: Sweep output step voltage  
I1Limit: Port1 current compliance  
Port2: SMU connected to resistor, constant voltage output  
V2: Port2 voltage

### [Extended Test Parameters]

HoldTime: Hold time  
DelayTime: Delay time  
Port1MinRng: Minimum range for Port1 current measurement

### [Measurement Parameters]

Iport1: Port1 current

### [User Function]

Circular constant  $PI=3.141592653589$   
Resistor terminal voltage  $\Delta V=V_{port1}-V_{port2}$   
Resistance  $R=\Delta V/I_{port1}$   
Sheet resistance  $R_{sheet}=R*((PI*D)/L)$

### [X-Y Plot]

X axis: Voltage  $\Delta V$  (LINEAR)  
Y1 axis: Measured current  $I_{port1}$  (LINEAR)  
Y2 axis: Resistance  $R$  (LINEAR)

### [List Display]

$\Delta V$ : Input voltage  
 $I_{port1}$ : Measured current  
R: Resistance value  
 $R_{sheet}$ : Sheet resistance



## 6.10 CNT Vth gmMax: CNT FET linear region Vth (A.01.20)

### [Description]

Extracts the threshold voltage (Vth) from linear region data by using the extrapolation method for the measurement of CNT FET Id-Vg characteristics.

### [Device Under Test]

Carbon Nano Tube FET, 4 terminals

### [Device Parameters]

Polarity: Forward (SMUs force the specified value) or Reverse (SMUs force the negative specified value)

L: CNT length

D: CNT diameter

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

BackGate: SMU connected to Back Gate, primary sweep voltage output

VbgStart: Sweep start voltage for Back Gate

VbgStop: Sweep stop voltage for Back Gate

VbgStep: Sweep step voltage for Back Gate

Drain: SMU connected to Drain, constant voltage output

Vd: Drain voltage, ideally at around 100mV

SideGate: SMU connected to Side Gate, constant voltage output

Source: SMU connected to Source, constant voltage output

### [Extended Test Parameters]

Vsg: Side Gate voltage

Vs: Source voltage

IbgLimit: Back Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

gm\_Min: Minimum transconductance value for Y axis

gm\_Max: Maximum transconductance value for Y axis

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

gm=diff(Idrain,Vbackgate)

### [Analysis Function]

gmMax=max(gm)

Von=@L1X (X intercept of Line1)

Vth=Von-Vd/2

Vth is given by the following formula.

$V_{th} = V_g(gm_{Max}) - I_d(gm_{Max}) / gm_{Max}$

Vd/2 is for compensation of the secondary term of Vd in the theoretical formula.

### [Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

[X-Y Plot]

X axis: Back Gate voltage  $V_{backgate}$  (LINEAR)

Y1 axis: Drain current  $I_{drain}$  (LINEAR)

Y2 axis: Transconductance  $g_m$  (LINEAR)

Y3 axis: Drain current  $I_{drain}$  (LOG)

[List Display]

$V_{backgate}$ : Back Gate voltage

$V_{source}$ : Source voltage

$V_{drain}$ : Drain voltage

$V_{sidegate}$ : Side Gate voltage

$I_{drain}$ : Drain current

$g_m$ : Transconductance

[Parameters Display Area]

Threshold voltage  $V_{th}$

Maximum transconductance value  $g_{mMax}$

## 7 Power Device

1. BVdss[3] PwrDevice: Breakdown voltage between source and drain (A.01.20)
2. BVgso[3] PwrDevice: Breakdown voltage between gate and source (A.01.20)
3. Id-Vd pulse[3] PwrDevice: Id-Vd characteristics (3-terminal), SMU Pulse (A.01.20)
4. Id-Vd[3] PwrDevice: Id-Vd Characteristics (3-terminal) (A.01.20)
5. Id-Vg pulse[3] PwrDevice: Id-Vg characteristics (3-terminal), SMU Pulse (A.01.20)
6. Id-Vg[3] PwrDevice: Id-Vg Characteristics (3-terminal) (A.01.20)
7. Vth Const Id[3] PwrDevice:  
Constant current Vth (A.01.20)
8. Vth gmMax[3] PwrDevice: Linear region Vth (A.01.20)

## **7.1 *BVdss*[3] PwrDevice: Breakdown voltage between source and drain (A.01.20)**

### [Description]

Measures the breakdown voltage between source and drain of a power MOSFET. Forces drain sweep voltage in the direction of FET on, and monitors breakdown.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Is@BVdss: Source current deemed to be a breakdown

Drain: SMU connected to Drain, primary sweep voltage output

VdStart: Sweep start voltage for Drain

VdStop: Sweep stop voltage for Drain

VdStep: Sweep step voltage for Drain

Gate: SMU connected to Gate, constant voltage output

Vg: Gate voltage

Source: SMU connected to Source, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $VgStart + BaseOffsetV$ .

### [Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for drain current measurement

GateMinRng: Minimum range for gate current measurement

IgLimit: Gate current compliance

### [Measurement Parameters]

Drain current Idrain

Source current Isource

For the Source terminal, the SMU current compliance is set to  $I_s@BVdss * 1.1$ .

### [User Function]

$I_{sourcePerWg} = I_{source} / Wg$ : Source current per unit gate width

$I_{drainPerWg} = I_{drain} / Wg$ : Drain current per unit gate width

### [Analysis Function]

$BVdss = @L1X$  (X intercept of Line1)

### [Auto Analysis]

Line1: Vertical line for Y2 at  $I_{source}=I_s@BV_{dss}$

[X-Y Plot]

X axis: Drain voltage  $V_{drain}$  (LINEAR)

Y1 axis: Drain current  $I_{drain}$  (LOG)

Y2 axis: Source current  $I_{source}$  (LOG)

[List Display]

Drain voltage  $V_{drain}$

Drain current  $I_{drain}$

Source current  $I_{source}$

Gate current  $I_{gate}$

Gate voltage  $V_{gate}$

Source voltage  $V_{source}$

[Parameters Display Area]

Source-Drain breakdown voltage  $BV_{dss}$

## 7.2 *BVgso[3] PwrDevice: Breakdown voltage between gate and source (A.01.20)*

### [Description]

Measures the breakdown voltage between gate and source of a power MOSFET when drain is opened. Forces gate sweep voltage in the direction of FET off, and monitors breakdown.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Is@BVgso: Source current deemed to be a breakdown

Gate: SMU connected to Gate, primary sweep voltage output

VgStart: Sweep start voltage for Gate

VgStop: Sweep stop voltage for Gate

VgStep: Sweep step voltage for Gate

Source: SMU connected to Source, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $VgStart+BaseOffsetV$ .

### [Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for gate current measurement

SourceMinRng: Minimum range for source current measurement

### [Measurement Parameters]

Source current Isource

Gate current Igate

For the terminals, the SMU current compliance is set to  $Is@BVgso*1.1$ .

### [User Function]

$IgatePerGateArea=Igate/Lg/Wg$ : Gate current per unit gate area

### [Analysis Function]

$BVgso=@L1X$  (X intercept of Line1)

### [Auto Analysis]

Line1: Vertical line for Y1 at  $Isource=Is@BVgso$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Source current Isource (LOG)

Y2 axis: Gate current Igate (LOG)

[List Display]

Gate voltage  $V_{gate}$

Source current  $I_{source}$

Gate current  $I_{gate}$

Source voltage  $V_{source}$

[Parameters Display Area]

Gate-Source breakdown voltage  $BV_{gso}$

### 7.3 *Id-Vd pulse[3] PwrDevice: Id-Vd characteristics (3-terminal), SMU Pulse (A.01.20)*

[Description]

Measures the drain current vs drain voltage characteristics of a power MOSFET.

[Device Under Test]

Power MOSFET, 3 terminals

[Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

[Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $VgStart+BaseOffsetV$ .

[Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

BaseValue: Pulse base voltage

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Drain current Idrain

[User Function]

$I_{drainPerWg} = I_{drain}/Wg$ : Drain current per unit gate width

[X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

[List Display]

Drain voltage Vdrain



Drain current  $I_{\text{drain}}$   
Source voltage  $V_{\text{source}}$   
Gate voltage  $V_{\text{gate}}$   
Drain current per unit gate width  $I_{\text{drainPerWg}}$

## 7.4 *Id-Vd[3] PwrDevice: Id-Vd Characteristics (3-terminal) (A.01.20)*

### [Description]

Measures the drain current vs drain voltage characteristics of a power MOSFET.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $VgStart + BaseOffsetV$ .

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$IdrainPerWg = Idrain / Wg$ : Drain current per unit gate width

### [X-Y Plot]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain voltage Vdrain

Drain current Idrain

Gate voltage Vgate

Source voltage Vsource

Drain current per unit gate width IdrainPerWg

## 7.5 *Id-Vg pulse[3] PwrDevice: Id-Vg characteristics (3-terminal), SMU Pulse (A.01.20)*

### [Description]

Measures the drain current vs gate voltage characteristics of a power MOSFET.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

PulsePeriod: Pulse period

PulseWidth: Pulse width

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $V_{gStart} + \text{BaseOffsetV}$ .

### [Extended Test Parameters]

Vs: Source voltage

BaseValue: Pulse base voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$\text{IdrainPerWg} = \text{Idrain} / \text{Wg}$ : Drain current per unit gate width

$\text{gm} = \text{diff}(\text{Idrain}, \text{Vgate})$ : gm: Transconductance

$\text{gmPerWg} = \text{diff}(\text{IdrainPerWg}, \text{Vgate})$ : Transconductance per unit gate width

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

[List Display]

Gate voltage  $V_{gate}$

Source voltage  $V_{source}$

Drain voltage  $V_{drain}$

Drain current  $I_{drain}$

Transconductance  $g_m$

Drain current per unit gate width  $I_{drainPerWg}$

Transconductance per unit gate width  $g_{mPerWg}$

## 7.6 *Id-Vg[3] PwrDevice: Id-Vg Characteristics (3-terminal) (A.01.20)*

### [Description]

Measures the drain current vs gate voltage characteristics of a power MOSFET.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $VgStart+BaseOffsetV$ .

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$IdrainPerWg=Idrain/Wg$ : Drain current per unit gate width

$gm=diff(Idrain,Vgate)$ : gm: Transconductance

$gmPerWg=diff(IdrainPerWg,Vgate)$ : Transconductance per unit gate width

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

### [List Display]

Gate voltage Vgate

Source voltage Vsource

Drain voltage  $V_{\text{drain}}$   
Drain current  $I_{\text{drain}}$   
Transconductance  $g_m$   
Drain current per unit gate width  $I_{\text{drainPerWg}}$   
Transconductance per unit gate width  $g_{m\text{PerWg}}$

## 7.7 *Vth Const Id[3] PwrDevice: Constant current Vth (A.01.20)*

### [Description]

Measures the drain current vs gate voltage characteristics, and extracts the threshold voltage ( $V_{th}$ ) by using the constant current method.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Id@Vth: Drain current to decide the  $V_{th}$

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $V_{gStart} + \text{BaseOffsetV}$ .

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$gm = \text{diff}(\text{Idrain}, V_{gate})$

### [Analysis Function]

$V_{th} = @L1X$  (X intercept of Line1)

### [Auto Analysis]

Line1: Vertical line for Y1 at  $\text{Idrain} = \text{Id}@V_{th}$

### [X-Y Plot]

X axis: Gate voltage  $V_{gate}$  (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

[List Display]

Gate voltage  $V_{gate}$

Drain current  $I_{drain}$

Source voltage  $V_{source}$

Drain voltage  $V_{drain}$

Transconductance  $g_m$

[Parameters Display Area]

Threshold voltage  $V_{th}$



## 7.8 *Vth gmMax[3] PwrDevice: Linear region Vth (A.01.20)*

### [Description]

Extracts the threshold voltage ( $V_{th}$ ) by using the extrapolation method for the linear region of the drain current vs gate voltage characteristics.

### [Device Under Test]

Power MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Drain: SMU connected to Drain terminal, constant voltage output

Vd: Drain voltage, ideally at around 100mV

Source: SMU connected to Source terminal, constant voltage output

BaseOffsetV: Base offset voltage

Base offset voltage is added to the specified voltage. For example, the gate start voltage will be  $V_{gStart} + \text{BaseOffsetV}$ .

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

gm\_Min: Minimum gm value for graph scale

gm\_Max: Maximum gm value for graph scale

DrainMinRng: Minimum range for drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

$gm = \text{diff}(\text{Idrain}, V_{gate})$

### [Analysis Function]

$gm_{Max} = \max(gm)$

$V_{on} = @L1X$  (X intercept of Line1)

$V_{th} = V_{on} - V_d/2$

$V_{th}$  is given by the following formula.

$V_{th} = V_g(gm_{Max}) - I_d(gm_{Max})/gm_{Max}$

$V_d/2$  is for compensation of the secondary term of  $V_d$  in the theoretical formula.

[Auto Analysis]

Line1: Tangent line for Y1 at gm=gmMax

[X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Transconductance gm (LINEAR)

Y3 axis: Drain current Idrain (LOG)

[List Display]

Gate voltage Vgate

Source voltage Vsource

Drain voltage Vdrain

Drain current Idrain

Transconductance gm

[Parameters Display Area]

Threshold voltage Vth

Maximum transconductance value gmMax

## 8 Reliability

1. BJT EB RevStress 3devices: Emitter-Base junction Reverse bias Stress test, 4 terminals, 3 devices (A.01.20)
2. BJT EB RevStress 3devices[3]: Emitter-Base junction Reverse bias Stress test, 3 terminals, 3 devices (A.01.20)
3. BJT EB RevStress: Emitter-Base junction Reverse bias Stress test, 4 terminals (A.01.20)
4. BJT EB RevStress[3]: Emitter-Base junction Reverse bias Stress test, 3 terminals (A.01.20)
5. BTI 3devices: Bias Temperature Instability test, 4 terminals, 3 devices (A.01.20)
6. BTI 3devices[3]: Bias Temperature Instability test, 3 terminals, 3 devices (A.01.20)
7. BTI: Bias Temperature Instability test, 4 terminals (A.01.20)
8. BTI[3]: Bias Temperature Instability test, 3 terminals (A.01.20)
9. Charge Pumping: Evaluation of the interface state using charge pumping method (A.01.20)
10. EM Istress: Electromigration test, current stressed, 4 SMUs (A.01.20)
11. EM Istress[2]: Electromigration test, current stressed, 2 SMUs (A.01.20)
12. EM Istress[6]: Electromigration test, current stressed, 6 SMUs (A.01.20)
13. EM Vstress: Electromigration test, voltage stressed, 4 SMUs (A.01.20)
14. EM Vstress[2]: Electromigration test, voltage stressed, 2 SMUs (A.01.20)
15. EM Vstress[6]: Electromigration test, voltage stressed, 6 SMUs (A.01.20)
16. HCI 3devices: Hot Carrier Injection test, 4 terminals, 3 devices (A.01.20)
17. HCI: Hot Carrier Injection test, 4 terminals (A.01.20)
18. J-Ramp: Insulator lifetime evaluation, current stressed (A.01.20)
19. TDDB Istress 3devices: TDDB Test, current stressed, 3 devices (A.01.20)
20. TDDB Istress: TDDB Test, current stressed (A.01.20)
21. TDDB Vstress 3devices: TDDB Test, voltage stressed, 3 devices (A.01.20)
22. TDDB Vstress: TDDB Test, voltage stressed (A.01.20)
23. TZDB: TZDB Test of oxide layer (A.01.20)
24. V-Ramp: Insulator lifetime evaluation, voltage stressed (A.01.20)

## **8.1 BJT EB RevStress 3devices: Emitter-Base junction Reverse bias Stress test, 4 terminals, 3 devices (A.01.20)**

### [Description]

Performs the bipolar transistor Emitter-Base junction reverse bias stress test, and plots the accumulated stress time vs collector current/base current/current amplification factor characteristics. Maximum three devices can be measured by a test execution. This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

Bipolar transistor, 4 terminals, 3 devices

### [Required Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the Tr#Base/Tr#Collector/Tr#Emitter/Tr#Subs field (# is an integer from 1 to 3) of Test Parameters area.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)

Le: Emitter length

We: Emitter width

Temp: Temperature (deg)

IcMax: Maximum collector current value

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

Tr#Base: SWM Pin Assign setting for Base of devices

Tr#Collector: SWM Pin Assign setting for Collector of devices

Tr#Emitter: SWM Pin Assign setting for Emitter of devices

Tr#Subs: SWM Pin Assign setting for Subs of devices

where, # is an integer from 1 to 3.

### [Test Parameters for Sampling\_Stress]

TotalStrsTime: Total stress time

Tr#StrsEmitter: SMU connected to Emitter terminal of devices, constant voltage output

StrsBase: SMU connected to Base terminal, constant voltage output

StrsCollector: SMU connected to Collector terminal, constant voltage output

StrsSubs: SMU connected to Substrate terminal, constant voltage output

Tr#VeStrs: Stress voltage for Emitter terminal of devices

where, # is an integer from 1 to 3.

### [Test Parameters for IvSweep\_hfe]

MeasCollector: SMU connected to Collector terminal, constant voltage output  
MeasBase: SMU connected to Base terminal, voltage output  
MeasEmitter: SMU connected to Emitter terminal, primary sweep constant voltage output  
MeasSubs: SMU connected to Substrate terminal, constant voltage output  
VbStart: Sweep start voltage for Base terminal  
VbStop: Sweep stop voltage for Base terminal  
VbStep: Sweep step voltage for Base terminal  
Ic@hfe: Collector current determining the hfe  
Vc: Collector voltage

[Extended Test Parameters]

[Extended Test Parameters for Sampling\_Stress]

VbStrs: Stress voltage for Base terminal  
VcStrs: Stress voltage for Collector terminal  
VsubsStrs: Stress voltage for Substrate terminal  
IeStrsLimit: Emitter current compliance

[Extended Test Parameters for IvSweep\_hfe]

IsubsLimit: Substrate current compliance  
Ve: Emitter voltage  
Vsubs: Substrate voltage  
hfe\_Min: Minimum hfe value for graph scale  
hfe\_Max: Maximum hfe value for graph scale  
HoldTime: Hold time  
DelayTime: Delay time  
BaseMinRng1: Minimum range for base current measurement on device 1  
BaseMinRng2: Minimum range for base current measurement on device 2  
BaseMinRng3: Minimum range for base current measurement on device 3  
CollectorMinRng1: Minimum range for collector current measurement on device 1  
CollectorMinRng2: Minimum range for collector current measurement on device 2  
CollectorMinRng3: Minimum range for collector current measurement on device 3

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $MaxTime = \max(Time)$   
Stress time  $StressTime = AccTime + Time$

[User Function for IvSweep\_hfe]

Current amplification factor  $hfe = I_{collector} / I_{base}$

[Analysis Function]

[Analysis Function for IvSweep\_hfe]  
 $I_b @ I_c = @L1X$  (X intercept of Line1)  
 $hfe @ I_c = @L2Y3$  (X intercept of Line2)

[Auto Analysis]

[Auto Analysis for IvSweep\_hfe]  
Line1: Horizontal line for Y1 at  $I_{collector} = I_c @ hfe$   
Line2: Horizontal line for Y3 at  $I_{collector} = I_c @ hfe$

[Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList (LOG)  
Y1 axis: Collector current for device 1 Dev1\_IcList (LINEAR)  
Y2 axis: Collector current for device 2 Dev2\_IcList (LINEAR)  
Y3 axis: Collector current for device 3 Dev3\_IcList (LINEAR)

Y4 axis: Y3 accumulation data at Icollector=Ic@hfe for device 1 Dev1\_hfe@IcList (LINEAR)  
Y5 axis: Y3 accumulation data at Icollector=Ic@hfe for device 2 Dev2\_hfe@IcList (LINEAR)  
Y6 axis: Y3 accumulation data at Icollector=Ic@hfe for device 3 Dev3\_hfe@IcList (LINEAR)

[Test Output: List Display]

TimeList: Accumulated stress time

Dev1\_IcList: Collector current for device 1

Dev2\_IcList: Collector current for device 2

Dev3\_IcList: Collector current for device 3

Dev1\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 1

Dev2\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 2

Dev3\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 3

Dev1\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 1

Dev2\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 2

Dev3\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 3

## **8.2 BJT EB RevStress 3devices[3]: Emitter-Base junction Reverse bias Stress test, 3 terminals, 3 devices (A.01.20)**

### [Description]

Performs the bipolar transistor Emitter-Base junction reverse bias stress test, and plots the accumulated stress time vs collector current/base current/current amplification factor characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

Bipolar transistor, 3 terminals, 3 devices

### [Required Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the Tr#Base/Tr#Collector/Tr#Emitter field (# is an integer from 1 to 3) of Test Parameters area.

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)

Le: Emitter length

We: Emitter width

Temp: Temperature (deg)

IcMax: Maximum collector current value

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

Tr#Base: SWM Pin Assign setting for Base of devices

Tr#Collector: SWM Pin Assign setting for Collector of devices

Tr#Emitter: SWM Pin Assign setting for Emitter of devices

where, # is an integer from 1 to 3.

### [Test Parameters for Sampling\_Stress]

TotalStrsTime: Total stress time

Tr#StrsEmitter: SMU connected to Emitter terminal of devices, constant voltage output

StrsBase: SMU connected to Base terminal, constant voltage output

StrsCollector: SMU connected to Collector terminal, constant voltage output

Tr#VeStrs: Stress voltage for Emitter terminal of devices

where, # is an integer from 1 to 3.

### [Test Parameters for IvSweep\_hfe]

MeasCollector: SMU connected to Collector terminal, constant voltage output

MeasBase: SMU connected to Base terminal, voltage output

MeasEmitter: SMU connected to Emitter terminal, primary sweep constant voltage output  
VbStart: Sweep start voltage for Base terminal  
VbStop: Sweep stop voltage for Base terminal  
VbStep: Sweep step voltage for Base terminal  
Ic@hfe: Collector current determining the hfe  
Vc: Collector voltage

[Extended Test Parameters]

[Extended Test Parameters for Sampling\_Stress]

VbStrs: Stress voltage for Base terminal  
VcStrs: Stress voltage for Collector terminal  
IeStrsLimit: Emitter current compliance

[Extended Test Parameters for IvSweep\_hfe]

Ve: Emitter voltage  
hfe\_Min: Minimum hfe value for graph scale  
hfe\_Max: Maximum hfe value for graph scale  
HoldTime: Hold time  
DelayTime: Delay time  
BaseMinRng1: Minimum range for base current measurement on device 1  
BaseMinRng2: Minimum range for base current measurement on device 2  
BaseMinRng3: Minimum range for base current measurement on device 3  
CollectorMinRng1: Minimum range for collector current measurement on device 1  
CollectorMinRng2: Minimum range for collector current measurement on device 2  
CollectorMinRng3: Minimum range for collector current measurement on device 3

[User Function]

[User Function for Sampling\_Stress]

Maximum elapsed time value  $MaxTime = \max(Time)$   
Stress time  $StressTime = AccTime + Time$

[User Function for IvSweep\_hfe]

Current amplification factor  $hfe = I_{collector} / I_{base}$

[Analysis Function]

[Analysis Function for IvSweep\_hfe]

$I_b @ I_c = @L1X$  (X intercept of Line1)  
 $hfe @ I_c = @L2Y3$  (X intercept of Line2)

[Auto Analysis]

[Auto Analysis for IvSweep\_hfe]

Line1: Horizontal line for Y1 at  $I_{collector} = I_c @ hfe$   
Line2: Horizontal line for Y3 at  $I_{collector} = I_c @ hfe$

[Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList (LOG)  
Y1 axis: Collector current for device 1 Dev1\_IcList (LINEAR)  
Y2 axis: Collector current for device 2 Dev2\_IcList (LINEAR)  
Y3 axis: Collector current for device 3 Dev3\_IcList (LINEAR)  
Y4 axis: Y3 accumulation data at  $I_{collector} = I_c @ hfe$  for device 1 Dev1\_hfe@IcList (LINEAR)  
Y5 axis: Y3 accumulation data at  $I_{collector} = I_c @ hfe$  for device 2 Dev2\_hfe@IcList (LINEAR)  
Y6 axis: Y3 accumulation data at  $I_{collector} = I_c @ hfe$  for device 3 Dev3\_hfe@IcList (LINEAR)

[Test Output: List Display]

TimeList: Accumulated stress time



Dev1\_IcList: Collector current for device 1  
Dev2\_IcList: Collector current for device 2  
Dev3\_IcList: Collector current for device 3  
Dev1\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 1  
Dev2\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 2  
Dev3\_hfe@IcList: Y3 accumulation data at Icollector=Ic@hfe for device 3  
Dev1\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 1  
Dev2\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 2  
Dev3\_Ib@IcList: Y1 accumulation data at Icollector=Ic@hfe for device 3

### **8.3 BJT EB RevStress: Emitter-Base junction Reverse bias Stress test, 4 terminals (A.01.20)**

#### [Description]

Performs the bipolar transistor Emitter-Base junction reverse bias stress test, and plots the accumulated stress time vs collector current/base current/current amplification factor characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

#### [Device Under Test]

Bipolar transistor, 4 terminals

#### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)

Le: Emitter length

We: Emitter width

Temp: Temperature (deg)

IcMax: Maximum collector current value

#### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

TotalStressTime: Total stress time

Collector: SMU connected to Collector terminal, constant voltage output

Base: SMU connected to Base terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

#### [Test Parameters for Sampling\_Stress]

VeStress: Stress voltage for Emitter terminal

#### [Test Parameters for IvSweep\_hfe]

Ic@hfe: Collector current determining the hfe

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Vc: Collector voltage

#### [Extended Test Parameters]

##### [Extended Test Parameters for Sampling\_Stress]

IeStressLimit: Emitter current compliance

VbStress: Stress voltage for Base terminal

VcStress: Stress voltage for Collector terminal

VsubsStress: Stress voltage for Substrate terminal

##### [Extended Test Parameters for IvSweep\_hfe]

HoldTime: Hold time

DelayTime: Delay time

IsubsLimit: Substrate current compliance

BaseMinRng: Minimum range for base current measurement

CollectorMinRng: Minimum range for collector current measurement  
Ve: Emitter voltage  
Vsubs: Substrate voltage  
hfe\_Min: Minimum hfe value for graph scale  
hfe\_Max: Maximum hfe value for graph scale

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value MaxTime=max(Time)  
Stress time StressTime=AccTime+Time

[User Function for IvSweep\_hfe]  
Current amplification factor hfe=Icollector/Ibase

[Analysis Function]

[Analysis Function for IvSweep\_hfe]  
Ib@Ic=@L1X (X intercept of Line1)  
hfe@Ic=@L2Y3 (X intercept of Line2)

[Auto Analysis]

[Auto Analysis for IvSweep\_hfe]  
Line1: Horizontal line for Y1 at Icollector=Ic@hfe  
Line2: Horizontal line for Y3 at Icollector=Ic@hfe

[Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList (LOG)  
Y1 axis: Collector current IcList (LOG)  
Y2 axis: Y1 accumulation data at Icollector=Ic@hfe Ib@IcList (LOG)  
Y3 axis: Y3 accumulation data at Icollector=Ic@hfe Ihfe@IcList (LINEAR)

[Test Output: List Display]

Accumulated stress time TimeList  
Collector current IcList  
Y1 accumulation data at Icollector=Ic@hfe Ib@IcList  
Y3 accumulation data at Icollector=Ic@hfe hfe@IcList

## **8.4 BJT EB RevStress[3]: Emitter-Base junction Reverse bias Stress test, 3 terminals (A.01.20)**

### [Description]

Performs the bipolar transistor Emitter-Base junction reverse bias stress test, and plots the accumulated stress time vs collector current/base current/current amplification factor characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

Bipolar transistor, 3 terminals

### [Device Parameters]

Polarity: NPN (SMUs force the specified value) or PNP (SMUs force the negative specified value)

Le: Emitter length

We: Emitter width

Temp: Temperature (deg)

IcMax: Maximum collector current value

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

TotalStressTime: Total stress time

Collector: SMU connected to Collector terminal, constant voltage output

Base: SMU connected to Base terminal, constant voltage output

Emitter: SMU connected to Emitter terminal, primary sweep voltage output

### [Test Parameters for Sampling\_Stress]

VeStress: Stress voltage for Emitter terminal

### [Test Parameters for IvSweep\_hfe]

Ic@hfe: Collector current determining the hfe

VbStart: Sweep start voltage for Base terminal

VbStop: Sweep stop voltage for Base terminal

VbStep: Sweep step voltage for Base terminal

Vc: Collector voltage

### [Extended Test Parameters]

#### [Extended Test Parameters for Sampling\_Stress]

IeStressLimit: Emitter current compliance

VbStress: Stress voltage for Base terminal

VcStress: Stress voltage for Collector terminal

#### [Extended Test Parameters for IvSweep\_hfe]

HoldTime: Hold time

DelayTime: Delay time

BaseMinRng: Minimum range for base current measurement

CollectorMinRng: Minimum range for collector current measurement

Ve: Emitter voltage

hfe\_Min: Minimum hfe value for graph scale

hfe\_Max: Maximum hfe value for graph scale

[User Function]

[User Function for Sampling\_Stress]

Maximum elapsed time value  $\text{MaxTime}=\text{max}(\text{Time})$

Stress time  $\text{StressTime}=\text{AccTime}+\text{Time}$

[User Function for IvSweep\_hfe]

$\text{hfe}=\text{Icollector}/\text{Ibase}$

[Analysis Function]

[Analysis Function for IvSweep\_hfe]

$\text{Ib@Ic}=@\text{L1X}$  (X intercept of Line1)

$\text{hfe@Ic}=@\text{L2Y3}$  (X intercept of Line2)

[Auto Analysis]

[Auto Analysis for IvSweep\_hfe]

Line1: Horizontal line for Y1 at  $\text{Icollector}=\text{Ic@hfe}$

Line2: Horizontal line for Y3 at  $\text{Icollector}=\text{Ic@hfe}$

[Test Output: X-Y Graph]

X axis: Accumulated stress time  $\text{TimeList}$  (LOG)

Y1 axis: Collector current  $\text{IcList}$  (LOG)

Y2 axis: Y1 accumulation data at  $\text{Icollector}=\text{Ic@hfe}$   $\text{Ib@IcList}$  (LOG)

Y3 axis: Y3 accumulation data at  $\text{Icollector}=\text{Ic@hfe}$   $\text{Ihfe@IcList}$  (LINEAR)

[Test Output: List Display]

Accumulated stress time  $\text{TimeList}$

Collector current  $\text{IcList}$

Y1 accumulation data at  $\text{Icollector}=\text{Ic@hfe}$   $\text{Ib@IcList}$

Y3 accumulation data at  $\text{Icollector}=\text{Ic@hfe}$   $\text{hfe@IcList}$

## **8.5 BTI 3 devices: Bias Temperature Instability test, 4 terminals, 3 devices (A.01.20)**

### [Description]

Performs the bias temperature instability test, and plots the accumulated stress time vs threshold voltage/drain current characteristics. Maximum three devices can be measured by a test execution. This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 4 terminals, 3 devices

### [Required Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the Tr#Gate/Tr#Drain/Tr#Source/Tr#Subs field (# is an integer from 1 to 3) of Test Parameters area.

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)  
Lg: Gate length  
Wg: Gate width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)  
Tr#Gate: SWM Pin Assign settings for Gate terminal of devices  
Tr#Drain: SWM Pin Assign settings for Drain terminal of devices  
Tr#Source: SWM Pin Assign settings for Source terminal of devices  
Tr#Subs: SWM Pin Assign settings for Substrate terminal of devices

where, # is an integer from 1 to 3.

### [Test Parameters for Sampling\_Stress]

TotalStrsTime: Total stress time  
Tr#StrsGate: SMU connected to Gate terminal of devices, constant voltage output  
StrsSource: SMU connected to Gate terminal of devices, constant voltage output (drain/subs short)  
Tr#VgStrs: Gate terminal stress voltage for the devices  
VsStrs: Source terminal stress voltage

where, # is an integer from 1 to 3.

### [Test Parameters for IvSweep\_ConstId]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output

MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output  
MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
Id@Vth: Drain current to decide the Vth, per unit area  
VgStart1: Sweep start voltage for Gate terminal  
VgStop1: Sweep stop voltage for Gate terminal  
VgStep1: Sweep step voltage for Gate terminal  
Vd1: Drain terminal voltage, constant value

[Test Parameters for IvSweep\_gmmax]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output  
MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output  
MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
VgStart2: Sweep start voltage for Gate terminal  
VgStop2: Sweep stop voltage for Gate terminal  
VgStep2: Sweep step voltage for Gate terminal  
Vd2: Drain voltage

[Test Parameters for Sampling\_Ids]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output  
MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output  
MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
Vg3: Gate terminal voltage  
Vd3: Drain terminal voltage

[Extended Test Parameters]

[Extended Test Parameters for IvSweep\_ConstId]

HoldTime: Hold time  
DelayTime: Delay time  
Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 1  
DrainMinRng3: Minimum range for drain current measurement on device 1

[Extended Test Parameters for IvSweep\_gmmax]

HoldTime: Hold time  
DelayTime: Delay time  
Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
gmMax\_Min: Minimum gmMax value for graph scale  
gmMax\_Max: Maximum gmMax value for graph scale  
DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 1  
DrainMinRng3: Minimum range for drain current measurement on device 1

[Extended Test Parameters for Sampling\_Ids]

Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance

DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 1  
DrainMinRng3: Minimum range for drain current measurement on device 1

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $\text{MaxTime}=\max(\text{Time})$   
Stress time  $\text{StressTime}=\text{AccTime}+\text{Time}$

[User Function for IvSweep\_ConstId]  
Maximum drain current value  $\text{IdMax}=\max(\text{abs}(\text{Idrain}))$  (For initial measurement only)

[User Function for IvSweep\_gmmax]  
Transconductance  $\text{gm}=\text{diff}(\text{Idrain}, \text{Vgate})$   
Maximum transconductance value  $\text{gmmax}=\max(\text{gm})$   
Maximum drain current value  $\text{IdMax}=\max(\text{abs}(\text{Idrain}))$  (For initial measurement only)

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]  
 $\text{Vth@Id}=@\text{L1X}$  (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]  
 $\text{Vth@Gm}=@\text{L1X}$  (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]  
Line1: Vertical line for Y1 at  $\text{Idrain}=\text{Id@Vth}$

[Auto Analysis for IvSweep\_gmmax]  
Line1: Tangent line for Y1 at  $\text{gm}=\text{gmMax}$

[Test Output: X-Y Graph]

X axis: Elapsed time  $\text{TimeList}$  (LOG)  
Y1 axis: Drain current for device 1  $\text{Dev1\_IdsList}$  (LOG)  
Y2 axis: Drain current for device 2  $\text{Dev2\_IdsList}$  (LOG)  
Y3 axis: Drain current for device 3  $\text{Dev3\_IdsList}$  (LOG)  
Y4 axis: Maximum transconductance value for device 1  $\text{Dev1\_GmMaxList}$  (LINEAR)  
Y5 axis: Maximum transconductance value for device 2  $\text{Dev2\_GmMaxList}$  (LINEAR)  
Y6 axis: Maximum transconductance value for device 3  $\text{Dev3\_GmMaxList}$  (LINEAR)

[Test Output: List Display]

$\text{TimeList}$ : Elapsed time  
 $\text{Dev1\_IdsList}$ : Drain current for device 1  
 $\text{Dev2\_IdsList}$ : Drain current for device 2  
 $\text{Dev3\_IdsList}$ : Drain current for device 3  
 $\text{Dev1\_VthIdList}$ : Vth for device 1, determined by constant current method  
 $\text{Dev2\_VthIdList}$ : Vth for device 2, determined by constant current method  
 $\text{Dev3\_VthIdList}$ : Vth for device 3, determined by constant current method  
 $\text{Dev1\_VthGmList}$ : Vth for device 1, determined by extrapolation method  
 $\text{Dev2\_VthGmList}$ : Vth for device 2, determined by extrapolation method  
 $\text{Dev3\_VthGmList}$ : Vth for device 3, determined by extrapolation method  
 $\text{Dev1\_GmMaxList}$ : Maximum transconductance value for device 1  
 $\text{Dev2\_GmMaxList}$ : Maximum transconductance value for device 2  
 $\text{Dev3\_GmMaxList}$ : Maximum transconductance value for device 3



## **8.6 BTI 3 devices[3]: Bias Temperature Instability test, 3 terminals, 3 devices (A.01.20)**

### [Description]

Performs the bias temperature instability test, and plots the accumulated stress time vs threshold voltage/drain current characteristics. Maximum three devices can be measured by a test execution. This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 3 terminals, 3 devices

### [Required Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the Tr#Gate/Tr#Drain/Tr#Source field (# is an integer from 1 to 3) of Test Parameters area.

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)  
Lg: Gate length  
Wg: Gate width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)  
Tr#Gate: SWM Pin Assign settings for Gate terminal of devices  
Tr#Drain: SWM Pin Assign settings for Drain terminal of devices  
Tr#Source: SWM Pin Assign settings for Source terminal of devices

where, # is an integer from 1 to 3.

### [Test Parameters for Sampling\_Stress]

TotalStrsTime: Total stress time  
Tr#StrsGate: SMU connected to Gate terminal of devices, constant voltage output  
StrsSource: SMU connected to Gate terminal of devices, constant voltage output (drain/subs short)  
Tr#VgStrs: Gate terminal stress voltage for the devices  
VsStrs: Source terminal stress voltage

where, # is an integer from 1 to 3.

### [Test Parameters for IvSweep\_ConstId]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output  
MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output

MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
Id@Vth: Drain current to decide the Vth, per unit area  
VgStart1: Sweep start voltage for Gate terminal  
VgStop1: Sweep stop voltage for Gate terminal  
VgStep1: Sweep step voltage for Gate terminal  
Vd1: Drain terminal voltage, constant value

[Test Parameters for IvSweep\_gmmax]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output  
MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output  
MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
VgStart2: Sweep start voltage for Gate terminal  
VgStop2: Sweep stop voltage for Gate terminal  
VgStep2: Sweep step voltage for Gate terminal  
Vd2: Drain voltage

[Test Parameters for Sampling\_Ids]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output  
MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output  
MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output  
Vg3: Gate terminal voltage  
Vd3: Drain terminal voltage

[Extended Test Parameters]

[Extended Test Parameters for IvSweep\_ConstId]

HoldTime: Hold time  
DelayTime: Delay time  
Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 2  
DrainMinRng3: Minimum range for drain current measurement on device 3

[Extended Test Parameters for IvSweep\_gmmax]

HoldTime: Hold time  
DelayTime: Delay time  
Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
gmMax\_Min: Minimum gmMax value for graph scale  
gmMax\_Max: Maximum gmMax value for graph scale  
DrainMinRng1: Minimum range for drain current measurement on device 1  
DrainMinRng2: Minimum range for drain current measurement on device 2  
DrainMinRng3: Minimum range for drain current measurement on device 3

[Extended Test Parameters for Sampling\_Ids]

Vs: Source terminal voltage, constant voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
DrainMinRng1: Minimum range for drain current measurement on device 1

DrainMinRng2: Minimum range for drain current measurement on device 2  
DrainMinRng3: Minimum range for drain current measurement on device 3

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $\text{MaxTime}=\max(\text{Time})$   
Stress time  $\text{StressTime}=\text{AccTime}+\text{Time}$

[User Function for IvSweep\_ConstId]  
Maximum drain current value  $\text{IdMax}=\max(\text{abs}(\text{Idrain}))$  (For initial measurement only)

[User Function for IvSweep\_gmmax]  
Transconductance  $\text{gm}=\text{diff}(\text{Idrain}, \text{Vgate})$   
Maximum transconductance value  $\text{gmmax}=\max(\text{gm})$   
Maximum drain current value  $\text{IdMax}=\max(\text{abs}(\text{Idrain}))$  (For initial measurement only)

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]  
 $\text{Vth@Id}=@\text{L1X}$  (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]  
 $\text{Vth@Gm}=@\text{L1X}$  (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]  
Line1: Vertical line for Y1 at  $\text{Idrain}=\text{Id@Vth}$

[Auto Analysis for IvSweep\_gmmax]  
Line1: Tangent line for Y1 at  $\text{gm}=\text{gmMax}$

[Test Output: X-Y Graph]

X axis: Elapsed time  $\text{TimeList}$  (LOG)  
Y1 axis: Drain current for device 1  $\text{Dev1\_IdsList}$  (LOG)  
Y2 axis: Drain current for device 2  $\text{Dev2\_IdsList}$  (LOG)  
Y3 axis: Drain current for device 3  $\text{Dev3\_IdsList}$  (LOG)  
Y4 axis: Maximum transconductance value for device 1  $\text{Dev1\_GmMaxList}$  (LINEAR)  
Y5 axis: Maximum transconductance value for device 2  $\text{Dev2\_GmMaxList}$  (LINEAR)  
Y6 axis: Maximum transconductance value for device 3  $\text{Dev3\_GmMaxList}$  (LINEAR)

[Test Output: List Display]

$\text{TimeList}$ : Elapsed time  
 $\text{Dev1\_IdsList}$ : Drain current for device 1  
 $\text{Dev2\_IdsList}$ : Drain current for device 2  
 $\text{Dev3\_IdsList}$ : Drain current for device 3  
 $\text{Dev1\_VthIdList}$ : Vth for device 1, determined by constant current method  
 $\text{Dev2\_VthIdList}$ : Vth for device 2, determined by constant current method  
 $\text{Dev3\_VthIdList}$ : Vth for device 3, determined by constant current method  
 $\text{Dev1\_VthGmList}$ : Vth for device 1, determined by extrapolation method  
 $\text{Dev2\_VthGmList}$ : Vth for device 2, determined by extrapolation method  
 $\text{Dev3\_VthGmList}$ : Vth for device 3, determined by extrapolation method  
 $\text{Dev1\_GmMaxList}$ : Maximum transconductance value for device 1  
 $\text{Dev2\_GmMaxList}$ : Maximum transconductance value for device 2  
 $\text{Dev3\_GmMaxList}$ : Maximum transconductance value for device 3

## 8.7 BTI: Bias Temperature Instability test, 4 terminals (A.01.20)

### [Description]

Performs the bias temperature instability test, and plots the accumulated stress time vs threshold voltage/drain current characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

TotalStressTime: Total stress time

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStress: Gate terminal stress voltage

### [Test Parameters for IvSweep\_ConstId]

Id@Vth: Drain current to decide the Vth, per unit area

VgStart1: Sweep start voltage for Gate terminal

VgStop1: Sweep stop voltage for Gate terminal

VgStep1: Sweep step voltage for Gate terminal

Vd1: Drain terminal voltage, constant value

### [Test Parameters for IvSweep\_gmmax]

VgStart2: Sweep start voltage for Gate terminal

VgStop2: Sweep stop voltage for Gate terminal

VgStep2: Sweep step voltage for Gate terminal

Vd2: Drain voltage

### [Test Parameters for Sampling\_Ids]

Vg3: Gate terminal voltage

Vd3: Drain terminal voltage

### [Extended Test Parameters]

#### [Extended Test Parameters for Sampling\_Stress]

Vd: Drain terminal voltage, constant voltage

Vs: Source terminal voltage, constant voltage

Vsubs: Substrate terminal voltage, constant voltage

IgLimit: Gate current compliance

[Extended Test Parameters for IvSweep\_ConstId]  
HoldTime: Hold time  
DelayTime: Delay time  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
Vs: Source terminal voltage, constant voltage  
Vsubs: Substrate terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement

[Extended Test Parameters for IvSweep\_gmmax]  
HoldTime: Hold time  
DelayTime: Delay time  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
Vs: Source terminal voltage, constant voltage  
Vsubs: Substrate terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale

[Extended Test Parameters for Sampling\_Ids]  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
Vs: Source terminal voltage, constant voltage  
Vsubs: Substrate terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $MaxTime = \max(Time)$   
Stress time  $StressTime = AccTime + Time$

[User Function for IvSweep\_ConstId]  
Maximum drain current value  $IdMax = \max(\text{abs}(Idrain))$  (For initial measurement only)

[User Function for IvSweep\_gmmax]  
Maximum drain current value  $IdMax = \max(\text{abs}(Idrain))$  (For initial measurement only)  
Transconductance  $gm = \text{diff}(Idrain, Vgate)$   
Maximum transconductance value  $gmMax = \max(gm)$

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]  
 $Vth@Id = @L1X$  (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]  
 $Vth@Gm = @L1X$  (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]  
Line1: Vertical line for Y1 at  $Idrain = Id@Vth$

[Auto Analysis for IvSweep\_gmmax]  
Line1: Tangent line for Y1 at  $gm = gmMax$

[Test Output: X-Y Graph]

X axis: Elapsed time TimeList (LOG)

Y1 axis: Maximum transconductance value gmMaxList (LINEAR)

Y2 axis: Vth by constant current method VthIdList (LINEAR)

Y3 axis: Vth by extrapolation method VthGmList (LINEAR)

Y4 axis: Drain current IdsList (LOG)

[Test Output: List Display]

Elapsed time TimeList

Vth by constant current method VthIdList

Vth by extrapolation method VthGmList

Drain current IdsList

Maximum transconductance value gmMaxList

## 8.8 BTI[3]: Bias Temperature Instability test, 3 terminals (A.01.20)

### [Description]

Performs the bias temperature instability test, and plots the accumulated stress time vs threshold voltage/drain current characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

TotalStressTime: Total stress time

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStress: Gate terminal stress voltage

### [Test Parameters for IvSweep\_ConstId]

Id@Vth: Drain current to decide the Vth, per unit area

VgStart1: Sweep start voltage for Gate terminal

VgStop1: Sweep stop voltage for Gate terminal

VgStep1: Sweep step voltage for Gate terminal

Vd1: Drain terminal voltage, constant value

### [Test Parameters for IvSweep\_gmmax]

VgStart2: Sweep start voltage for Gate terminal

VgStop2: Sweep stop voltage for Gate terminal

VgStep2: Sweep step voltage for Gate terminal

Vd2: Drain voltage

### [Test Parameters for Sampling\_Ids]

Vg3: Gate terminal voltage

Vd3: Drain terminal voltage

### [Extended Test Parameters]

#### [Extended Test Parameters for Sampling\_Stress]

Vd: Drain terminal voltage, constant voltage

Vs: Source terminal voltage, constant voltage

IgLimit: Gate current compliance

#### [Extended Test Parameters for IvSweep\_ConstId]

HoldTime: Hold time

DelayTime: Delay time  
IdLimit: Drain current compliance  
Vs: Source terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement

[Extended Test Parameters for IvSweep\_gmmax]

HoldTime: Hold time  
DelayTime: Delay time  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
Vs: Source terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale

[Extended Test Parameters for Sampling\_Ids]

IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
Vs: Source terminal voltage, constant voltage  
DrainMinRng: Minimum range for drain current measurement

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $\text{MaxTime}=\text{max}(\text{Time})$   
Stress time  $\text{StressTime}=\text{AccTime}+\text{Time}$

[User Function for IvSweep\_ConstId]

Maximum drain current value  $\text{IdMax}=\text{max}(\text{abs}(\text{Idrain}))$  (For initial measurement only)

[User Function for IvSweep\_gmmax]

Maximum drain current value  $\text{IdMax}=\text{max}(\text{abs}(\text{Idrain}))$  (For initial measurement only)  
Transconductance  $\text{gm}=\text{diff}(\text{Idrain}, \text{Vgate})$   
Maximum transconductance value  $\text{gmMax}=\text{max}(\text{gm})$

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]  
 $\text{Vth@Id}=@\text{L1X}$  (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]  
 $\text{Vth@Gm}=@\text{L1X}$  (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]  
Line1: Vertical line for Y1 at  $\text{Idrain}=\text{Id@Vth}$

[Auto Analysis for IvSweep\_gmmax]  
Line1: Tangent line for Y1 at  $\text{gm}=\text{gmMax}$

[Test Output: X-Y Graph]

X axis: Elapsed time TimeList (LOG)  
Y1 axis: Maximum transconductance value gmMaxList (LINEAR)  
Y2 axis: Vth by constant current method VthIdList (LINEAR)  
Y3 axis: Vth by extrapolation method VthGmList (LINEAR)  
Y4 axis: Drain current IdsList (LOG)



[Test Output: List Display]  
Elapsed time TimeList  
Vth by constant current method VthIdList  
Vth by extrapolation method VthGmList  
Drain current IdsList  
Maximum transconductance value gmMaxList

## **8.9 Charge Pumping: Evaluation of the interface state using charge pumping method (A.01.20)**

### [Description]

Measures the Substrate current vs Gate pulse base voltage characteristics, and extracts the interface state density (Nss). This test uses the Agilent 81110A pulse generator.

### [Test Setup used in this test definition]

ForcePGC: Used to apply Gate pulse

I/V-t Sampling: Used to perform the Substrate current measurement

ResetPG: Used to reset the pulse generator

### [Device Under Test]

MOSFET, 3 terminals or 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Source: SMU connected to Source, constant voltage output

Vs: Source voltage

IsLimit: Source current compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

IsubsLimit: Substrate current compliance

### [Extended Test Parameters]

SubsMinRng: Minimum range for the substrate current measurement

### [Test Parameters for Gate Pulse]

PulseLevel: Pulse output level

VbaseStart: Sweep start value of Gate pulse base voltage

VbaseStop: Sweep stop value of Gate pulse base voltage

VbaseStep: Sweep step value of Gate pulse base voltage

PulsePeriod: Pulse period

PulseDelay: Pulse delay

DutyCycle: Duty cycle

LeadingTime: Leading transition time

TrailingTime: Trailing transition time

PgAdd: GPIB address of Agilent 81110A

### [Test Output: X-Y Graph]

X axis: Gate pulse base voltage VbaseList (LINEAR)

Y1 axis: Substrate current IcpList (LOG)

### [Test Output: Parameters]

Interface state density Nss

### [Nss calculation]

$$N_{ss} = I_{cpMax} / q * PulsePeriod / Lg / Wg$$

## **8.10 EM Istress: Electromigration test, current stressed, 4 SMUs (A.01.20)**

### [Description]

Performs the Electromigration (EM) test, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode.

### [Device Under Test]

Wiring (resistor), 2 terminals

### [Device Parameters]

L: Length of pattern

W: Width of pattern

Temp: Temperature

### [Test Parameters]

Port1: SMU for Port1 stress force

Port2: SMU for Port2 stress force

VM1: SMU for Port1 voltage monitor

VM2: SMU for Port2 voltage monitor

TotalStressTime: Total stress time.

StopCondition: Measurement stop condition

I1Stress: Port1 stress current

NoOfSamples: Number of samples

IntegTime: Integration time

### [Extended Test Parameters]

V2: Port2 terminal voltage

V1Limit: Port1 voltage compliance

I2Limit: Port2 current compliance

HoldTime: Hold time

### [User Function]

I<sub>Port1PerArea</sub> (A/cm<sup>2</sup>) Port1 terminal current per unit area

I<sub>Port2PerArea</sub> (A/cm<sup>2</sup>) Port2 terminal current per unit area

R (ohm) Resistance of wiring

DeltaR (%) Difference from initial resistance

### [X-Y Plot]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal voltage V<sub>port1List</sub> (LOG)

Y2 axis: Resistance RList (LINEAR)

Y3 axis: Difference from initial resistance DeltaRList (LINEAR)

## **8.11 EM Istress[2]: Electromigration test, current stressed, 2 SMUs (A.01.20)**

### [Description]

Performs the Electromigration (EM) test, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode as shown below.

1. applies stress current
2. performs measurement and saves measurement data
3. calculates the device failure time

### [Device Under Test]

Wiring device, 2 terminals

### [Device Parameters]

D: Wiring pattern length

W: Wiring pattern width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time

TotalStressTime: Total stress time

StopCondition: Stop condition (%changes of wire resistance)

Port1: SMU connected to Port1, constant current output

Port2: SMU connected to Port2, constant voltage output

I1Stress: Port1 stress current

### [Extended Test Parameters]

V2: Port2 voltage

V1Limit: Port1 voltage compliance

I2Limit: Port2 current compliance

HoldTime: Hold time

DelayTime: Delay time

### [User Function]

Wiring resistance value  $R = V_{port1} / I_{port1}$

### [Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList

Y1 axis: Port1 voltage Vport1List

Y2 axis: Wiring resistance value RList

Y3 axis: Offset from initial resistance value DeltaRList

### [Test Output: List Display]

Accumulated stress time TimeList

Port1 voltage Vport1List

Wiring resistance value RList

Offset from initial resistance value DeltaRList

### [Test Output: Parameters]

FailureTime: Time to failure

## 8.12 EM Istress[6]: Electromigration test, current stressed, 6 SMUs (A.01.20)

### [Description]

Performs the Electromigration (EM) test for a wiring device with extrusion lines, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode as shown below.

1. applies stress current
2. performs measurement and saves measurement data
3. calculates the device failure time

### [Device Under Test]

Wiring device with extrusion lines, 6 terminals

### [Device Parameters]

D: Wiring pattern length  
W: Wiring pattern width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time  
TotalStressTime: Total stress time  
StopCondition: Stop condition 1 (%changes of wire resistance)  
ExtCondition: Stop condition 2 (current to extrusion line)  
Port1: SMU connected to Port1, constant current output  
Port2: SMU connected to Port2, constant voltage output  
Port3: SMU connected to Extrusion Line, constant voltage output  
Port4: SMU connected to Extrusion Line, constant voltage output  
VM1: SMU for Port1 voltage monitoring, constant voltage output  
VM2: SMU for Port2 voltage monitoring, constant voltage output  
I1Stress: Port1 stress current

### [Extended Test Parameters]

V2: Port2 voltage  
V3: Port3 voltage  
V4: Port4 voltage  
V1Limit: Port1 voltage compliance  
I2Limit: Port2 current compliance  
I3Limit: Port3 current compliance  
I4Limit: Port4 current compliance  
HoldTime: Hold time  
DelayTime: Delay time  
Port2MinRng: Minimum range for Port1 current measurement

### [User Function]

Potential difference between lines  $\Delta V = V_{m1} - V_{m2}$   
Wiring resistance value  $R = \Delta V / I_{port1}$

### [Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList  
Y1 axis: Wiring resistance value RList  
Y2 axis: Offset from initial resistance value DeltaRList  
Y3 axis: Port2 current Iport2List  
Y4 axis: Port3 current Iport3List  
Y5 axis: Port4 current Iport4List

[Test Output: List Display]

Accumulated stresss time TimeList

Wiring resistance value RList

Offset from initial resistance value DeltaRList

Port2 current Iport2List

Port3 current Iport3List

Port4 current Iport4List

[Test Output: Parameters]

R\_FailureTime: Time to failure (Resistance)

E\_FailureTime: Time to failure (Extrusion)

### **8.13 EM Vstress: Electromigration test, voltage stressed, 4 SMUs (A.01.20)**

[Description]

Performs the Electromigration (EM) test, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode.

[Device Under Test]

Wiring (resistor), 2 terminals

[Device Parameters]

L: Length of pattern

W: Width of pattern

Temp: Temperature

[Test Parameters]

Port1: SMU for Port1 stress force

Port2: SMU for Port2 stress force

VM1: SMU for Port1 voltage monitor

VM2: SMU for Port2 voltage monitor

TotalStressTime: Total stress time.

StopCondition: Measurement stop condition

V1Stress: Port1 stress voltage

NoOfSamples: Number of samples

IntegTime: Integration time

[Extended Test Parameters]

V2: Port2 terminal voltage

I1Limit: Port1 current compliance

HoldTime: Hold time

Port1MinRng: Minimum range for the port1 current measurement

[User Function]

I<sub>Port1PerArea</sub> (A/cm<sup>2</sup>) Port1 terminal current per unit area

I<sub>Port2PerArea</sub> (A/cm<sup>2</sup>) Port2 terminal current per unit area

R (ohm) Resistance of wiring

DeltaR (%) Difference from initial resistance

[X-Y Plot]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal current I<sub>port1List</sub> (LOG)

Y2 axis: Resistance RList (LINEAR)

Y3 axis: Difference from initial resistance DeltaRList (LINEAR)



## **8.14 EM Vstress[2]: Electromigration test, voltage stressed, 2 SMUs (A.01.20)**

### [Description]

Performs the Electromigration (EM) test, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode as shown below.

1. applies stress voltage
2. performs measurement and saves measurement data
3. calculates the device failure time

### [Device Under Test]

Wiring device, 2 terminals

### [Device Parameters]

D: Wiring pattern length

W: Wiring pattern width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time

TotalStressTime: Total stress time

StopCondition: Stop condition (%changes of wire resistance)

Port1: SMU connected to Port1, constant voltage output

Port2: SMU connected to Port2, constant voltage output

V1Stress: Port1 stress voltage

### [Extended Test Parameters]

V2: Port2 voltage

I1Limit: Port1 current compliance

HoldTime: Hold time

Port1MinRng: Minimum range for Port1 current measurement

### [User Function]

Wiring resistance value  $R = V_{port1} / I_{port1}$

### [Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList

Y1 axis: Port1 current Iport1List

Y2 axis: Wiring resistance value RList

Y3 axis: Offset from initial resistance value DeltaRList

### [Test Output: List Display]

Accumulated stress time TimeList

Port1 current Iport1List

Wiring resistance value RList

Offset from initial resistance value DeltaRList

### [Test Output: Parameters]

FailureTime: Time to failure

## 8.15 EM Vstress[6]: Electromigration test, voltage stressed, 6 SMUs (A.01.20)

### [Description]

Performs the Electromigration (EM) test for a wiring device with extrusion lines, and plots the stress time vs resistance characteristics. This test is performed by the sampling measurement mode as shown below.

1. applies stress voltage
2. performs measurement and saves measurement data
3. calculates the device failure time

### [Device Under Test]

Wiring device with extrusion lines, 6 terminals

### [Device Parameters]

D: Wiring pattern length  
W: Wiring pattern width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time  
TotalStressTime: Total stress time  
StopCondition: Stop condition 1 (%changes of wire resistance)  
ExtCondition: Stop condition 2 (current to extrusion line)  
Port1: SMU connected to Port1, constant voltage output  
Port2: SMU connected to Port2, constant voltage output  
Port3: SMU connected to Extrusion Line, constant voltage output  
Port4: SMU connected to Extrusion Line, constant voltage output  
VM1: SMU for Port1 voltage monitoring, constant voltage output  
VM2: SMU for Port2 voltage monitoring, constant voltage output  
V1Stress: Port1 stress voltage

### [Extended Test Parameters]

V2: Port2 voltage  
V3: Port3 voltage  
V4: Port4 voltage  
IM1: VM1 output current  
IM2: VM2 output current  
I1Limit: Port1 current compliance  
I3Limit: Port3 current compliance  
I4Limit: Port4 current compliance  
HoldTime: Hold time  
DelayTime: Delay time  
Port1MinRng: Minimum range for Port1 current measurement

### [User Function]

Potential difference between lines  $\Delta V = VM1 - VM2$   
Wiring resistance value  $R = \Delta V / I_{port1}$

### [Test Output: X-Y Graph]

X axis: Accumulated stress time TimeList  
Y1 axis: Wiring resistance value RList  
Y2 axis: Port1 current Iport1List  
Y3 axis: Port3 current Iport3List  
Y4 axis: Port4 current Iport4List  
Y5 axis: Offset from initial resistance value DeltaRList

[Test Output: List Display]

Accumulated stresss time TimeList

Port1 current Iport1List

Wiring resistance value RList

Port3 current Iport3List

Port4 current Iport4List

Offset from initial resistance value DeltaRList

[Test Output: Parameters]

R\_FailureTime: Time to failure (Resistance)

E\_FailureTime: Time to failure (Extrusion)

## **8.16 HCI 3devices: Hot Carrier Injection test, 4 terminals, 3 devices (A.01.20)**

### [Description]

Performs the hot carrier injection test, and plots the accumulated stress time vs threshold voltage/drain current characteristics. Maximum three devices can be measured by a test execution. This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 4 terminals, 3 devices

### [Required Accessories]

Agilent B2200A or B2201A switching matrix 1 unit  
GPIB cable

Connect B2200A/B2201A to B1500A with a measuring cable and GPIB cable.

Set information on B1500A SMU channel's connection to the B2200A/B2201A input port properly on the Switching Matrix tab screen of the Configuration window.

Set the output channel number of B2200A/B2201A connected to each terminal of a device under test properly in the Tr#Gate/Tr#Drain/Tr#Source/Tr#Subs field (# is an integer from 1 to 3) of Test Parameters area.

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

Tr#Gate: SWM Pin Assign settings for Gate terminal of devices

Tr#Drain: SWM Pin Assign settings for Drain terminal of devices

Tr#Source: SWM Pin Assign settings for Source terminal of devices

Tr#Subs: SWM Pin Assign settings for Substrate terminal of devices

where, # is an integer from 1 to 3.

### [Test Parameters for Sampling\_Stress]

TotalStrsTime: Total stress time

Tr#StrsGate: SMU connected to Gate terminal of devices, constant voltage output

Tr#StrsDrain: SMU connected to Drain terminal of devices, constant voltage output

StrsSource: SMU connected to Source terminal of devices, constant voltage output

StrsSubs: SMU connected to Substrate terminal of devices, constant voltage output

Tr#VgStrs: Gate terminal stress voltage for the devices

Tr#VdStrs: Drain terminal stress voltage for the devices

VsubsStrs: Substrate terminal stress voltage for the devices

VsStrs: Source terminal stress voltage for the devices

where, # is an integer from 1 to 3.

### [Test Parameters for IvSweep\_ConstId]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output

MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output

MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output

MeasSubs: SMU connected to the basic characteristics acquisition Substrate terminal, constant voltage output

Id@Vth: Drain current to decide the Vth, per unit area

VgStart1: Sweep start voltage for Gate terminal

VgStop1: Sweep stop voltage for Gate terminal

VgStep1: Sweep step voltage for Gate terminal

Vd1: Drain terminal voltage

[Test Parameters for IvSweep\_gmmax]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output

MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output

MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output

MeasSubs: SMU connected to the basic characteristics acquisition Substrate terminal, constant voltage output

VgStart2: Sweep start voltage for Gate terminal

VgStop2: Sweep stop voltage for Gate terminal

VgStep2: Sweep step voltage for Gate terminal

Vd2: Drain voltage

[Test Parameters for Sampling\_Ids]

MeasGate: SMU connected to the basic characteristics acquisition Gate terminal, primary sweep voltage output

MeasDrain: SMU connected to the basic characteristics acquisition Drain terminal, constant voltage output

MeasSource: SMU connected to the basic characteristics acquisition Source terminal, constant voltage output

MeasSubs: SMU connected to the basic characteristics acquisition Substrate terminal, constant voltage output

Vg3: Gate terminal voltage

Vd3: Drain terminal voltage

[Extended Test Parameters]

[Extended Test Parameters for IvSweep\_ConstId]

HoldTime: Hold time

DelayTime: Delay time

Vsubs: Substrate terminal voltage

Vs: Source terminal voltage

IgLimit: Gate current compliance of devices

IdLimit: Drain current compliance of devices

IsubsLimit: Substrate current compliance

DrainMinRng1: Minimum range for drain current measurement on device 1

DrainMinRng2: Minimum range for drain current measurement on device 2

DrainMinRng3: Minimum range for drain current measurement on device 3

[Extended Test Parameters for IvSweep\_gmmax]

HoldTime: Hold time

DelayTime: Delay time

Vsubs: Substrate terminal voltage

Vs: Source terminal voltage

IgLimit: Gate current compliance of devices

IdLimit: Drain current compliance of devices

IsubsLimit: Substrate current compliance

gmMax\_Min: Minimum gmMax value for graph scale

gmMax\_Max: Maximum gmMax value for graph scale

DrainMinRng1: Minimum range for drain current measurement on device 1

DrainMinRng2: Minimum range for drain current measurement on device 2  
DrainMinRng3: Minimum range for drain current measurement on device 3

[Extended Test Parameters for Sampling\_Ids]

Vsubs: Substrate terminal voltage

Vs: Source terminal voltage

IgLimit: Gate current compliance of devices

IdLimit: Drain current compliance of devices

IsubsLimit: Substrate current compliance

DrainMinRng1: Minimum range for drain current measurement on device 1

DrainMinRng2: Minimum range for drain current measurement on device 2

DrainMinRng3: Minimum range for drain current measurement on device 3

[User Function]

[User Function for Sampling\_Stress]

Maximum elapsed time value MaxTime=max(Time)

Stress time StressTime=AccTime+Time

[User Function for IvSweep\_ConstId]

Maximum drain current value IdMax=max(abs(Idrain)) (For initial measurement only)

[User Function for IvSweep\_gmmax]

Maximum drain current value IdMax=max(abs(Idrain)) (For initial measurement only)

Transconductance gm=diff(Idrain,Vgate)

Maximum transconductance value gmMax=max(gm)

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]

Vth@Id=@L1X (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]

Vth@Gm=@L1X (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]

Line1: Vertical line for Y1 at Idrain=Id@Vth

[Auto Analysis for IvSweep\_gmmax]

Line1: Tangent line for Y1 at gm=gmMax

[Test Output: X-Y Graph]

X axis: Elapsed time TimeList (LOG)

Y1 axis: Drain current for device 1 Dev1\_IdsList (LOG)

Y2 axis: Drain current for device 2 Dev2\_IdsList (LOG)

Y3 axis: Drain current for device 3 Dev3\_IdsList (LOG)

Y4 axis: Maximum transconductance value for device 1 Dev1\_gmMaxList (LINEAR)

Y5 axis: Maximum transconductance value for device 2 Dev2\_gmMaxList (LINEAR)

Y6 axis: Maximum transconductance value for device 3 Dev3\_gmMaxList (LINEAR)

[Test Output: List Display]

TimeList: Elapsed time

Dev1\_IdsList: Drain current for device 1

Dev2\_IdsList: Drain current for device 2

Dev3\_IdsList: Drain current for device 3

Dev1\_VthIdList: Vth for device 1, determined by constant current method

Dev2\_VthIdList: Vth for device 2, determined by constant current method  
Dev3\_VthIdList: Vth for device 3, determined by constant current method  
Dev1\_VthGmList: Vth for device 1, determined by extrapolation method  
Dev2\_VthGmList: Vth for device 2, determined by extrapolation method  
Dev3\_VthGmList: Vth for device 3, determined by extrapolation method  
Dev1\_gmMaxList: Maximum transconductance value for device 1  
Dev2\_gmMaxList: Maximum transconductance value for device 2  
Dev3\_gmMaxList: Maximum transconductance value for device 3

## **8.17 HCI: Hot Carrier Injection test, 4 terminals (A.01.20)**

### [Description]

Performs the hot carrier injection test, and plots the accumulated stress time vs threshold voltage/drain current characteristics.

This test is performed as follows.

1. performs initial characterization
2. applies stress voltage
3. performs interim characterization
4. saves measurement data
5. repeats 2 to 4 until TotalStressTime elapses

### [Device Under Test]

MOSFET, 4 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time (SHORT, MEDIUM, LONG)

TotalStressTime: Total stress time

Gate: SMU connected to Gate terminal, primary sweep voltage output

Drain: SMU connected to Drain terminal, constant voltage output

Subs: SMU connected to Substrate terminal, constant voltage output

Source: SMU connected to Source terminal, constant voltage output

VgStress: Gate terminal stress voltage

VdStress: Drain terminal stress voltage

VsubsStress: Substrate terminal stress voltage

Vsubs: Substrate terminal voltage

### [Test Parameters for IvSweep\_ConstId]

Id@Vth: Drain current to decide the Vth, per unit area

VgStart1: Sweep start voltage for Gate terminal

VgStop1: Sweep stop voltage for Gate terminal

VgStep1: Sweep step voltage for Gate terminal

Vd1: Drain terminal voltage, constant value

### [Test Parameters for IvSweep\_gmmax]

VgStart2: Sweep start voltage for Gate terminal

VgStop2: Sweep stop voltage for Gate terminal

VgStep2: Sweep step voltage for Gate terminal

Vd2: Drain voltage

### [Test Parameters for Sampling\_Ids]

Vg3: Gate terminal voltage

Vd3: Drain terminal voltage

### [Extended Test Parameters]

[Extended Test Parameters for IvSweep\_ConstId]

HoldTime: Hold time

DelayTime: Delay time



Vs: Source terminal voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
DrainMinRng: Minimum range for drain current measurement

[Extended Test Parameters for IvSweep\_gmmax]

HoldTime: Hold time  
DelayTime: Delay time  
Vs: Source terminal voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
Vth\_Min: Minimum Vth value for graph scale  
Vth\_Max: Maximum Vth value for graph scale  
gmMax\_Min: Minimum gmMax value for graph scale  
gmMax\_Max: Maximum gmMax value for graph scale  
DrainMinRng: Minimum range for drain current measurement

[Extended Test Parameters for Sampling\_Ids]

Vs: Source terminal voltage  
IgLimit: Gate current compliance  
IdLimit: Drain current compliance  
IsubsLimit: Substrate current compliance  
DrainMinRng: Minimum range for drain current measurement

[User Function]

[User Function for Sampling\_Stress]  
Maximum elapsed time value  $MaxTime = \max(Time)$   
Stress time  $StressTime = AccTime + Time$

[User Function for IvSweep\_ConstId]

Maximum drain current value  $IdMax = \max(\text{abs}(Idrain))$  (For initial measurement only)

[User Function for IvSweep\_gmmax]

Maximum drain current value  $IdMax = \max(\text{abs}(Idrain))$  (For initial measurement only)  
Transconductance  $gm = \text{diff}(Idrain, Vgate)$   
Maximum transconductance value  $gmMax = \max(gm)$

[Analysis Function]

[Analysis Function for IvSweep\_ConstId]  
 $Vth@Id = @L1X$  (X intercept of Line1)

[Analysis Function for IvSweep\_gmmax]

$Vth@Gm = @L1X$  (X intercept of Line1)

[Auto Analysis]

[Auto Analysis for IvSweep\_ConstId]  
Line1: Vertical line for Y1 at  $Idrain = Id@Vth$

[Auto Analysis for IvSweep\_gmmax]

Line1: Tangent line for Y1 at  $gm = gmMax$

[Test Output: X-Y Graph]

X axis: Elapsed time TimeList (LOG)

Y1 axis: Maximum transconductance value gmMaxList (LINEAR)  
Y2 axis: Vth by constant current method VthIdList (LINEAR)  
Y3 axis: Vth by extrapolation method VthGmList (LINEAR)  
Y4 axis: Drain current IdsList (LOG)

[Test Output: List Display]

Elapsed time TimeList  
Vth by constant current method VthIdList  
Vth by extrapolation method VthGmList  
Drain current IdsList  
Maximum transconductance value gmMaxList

## **8.18 J-Ramp: Insulator lifetime evaluation, current stressed (A.01.20)**

### [Description]

Measures the time vs current/voltage characteristics with current stress, and extracts the lifetime of the gate oxide, insulator and so on.

### [Device Under Test]

MOS capacitor, oxide layer, insulator and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

TimeMax: Maximum value of X axis

Gate: SMU connected to Gate, primary sweep, current output

IgStart: Sweep start current

IgStop: Sweep stop current

VgLimit: Gate voltage compliance

Subs: SMU connected to Substrate, constant voltage output

### [Extended Test Parameters]

Vsubs: Substrate voltage

HoldTime: Hold time

DelayTime: Delay time

SubsMinRng: Minimum range for the substrate current measurement

### [User Function]

$I_{gatePerArea} = I_{gate} / L_g / W_g$

$I_{subsPerArea} = I_{subs} / L_g / W_g$

$Q_{bdi} = \text{integ}(I_{gate}, \text{Time}) / L_g / W_g$

### [Test Output: X-Y Graph]

X axis: Time stamp TimeList (LINEAR)

Y1 axis: Gate current IgateList (LOG)

Y2 axis: Gate voltage VgateList (LINEAR)

### [Test Output: List Display]

Time stamp TimeList

Gate current IgateList

Gate voltage VgateList

### [Test Output: Parameters]

Breakdown voltage Vbd

Time to breakdown Tbd

Charge to breakdown Qbd

## **8.19 TDDDB Istress 3devices: TDDDB Test, current stressed, 3 devices (A.01.20)**

### [Description]

Performs the TDDDB (time dependent dielectric breakdown) test, and plots the stress time vs voltage characteristics. This test is performed by the sampling measurement mode. This test also supports 3-device connection.

### [Device Under Test]

MOS capacitor, insulator, oxide layer, and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

L: Length of pattern

W: Width of pattern

Temp: Temperature

### [Test Parameters]

Port1: SMU connected to Port1 terminal

Port2: SMU connected to Port2 terminal

Port3: SMU connected to Port3 terminal

Port4: SMU connected to Port4 terminal

TotalStressTime: Total stress time.

StopCondition: Terminal voltage to decide the breakdown

I1Stress: Port1 stress current

I2Stress: Port2 stress current

I3Stress: Port3 stress current

NoOfSamples: Number of samples

IntegTime: Integration time

### [Extended Test Parameters]

V4: Port4 terminal voltage

V1Limit: Port1/Port2/Port3 voltage compliance

I4Limit: Port4 current compliance

HoldTime: Hold time

Port4MinRng: Minimum range for the port4 current measurement

### [User Function]

IPort1PerArea= $I_{port1}/L/W$

IPort2PerArea= $I_{port2}/L/W$

IPort3PerArea= $I_{port3}/L/W$

IPort4PerArea= $I_{port4}/L/W$

### [Test Output: X-Y Graph]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal voltage Vport1List (LOG)

Y2 axis: Port2 terminal voltage Vport2List (LOG)

Y3 axis: Port3 terminal voltage Vport3List (LOG)

### [Test Output: Parameters]

Device1 breakdown voltage Vbd1

Device2 breakdown voltage Vbd2

Device3 breakdown voltage Vbd3

Device1 time to breakdown Tbd1

Device2 time to breakdown Tbd2

Device3 time to breakdown Tbd3  
Device1 charge to breakdown Qbd1  
Device2 charge to breakdown Qbd2  
Device3 charge to breakdown Qbd3

## **8.20 TDDB Istress: TDDB Test, current stressed (A.01.20)**

### [Description]

Performs the TDDB (time dependent dielectric breakdown) test, and plots the stress time vs voltage characteristics. This test is performed by the sampling measurement mode.

### [Device Under Test]

MOS capacitor, insulator, oxide layer, and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

L: Port1 terminal length

W: Port1 terminal width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

TotalStressTime: Total stress time. 10 to 10000 seconds.

NoOfSamples: Number of samples

Port1: SMU connected to Port1 terminal

I1Stress: Port1 stress current

Port2: SMU connected to Port2 terminal

### [Extended Test Parameters]

V2: Port2 terminal voltage

V1Limit: Port1 voltage compliance

I2Limit: Port2 current compliance

HoldTime: Hold time

Port2MinRng: Minimum range for the port2 current measurement

### [User Function]

I1PerArea=Iport1/L/W

I2PerArea=Iport2/L/W

### [Test Output: X-Y Graph]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal voltage Vport1List (LINEAR)

### [Test Output: List Display]

Stress time TimeList

Port1 terminal voltage Vport1List

### [Test Output: Parameters]

Breakdown voltage Vbd

Time to breakdown Tbd

Charge to breakdown Qbd

### [Qbd calculation]

$Qbd = I1Stress * Tbd / L / W$

## 8.21 TDDDB Vstress 3devices: TDDDB Test, voltage stressed, 3 devices (A.01.20)

### [Description]

Performs the TDDDB (time dependent dielectric breakdown) test, and plots the stress time vs current characteristics. This test is performed by the sampling measurement mode. This test also supports 3-device connection.

### [Device Under Test]

MOS capacitor, insulator, oxide layer, and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

L: Length of pattern

W: Width of pattern

Temp: Temperature

### [Test Parameters]

Port1: SMU connected to Port1 terminal

Port2: SMU connected to Port2 terminal

Port3: SMU connected to Port3 terminal

Port4: SMU connected to Port4 terminal

TotalStressTime: Total stress time.

StopCondition: Terminal current to decide the breakdown

V1Stress: Port1 stress voltage

V2Stress: Port2 stress voltage

V3Stress: Port3 stress voltage

NoOfSamples: Number of samples

IntegTime: Integration time

### [Extended Test Parameters]

V4: Port4 terminal voltage

I1Limit: Port1/Port2/Port3 current compliance

HoldTime: Hold time

Port1MinRng: Minimum range for the port1 current measurement

Port2MinRng: Minimum range for the port2 current measurement

Port3MinRng: Minimum range for the port3 current measurement

Port4MinRng: Minimum range for the port4 current measurement

### [User Function]

IPort1PerArea= $I_{port1}/L/W$

IPort2PerArea= $I_{port2}/L/W$

IPort3PerArea= $I_{port3}/L/W$

IPort4PerArea= $I_{port4}/L/W$

Qbd1val= $\text{integ}(I_{port1}, \text{Time})/L/W$

Qbd2val= $\text{integ}(I_{port2}, \text{Time})/L/W$

Qbd3val= $\text{integ}(I_{port3}, \text{Time})/L/W$

### [Test Output: X-Y Graph]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal current Iport1List (LOG)

Y2 axis: Port2 terminal current Iport2List (LOG)

Y3 axis: Port3 terminal current Iport3List (LOG)

### [Test Output: Parameters]

Device1 time to breakdown Tbd1  
Device2 time to breakdown Tbd2  
Device3 time to breakdown Tbd3  
Device1 charge to breakdown Qbd1  
Device2 charge to breakdown Qbd2  
Device3 charge to breakdown Qbd3



## 8.22 *TDDB Vstress: TDDB Test, voltage stressed (A.01.20)*

### [Description]

Performs the TDDB (time dependent dielectric breakdown) test, and plots the stress time vs current characteristics. This test is performed by the sampling measurement mode.

### [Device Under Test]

MOS capacitor, insulator, oxide layer, and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

L: Port1 terminal length

W: Port1 terminal width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

TotalStressTime: Total stress time. 10 to 10000 seconds.

StopCondition: Port1 terminal current to decide the breakdown

NoOfSamples: Number of samples

Port1: SMU connected to Port1 terminal

V1Stress: Port1 stress voltage

Port2: SMU connected to Port2 terminal

### [Extended Test Parameters]

V2: Port2 terminal voltage

I1Limit: Current compliance

HoldTime: Hold time

Port1MinRng: Minimum range for the port1 current measurement

### [User Function]

$I_{Port1PerArea} = I_{port1}/L/W$

$I_{Port2PerArea} = I_{port2}/L/W$

$Q_{bdval} = \text{integ}(I_{port1}, \text{Time})/L/W$

### [Test Output: X-Y Graph]

X axis: Stress time TimeList (LOG)

Y1 axis: Port1 terminal current Iport1List (LOG)

### [Test Output: List Display]

Stress time TimeList

Port1 terminal current Iport1List

Charge to breakdown QbdList

### [Test Output: Parameters]

Time to breakdown Tbd

Charge to breakdown Qbd

## 8.23 TZDB: TZDB Test of oxide layer (A.01.20)

### [Description]

Performs the TZDB (time zero dielectric breakdown) test, and plots the current vs voltage characteristics.

### [Device Under Test]

MOS capacitor, oxide layer, and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate, primary sweep, voltage output

VgStart: Sweep start voltage

VgStop: Sweep stop voltage

VgStep: Sweep step voltage

IgLimit: Gate current compliance

Subs: SMU connected to Substrate, constant voltage output

### [Extended Test Parameters]

Vsubs: Substrate voltage

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [User Function]

IgatePerArea=Igate/L/W

IsubsPerArea=Isubs/L/W

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Gate current Igate (LOG)

Y2 axis: Gate current per unit area IgatePerArea (LOG)

## 8.24 V-Ramp: Insulator lifetime evaluation, voltage stressed (A.01.20)

### [Description]

Measures the time vs current/voltage characteristics with voltage stress, and extracts the lifetime of the gate oxide, insulator and so on.

### [Device Under Test]

MOS capacitor, oxide layer, insulator and so on

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

TimeMax: Maximum value of X axis

Gate: SMU connected to Gate, primary sweep, voltage output

VgStart: Sweep start voltage

VgStop: Sweep stop voltage

VgStep: Sweep step voltage

Ibd: Gate current to decide the breakdown

Subs: SMU connected to Substrate, constant voltage output

### [Extended Test Parameters]

Vsubs: Substrate voltage

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [User Function]

$I_{gatePerArea} = I_{gate} / Lg / Wg$

$I_{subsPerArea} = I_{subs} / Lg / Wg$

$Q_{bdi} = \text{integ}(I_{gate}, \text{Time}) / Lg / Wg$

### [Test Output: X-Y Graph]

X axis: Time stamp TimeList (LINEAR)

Y1 axis: Gate current IgateList (LOG)

Y2 axis: Gate voltage VgateList (LINEAR)

### [Test Output: List Display]

Time stamp TimeList

Gate current IgateList

Gate voltage VgateList

Charge to breakdown QbdList

### [Test Output: Parameters]

Breakdown voltage Vbd

Charge to breakdown Qbd

Time to breakdown Tbd



## 9 Structure

1. BVgb ThinOx: MOS capacitor Ig-Vg characteristics (A.01.20)
2. BVgb: MOS capacitor Gate-Substrate breakdown voltage (A.01.20)
3. Cgb-Freq[2] Log: Cgb-f characteristics, 2 terminals (A.01.20)
4. Cgb-Vg 2Freq: MOS capacitor Cgb-Vg characteristics, 2-frequency method (A.01.11)
5. Cgb-Vg[2]: MOS capacitor Cgb-Vg characteristics (A.01.11)
6. Cj-Freq Log: Cj-f characteristics, junction device (A.01.20)
7. Cj-V: Junction capacitance Cj-V characteristics (A.01.11)
8. Diode BVAndCj-V ASU: Diode junction capacitance and breakdown voltage measurement using ASUs (A.01.20)
9. Diode BVAndCj-V SCUU: Diode junction capacitance and breakdown voltage measurement using SCUU (A.01.20)
10. Ig-Vg Iforce: MOS capacitor Ig-Vg characteristics, current sweep (A.01.20)
11. Ig-Vg Vforce: MOS capacitor Ig-Vg characteristics, voltage sweep (A.01.20)
12. Interconnect CouplingCap: Interconnection capacitance (A.01.11)
13. Interconnect OverlapCap: Layer to layer film capacitance (A.01.11)
14. Junction BV: Junction device breakdown voltage (A.01.20)
15. Junction DcParam: Junction device DC parameters (Is,N,Rs) (A.01.20)
16. Junction IV Fwd: Diode forward bias characteristics (A.01.20)
17. Junction IV Rev: Diode reverse bias characteristics (A.01.20)
18. Rdiff-I kelvin: Diffusion resistor R-I characteristics, Kelvin connection (A.01.11)
19. Rdiff-I: Diffusion resistor R-I characteristics (A.01.11)
20. Rdiff-V kelvin: Diffusion resistor R-V characteristics, Kelvin connection (A.01.20)
21. Rdiff-V: Diffusion resistor R-V characteristics (A.01.20)
22. R-I DVM: Low resistance measurement using 3458A, current force (A.01.20)
23. R-I kelvin: Resistor R-I characteristics, Kelvin connection (A.01.11)
24. R-I: Resistor R-I characteristics (A.01.11)
25. R-V DVM: Low resistance measurement using 3458A, voltage force (A.01.20)
26. R-V kelvin: Resistor R-V characteristics, Kelvin connection (A.01.20)
27. R-V: Resistor R-V characteristics (A.01.20)
28. VanDerPauw Square: Van Der Pauw pattern sheet resistance (A.01.11)

## 9.1 *BVgb ThinOx: MOS capacitor Ig-Vg characteristics (A.01.20)*

### [Description]

Extracts the gate current vs gate voltage ( $I_g$ - $V_g$ ) characteristics of MOS capacitor which has an ultra thin gate insulator. The primary sweep channel applies the quasi-pulsed voltage to Gate terminal, and measures Gate current at both pulse base and peak. The measurements are repeated  $ABS(V_{gStop}-V_{gStart})/V_{gStep}$  times to extract the  $I_g$ - $V_g$  characteristics. The pulse base value is the primary sweep start value and can be set by the  $V_{gLow}$  parameter. The pulse peak value is the primary sweep stop value and corresponds to  $V_g$ .

### [Device Under Test]

MOS capacitor

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate, primary sweep voltage output

VgStart: Pulse peak start value

VgStop: Pulse peak stop value

VgStep: Pulse peak step value

VgLow: Pulse base value, primary sweep start value

IgLimit: Gate current compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

$V_{gStart}$ ,  $V_{gStop}$ ,  $V_{gStep}$  values are used to calculate the primary sweep stop value.

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Gate current  $I_{gate}$

Substrate current  $I_{subs}$

### [User Function]

Gate current per Gate unit area  $I_{gatePerArea}=I_{gate}/L_g/W_g$

Substrate current per Gate unit area  $I_{subsPerArea}=I_{subs}/L_g/W_g$

### [Calculation After Measurement]

Buffer=getVectorData("Vgate")

V\_gate=storeAt(Vgate,I,1,at(Buffer,2,1))

Buffer=getVectorData("Igate")

I\_gate=storeAt(Igate,I,1,at(Buffer,2,1))

I\_gate@LowVg=storeAt(Igate,I,1,at(Buffer,1,1))

Val=at(Buffer,1,1)

Val=Val/Lg/Wg\*1E-12

I\_gate@LowVgPerArea=storeAt(I\_gate@LowVgPerArea,I,1,Val)

```
Buffer=getVectorData("IgatePerArea")
I_gatePerArea=storeAt(I_gatePerArea,I,1,at(Buffer,1,1))
I=I+1
```

[Test Output: X-Y Graph]

X axis: Gate voltage V\_gate (LINEAR)  
Y1 axis: Gate current I\_gate (LOG)  
Y2 axis: Gate current at pulse base voltage I\_gate@LowVg (LOG)

[Test Output: List Display]

Gate voltage V\_gate  
Gate current I\_gate  
Gate current at pulse base voltage I\_gate@LowVg  
Gate current per Gate unit area I\_gatePerArea  
I\_gate@LowVg per Gate unit area I\_gate@LowVgPerArea

## 9.2 *BVgb: MOS capacitor Gate-Substrate breakdown voltage (A.01.20)*

### [Description]

Measures the gate current vs gate voltage characteristics and extracts the breakdown voltage between gate and substrate (BVgb) of MOS capacitor.

### [Device Under Test]

MOS capacitor

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Ig@BVgb: Gate current to decide the breakdown

Gate: SMU connected to Gate, primary sweep voltage output

VgStart: Sweep start voltage for Gate

VgStop: Sweep stop voltage for Gate

VgStep: Sweep step voltage for Gate

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

### [Measurement Parameters]

Gate current Igate

For the all terminals, the SMU current compliance is set to  $Ig@BVgb * 1.1$ .

### [User Function]

Gate current per Gate unit area  $Igate\_Area = Igate / Lg / Wg$

### [Analysis Function]

$BVgb = @L1X$  (X intercept of Line1)

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Gate current Igate (LOG)

Y2 axis: Gate current per Gate unit area Igate\_Area (LOG)

### [Parameters Display Area]

Gate-Substrate breakdown voltage BVgb

### [Auto Analysis]

Line1: Vertical line through Y1 data at  $Igate = Ig@BVgb$



### 9.3 Cgb-Freq[2] Log: Cgb-f characteristics, 2 terminals (A.01.20)

#### [Description]

Measures MOS capacitor's characteristics of gate-to-substrate capacitance (Cgb, linear) vs frequency (f, log). The measurement frequency is 10 points per decade.

#### [Device Under Test]

MOS capacitor, 2 terminals

Connect CMU High and CMU Low to the substrate and gate respectively.

#### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

#### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value)

Lg: Gate length

Wg: Gate width

Temp: Temperature (deg)

#### [Test Parameters]

IntegTime: Integration time

FreqStart: Sweep start frequency, LOG sweep

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Gate: CMU connected to Gate terminal

Vgs: Voltage for Gate terminal, constant voltage

#### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

#### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

#### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

#### [X-Y Plot]

X axis: Frequency Freq (LOG)

Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

#### [List Display]

Frequency Freq  
Gate capacitance (parallel capacitance) Cp  
Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Substrate voltage Vsubs

[Test Output: X-Y Graph]

X axis: Frequency list FreqList (LOG)

Y1 axis: Gate capacitance (parallel capacitance) list CpList (LINEAR)

Y2 axis: Conductance list GList (LINEAR)

[Test Output: List Display]

Frequency FreqList

Gate capacitance (parallel capacitance) CpList

Conductance GList

Series capacitance CsList

Series resistance RsList

Parallel resistance RpList

Dissipation factor DList

Reactance XList

Impedance ZList

Phase ThetaList

Substrate voltage VsubsList

## 9.4 Cgb-Vg 2Freq: MOS capacitor Cgb-Vg characteristics, 2-frequency method (A.01.11)

### [Description]

Measures the Gate-Substrate capacitance (Cgb) by using two-frequency method, and plots the Cgb-Vg characteristics.

DC bias output is performed from -VgbStart to -VgbStop in -VgbStep steps.

The Cgb value is given by the following formula. Then C1 and C2 are capacitance, D1 and C2 are dissipation factor measured at the frequency (f1 and f2).

$$C_{gb} = [f1^2 * C1 * (1 + D1^2) - f2^2 * C2 * (1 + D2^2)] / [f2^2 - f1^2]$$

### [Device Under Test]

MOS capacitor

Connect Gate to the CMU Low, and Substrate to the CMU High.

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ1: Measurement frequency #1

FREQ2: Measurement frequency #2

OscLevel: Measurement signal level

Gate: CMU connected between Gate and channel (CV sweep measurement)

VgbStart: DC bias start voltage

VgbStop: DC bias stop voltage

VgbStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Dissipation factor D

### [User Function]

Vgb=-Vsubs

### [Display Setup: X-Y Graph]

X axis: Gate voltage Vgb (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

### [Display Setup: List Display]

Measurement frequency Freq

Gate voltage Vgb

Gate capacitance (parallel capacitance) Cp

Dissipation factor D

[Test Output: X-Y Graph]

X axis: Gate voltage VGB (LINEAR)

Y1 axis: Gate capacitance (parallel capacitance) Cgb (LINEAR)

Y2 axis: Gate capacitance (parallel capacitance) Cp\_FREQ1 (LINEAR)

Y3 axis: Gate capacitance (parallel capacitance) Cp\_FREQ2 (LINEAR)

[Test Output: List Display]

Gate voltage VGB

Gate capacitance (parallel capacitance) Cgb

Gate capacitance (parallel capacitance) Cp\_FREQ1

Gate capacitance (parallel capacitance) Cp\_FREQ2

Dissipation factor D\_FREQ1

Dissipation factor D\_FREQ2

## 9.5 Cgb-Vg[2]: MOS capacitor Cgb-Vg characteristics (A.01.11)

### [Description]

Measures the Gate-Substrate capacitance (Cgb), and plots the Cgb-Vg characteristics.  
DC bias output is performed from -VgbStart to -VgbStop in -VgbStep steps.

### [Device Under Test]

MOS capacitor  
Connect Gate to the CMU Low, and Substrate to the CMU High.

### [Device Parameters]

Polarity: Nch (CMU forces the specified value) or Pch (CMU forces the negative specified value).  
Lg: Gate length  
Wg: Gate width  
Temp: Temperature

### [Test Parameters]

IntegTime: Integration time  
FREQ: Measurement frequency  
OscLevel: Measurement signal level  
Gate: CMU connected between Gate and channel (CV sweep measurement)  
VgbStart: DC bias start voltage  
VgbStop: DC bias stop voltage  
VgbStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time  
DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp  
Conductance G

### [User Function]

PI=3.141592653589  
 $D=G/(2*PI*FREQ*Cp)$   
 $Rp=1/G$   
 $Cs=(1+D^2)*Cp$   
 $X=-1/(2*PI*FREQ*Cs)$   
 $Rs=D*abs(X)$   
 $Z=sqrt(Rs^2+X^2)$   
 $Theta=atan(X/Rs)$   
 $Vgate=-Vsubs$   
 $CpPerArea=Cp/Lg/Wg$   
 $CpPerWg=Cp/Wg$

### [X-Y Graph]

X axis: Gate voltage Vgate (LINEAR)  
Y1 axis: Gate capacitance (parallel capacitance) Cp (LINEAR)  
Y2 axis: Conductance G (LINEAR)

### [List Display]

Gate voltage Vgate  
Gate capacitance (parallel capacitance) Cp

Conductance G  
Series capacitance Cs  
Series resistance Rs  
Parallel resistance Rp  
Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta  
Gate-Substrate capacitance per Gate unit area CpPerArea  
Gate-Substrate capacitance per Gate unit width CpPerWg

## 9.6 *Cj-Freq Log: Cj-f characteristics, junction device (A.01.20)*

### [Description]

Measures the junction capacitance ( $C_j$ , linear) vs frequency ( $f$ , log) characteristics of a junction device. The measurement frequency is 10 points per decade.

### [Device Under Test]

Junction device (diode), 2 terminals

Connect CMU High and CMU Low to the anode and cathode respectively.

### [Required Modules and Accessories]

Agilent B1520A MFCMU 1 unit

### [Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time

FreqStart: Sweep start frequency, LOG sweep

NoOfDecade: Number of decades for data collection

OscLevel: Measurement signal level

Anode: CMU connected between Anode and Cathode

Vanode: Voltage applied on Anode

### [Extended Test Parameters]

G\_Min: Minimum transconductance value for graph

G\_Max: Maximum transconductance value for graph

Cp\_Min: Minimum capacitance value for graph

Cp\_Max: Maximum capacitance value for graph

### [Measurement Parameters]

Parallel capacitance  $C_p$

Conductance  $G$

### [User Function]

Circular constant  $PI=3.141592653589$

Frequency  $Frequency=Freq$

Dissipation factor  $D=G/(2*PI*Freq*Cp)$

Parallel resistance  $Rp=1/G$

Series capacitance  $Cs=(1+D^2)*Cp$

Reactance  $X=-1/(2*PI*Freq*Cs)$

Series resistance  $Rs=D*abs(X)$

Impedance  $Z=sqrt(Rs^2+X^2)$

Phase Theta= $atan(X/Rs)$

### [X-Y Plot]

X axis: Frequency  $Freq$  (LOG)

Y1 axis: Junction capacitance (parallel capacitance)  $Cp$  (LINEAR)

Y2 axis: Conductance  $G$  (LINEAR)

### [List Display]

Frequency  $Freq$

Anode voltage  $V_{anode}$   
Junction capacitance (parallel capacitance)  $C_p$   
Conductance  $G$   
Series capacitance  $C_s$   
Series resistance  $R_s$   
Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $\Theta$

[Test Output: X-Y Graph]

X axis: Frequency list  $FreqList$  (LOG)

Y1 axis: Gate capacitance (parallel capacitance) list  $CpList$  (LINEAR)

Y2 axis: Conductance list  $GList$  (LINEAR)

[Test Output: List Display]

Frequency  $FreqList$

Anode voltage  $VaList$

Gate capacitance (parallel capacitance)  $CpList$

Conductance  $GList$

Series capacitance  $CsList$

Series resistance  $RsList$

Parallel resistance  $RpList$

Dissipation factor  $DList$

Reactance  $XList$

Impedance  $ZList$

Phase  $\Theta List$



## 9.7 *Cj-V: Junction capacitance Cj-V characteristics (A.01.11)*

### [Description]

Measures the junction capacitance (Cj), and plots the Cj-V characteristics.

### [Device Under Test]

Junction device, diode

### [Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

Anode: CMU connected between Anode and Cathode (CV sweep measurement)

VacStart: DC bias start voltage

VacStop: DC bias stop voltage

VacStep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

Vgate=-Vsubs

$CpPerArea=Cp/L/W$

$CpPerWg=Cp/W$

### [X-Y Graph]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Junction capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

### [List Display]

Anode voltage Vanode

Junction capacitance (parallel capacitance) Cp

Conductance G

Series capacitance Cs

Series resistance Rs

Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $\Theta$   
Junction capacitance per unit area  $C_{pPerArea}$   
Junction capacitance per unit width  $C_{pPerWg}$

## **9.8 Diode BVAndCj-V ASU : Diode junction capacitance and breakdown voltage measurement using ASUs (A.01.20)**

### [Description]

Measures the reverse bias junction capacitance and breakdown voltage by using one MFCMU and two sets of the HRSMU/ASU.

### [Device Under Test]

Diode

### [Required Modules and Accessories]

One MFCMU module and two sets of HRSMU/ASU are required.

ASU#1 connections: Output: anode, SMU: HRSMU, AUX: MFCMU High

ASU#2 connections: Output: cathode, SMU: HRSMU, AUX: MFCMU Low

Connection wire must be connected between the CMU Return terminals of ASUs.

Setting of ASU I/O Path, ASU tab, Configuration window: AUX

### [Device Parameters]

L: Diode length

W: Diode width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

### [Test Parameters: for Junction Capacitance Measurements]

AnodeAC: CMU connected to Anode terminal

FREQ: Measurement frequency

OscLevel: Measurement signal level

VBiasStart: DC bias start voltage

VBiasStop: DC bias stop voltage

VBiasStep: DC bias step voltage

### [Test Parameters: for Breakdown Voltage Measurements]

AnodeDC: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Ianode@BV: Anode current to decide the breakdown

CathodeDC: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

### [Junction Capacitance Measurements: Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [Junction Capacitance Measurements: X-Y Plot]

X axis: Anode voltage (LINEAR)

Y1 axis: Junction capacitance Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[Junction Capacitance Measurements: List Display]

Impedance Z

Phase Theta

Series capacitance Cs

Series resistance Rs

Parallel resistance Rp

Dissipation factor D

Reactance X

Capacitance per junction unit area Cp\_S

[Junction Capacitance Measurements: Parameters Display Area]

Zero bias capacitance value Cj0

[Breakdown Voltage Measurements: Measurement Parameters]

Anode current

For the anode terminal, the SMU current compliance is set to  $I_{\text{anode@BD}} * 1.1$ .

[Breakdown Voltage Measurements: User Function]

Anode current per junction unit area  $I_{\text{anode\_S}}$

[Breakdown Voltage Measurements: X-Y Plot]

X axis: Anode voltage (LINEAR)

Y1 axis: Anode current (LOG)

[Breakdown Voltage Measurements: Parameters Display Area]

Junction breakdown voltage BV

Zero bias capacitance value Cj0

## **9.9 Diode BVAndCj-V SCUU: Diode junction capacitance and breakdown voltage measurement using SCUU (A.01.20)**

### [Description]

Measures the reverse bias junction capacitance and breakdown voltage by using one MFCMU, two SMUs, and a set of SCUU/GSWU.

### [Device Under Test]

Diode

### [Required Modules and Accessories]

One MFCMU module, two SMU modules, and a set of SCUU/GSWU are required.

SCUU connections: Output1: anode, Output2: cathode

Connection wire must be connected between the GSWU and the DUT interface High/Low guard lines for the capacitance measurements.

### [Device Parameters]

L: Diode length

W: Diode width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

### [Test Parameters: for Junction Capacitance Measurements]

AnodeAC: CMU connected to Anode terminal

FREQ: Measurement frequency

OscLevel: Measurement signal level

VBiasStart: DC bias start voltage

VBiasStop: DC bias stop voltage

VBiasStep: DC bias step voltage

### [Test Parameters: for Breakdown Voltage Measurements]

AnodeDC: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Ianode@BV: Anode current at breakdown

CathodeDC: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

### [Junction Capacitance Measurements: Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [Junction Capacitance Measurements: X-Y Plot]

X axis: Anode voltage (LINEAR)

Y1 axis: Junction capacitance Cp (LINEAR)

Y2 axis: Conductance G (LINEAR)

[Junction Capacitance Measurements: List Display]

Impedance Z

Phase Theta

Series capacitance Cs

Series resistance Rs

Parallel resistance Rp

Dissipation factor D

Reactance X

Capacitance per junction unit area Cp\_S

[Junction Capacitance Measurements: Parameters Display Area]

Zero bias capacitance value Cj0

[Breakdown Voltage Measurements: Measurement Parameters]

Anode current

For the anode terminal, the SMU current compliance is set to  $I_{anode}@BD*1.1$ .

[Breakdown Voltage Measurements: User Function]

Anode current per junction unit area  $I_{anode\_S}$

[Breakdown Voltage Measurements: X-Y Plot]

X axis: Anode voltage (LINEAR)

Y1 axis: Anode current (LOG)

[Breakdown Voltage Measurements: Parameters Display Area]

Junction breakdown voltage BV

Zero bias capacitance value Cj0

## **9.10 *I<sub>g</sub>-V<sub>g</sub> I<sub>force</sub>: MOS capacitor I<sub>g</sub>-V<sub>g</sub> characteristics, current sweep (A.01.20)***

### [Description]

Measures gate current vs gate voltage ( $I_g$ - $V_g$ ) characteristics of MOS capacitor gate insulator.

### [Device Under Test]

MOS capacitor

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep current output

IgStart: Sweep start current for Gate terminal

IgStop: Sweep stop current for Gate terminal

VgLimit: Gate voltage compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Gate voltage  $V_{gate}$

Substrate current  $I_{subs}$

### [User Function]

IgatePerArea: Gate current per unit gate area  $I_{gatePerArea} = I_{gate} / L_g / W_g$

IsubsPerArea: Substrate current per unit gate area  $I_{subsPerArea} = I_{subs} / L_g / W_g$

### [X-Y Plot]

X axis: Gate current  $I_{gate}$  (LOG)

Y1 axis: Gate voltage  $V_{gate}$  (LINEAR)

## **9.11 Ig-Vg Vforce: MOS capacitor Ig-Vg characteristics, voltage sweep (A.01.20)**

### [Description]

Measures gate current vs gate voltage (Ig-Vg) characteristics of MOS capacitor gate insulator.

### [Device Under Test]

MOS capacitor

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Subs: SMU connected to Substrate, constant voltage output

Vsubs: Substrate voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

GateMinRng: Minimum range for the gate current measurement

SubsMinRng: Minimum range for the substrate current measurement

### [Measurement Parameters]

Gate current Igate

Substrate current Isubs

### [User Function]

IgatePerArea: Gate current per unit gate area  $I_{gatePerArea} = I_{gate} / L_g / W_g$

IsubsPerArea: Substrate current per unit gate area  $I_{subsPerArea} = I_{subs} / L_g / W_g$

### [X-Y Plot]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Gate current Igate (LOG)

### [List Display]

Gate voltage Vgate

Gate current Igate

Substrate current Isubs



## 9.12 Interconnect CouplingCap: Interconnection capacitance (A.01.11)

### [Application]

Measures the interconnection capacitance, and plots the C-V characteristics.

### [Device Under Test]

Capacitor generated between two interconnections in the same layer

### [Device Parameters]

L: Metal length

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

MetalA: CMU connected between MetalA and MetalB (CV sweep measurement)

Vstart: DC bias start voltage

Vstop: DC bias stop voltage

Vstep: DC bias step voltage

### [Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Parallel capacitance Cp

Conductance G

### [User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

$CsPerLength=Cs/L$

$CpPerLength=Cp/L$

### [X-Y Graph]

X axis: DC bias VmetalA (LINEAR)

Y1 axis: Interconnection capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

Y3 axis: Conductance G (LINEAR)

### [List Display]

Measurement frequency Freq

DC bias VmetalA

Interconnection capacitance (parallel capacitance) Cp

Conductance G

Series capacitance Cs

Series resistance Rs

Parallel resistance  $R_p$   
Dissipation factor  $D$   
Reactance  $X$   
Impedance  $Z$   
Phase  $\Theta$   
Cs per unit length  $C_{pPerLength}$   
Cp per unit length  $C_{pPerLength}$

### ***9.13 Interconnect OverlapCap: Layer to layer film capacitance (A.01.11)***

[Application]

Measures the capacitance of the film between two interconnection layers, and plots the C-V characteristics.

[Device Under Test]

Film capacitor generated between two interconnection layers

[Device Parameters]

L: Metal length

W: Metal width

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

FREQ: Measurement frequency

OscLevel: Measurement signal level

MetalA: CMU connected between MetalA and MetalB (CV sweep measurement)

Vstart: DC bias start voltage

Vstop: DC bias stop voltage

Vstep: DC bias step voltage

[Extended Test Parameters]

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Parallel capacitance Cp

Conductance G

[User Function]

PI=3.141592653589

$D=G/(2*PI*FREQ*Cp)$

$Rp=1/G$

$Cs=(1+D^2)*Cp$

$X=-1/(2*PI*FREQ*Cs)$

$Rs=D*abs(X)$

$Z=sqrt(Rs^2+X^2)$

$Theta=atan(X/Rs)$

[X-Y Graph]

X axis: DC bias VmetalA (LINEAR)

Y1 axis: Film capacitance (parallel capacitance) Cp (LINEAR)

Y2 axis: Dissipation factor D (LINEAR)

Y3 axis: Conductance G (LINEAR)

[List Display]

Measurement frequency Freq

DC bias VmetalA

Film capacitance (parallel capacitance) Cp

Conductance G

Series capacitance Cs

Series resistance Rs

Parallel resistance Rp

Dissipation factor D  
Reactance X  
Impedance Z  
Phase Theta

## **9.14 Junction BV: Junction device breakdown voltage (A.01.20)**

### [Description]

Measures the junction device reverse bias characteristics, and extracts the breakdown voltage.

### [Device Under Test]

Junction device, diode

### [Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Ianode@BV: Anode current to decide the breakdown

Anode: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Cathode: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

### [Measurement Parameters]

Anode current Ianode

Cathode current Icathode

### [User Function]

IanodePerArea=Ianode/L/W

IcathodePerArea=Icathode/L/W

### [Analysis Function]

BV=@L1X (X intercept of Line1)

### [X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Anode current Ianode (LINEAR)

Y2 axis: Anode current Ianode (LOG)

Y3 axis: Cathode current Icathode (LINEAR)

Y4 axis: Cathode current Icathode (LOG)

### [List Display]

Anode voltage Vanode

Anode current Ianode

Anode current per unit area IanodePerArea

Cathode current Icathode

Cathode current per unit area IcathodePerArea

### [Parameters Display Area]

Junction breakdown voltage BV

[Auto Analysis]

Line1: Vertical line through Y1 data at I<sub>anode</sub>=I<sub>anode</sub>@BV

## 9.15 Junction DcParam: Junction device DC parameters (Is,N,Rs) (A.01.20)

### [Description]

Measures the forward bias anode voltage vs anode current characteristics, and extracts the slope minimum value (N\_Min), the reverse direction saturation current minimum value (IsMin, IsMin2), and the series resistance (Rs).

### [Device Under Test]

Junction device, diode

### [Device Parameters]

L: Junction length  
W: Junction width  
Temp: Temperature  
Imax: Current compliance

### [Test Parameters]

IntegTime: Integration time  
Anode: SMU connected to Anode terminal, primary sweep voltage output  
VanodeStart: Sweep start voltage for Anode terminal  
VanodeStop: Sweep stop voltage for Anode terminal  
VanodeStep: Sweep step voltage for Anode terminal  
Cathode: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

Vcathode: Cathode voltage  
HoldTime: Hold time  
DelayTime: Delay time  
AnodeMinRng: Minimum range for the anode current measurement

### [Measurement Parameters]

Anode current Ianode  
Cathode current Icathode

### [User Function]

$I_{anodePerArea} = I_{anode} / L / W$   
 $I_{cathodePerArea} = I_{cathode} / L / W$   
 $V_t = k * (Temp + 273.15) / q$   
 $N = 1 / V_t / (\text{diff}(\log(I_{anode}), V_{anode}))$   
 $N\_Min = \min(N)$   
 $Slope = \text{diff}(\log(I_{anode}), V_{anode})$   
 $I_s = \log(I_{anode}) - Slope * V_{anode}$   
 $I_{sMin} = \min(I_s)$   
 $SmplNum = \text{abs}((V_{anodeStop} - V_{anodeStart}) / V_{anodeStep}) + 1$   
 $I_{Rs} = \text{at}(I_{anode}, SmplNum, 1)$   
 $\Delta V_{Rs} = V_{anodeStop} - N\_Min * V_t * \log(I_{Rs} / I_{sMin})$   
 $R_s = \Delta V_{Rs} / I_{Rs}$

### [Analysis Function]

IsMin2=@L1Y (Y intercept of Line1)

### [X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)  
Y1 axis: Anode current Ianode (LOG)

Y2 axis: Anode current  $I_{anode}$  (LINEAR)

Y3 axis: Slope N (LINEAR)

[Parameters Display Area]

Slope minimum value  $N\_Min$

Reverse direction saturation current minimum value  $IsMin$

Reverse direction saturation current minimum value  $IsMin2$

Series resistance  $R_s$

[Auto Analysis]

Line1: Tangent line through Y1 data at  $Slope = \max(Slope)$



## **9.16 Junction IV Fwd: Diode forward bias characteristics (A.01.20)**

### [Description]

Measures the forward bias anode voltage vs anode current characteristics.

### [Device Under Test]

Junction device, diode

### [Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature

Imax: Current compliance

### [Test Parameters]

IntegTime: Integration time

Anode: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

Cathode: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

### [Measurement Parameters]

Anode current I<sub>anode</sub>

Cathode current I<sub>cathode</sub>

### [User Function]

$I_{anodePerArea} = I_{anode} / L / W$

$I_{cathodePerArea} = I_{cathode} / L / W$

### [X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Anode current I<sub>anode</sub> (LINEAR)

Y2 axis: Anode current I<sub>anode</sub> (LOG)

## **9.17 Junction IV Rev: Diode reverse bias characteristics (A.01.20)**

### [Description]

Measures the reverse bias anode voltage vs anode current characteristics.

### [Device Under Test]

Junction device, diode

### [Device Parameters]

L: Junction length

W: Junction width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Anode: SMU connected to Anode terminal, primary sweep voltage output

VanodeStart: Sweep start voltage for Anode terminal

VanodeStop: Sweep stop voltage for Anode terminal

VanodeStep: Sweep step voltage for Anode terminal

IanodeLimit: Anode current compliance

Cathode: SMU connected to Cathode terminal, constant voltage output

### [Extended Test Parameters]

Vcathode: Cathode voltage

HoldTime: Hold time

DelayTime: Delay time

AnodeMinRng: Minimum range for the anode current measurement

### [Measurement Parameters]

Anode current Ianode

Cathode current Icathode

### [User Function]

$I_{anodePerArea} = I_{anode} / L / W$

$I_{cathodePerArea} = I_{cathode} / L / W$

### [X-Y Plot]

X axis: Anode voltage Vanode (LINEAR)

Y1 axis: Anode current Ianode (LOG)

Y2 axis: Cathode current Icathode (LOG)

## **9.18 Rdiff-I kelvin: Diffusion resistor R-I characteristics, Kelvin connection (A.01.11)**

### [Description]

Measures the resistance vs current characteristics (R-I characteristic).

### [Device Under Test]

Diffusion resistor, 3 terminals

Connect the Port1 and VM1 modules to a terminal, the Port2 and VM2 modules to the other terminal.

### [Device Parameters]

Polarity: Ntype (SMUs force the specified value) or Ptype (SMUs force the negative specified value).

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep current output

I1Start: Primary sweep start current

I1Stop: Primary sweep stop current

I1Step: Primary sweep step current

V1Limit: Port1 voltage compliance

Subs: SMU connected to substrate, secondary sweep voltage output

VsubsStart: Secondary sweep start voltage

VsubsStop: Secondary sweep stop voltage

VsubsStep: Secondary sweep step voltage

IsubsLimit: Subs current compliance

Port2: SMU connected to resistor, constant voltage output

VM1: SMU connected to resistor, constant current output

VM2: SMU connected to resistor, constant current output

### [Extended Test Parameters]

V2: Port2 output voltage

IM1: VM1 output current

IM2: VM2 output current

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Port1 measurement voltage V1

VM1 measurement voltage Vm1

VM2 measurement voltage Vm2

### [User Function]

Voltage between terminals  $\Delta V = V_{m1} - V_{m2}$

Resistance  $R = \Delta V / I_1$

Sheet resistance  $R_{sheet} = R * W / L$

### [X-Y Graph]

X axis: Port1 output current I1 (LINEAR)

Y1 axis: Resistance R (LINEAR)

Y2 axis: Voltage between terminals  $\Delta V$  (LINEAR)

[List Display]

Port1 output current I1

Port1 measurement voltage V1

Subs output voltage Vsubs

Voltage between terminals DeltaV

Resistance R

Sheet resistance Rsheet

## 9.19 Rdiff-I: Diffusion resistor R-I characteristics (A.01.11)

### [Description]

Measures the resistance vs current characteristics (R-I characteristic).

### [Device Under Test]

Diffusion resistor, 3 terminals

### [Device Parameters]

Polarity: Ntype (SMUs force the specified value) or Ptype (SMUs force the negative specified value).

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep current output

I1Start: Primary sweep start current

I1Stop: Primary sweep stop current

I1Step: Primary sweep step current

V1Limit: Port1 voltage compliance

Subs: SMU connected to substrate, secondary sweep voltage output

VsubsStart: Secondary sweep start voltage

VsubsStop: Secondary sweep stop voltage

VsubsStep: Secondary sweep step voltage

IsubsLimit: Subs current compliance

Port2: SMU connected to resistor, constant voltage output

### [Extended Test Parameters]

V2: Port2 output voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Port1 measurement voltage V1

### [User Function]

Resistance  $R=V1/I1$

Sheet resistance  $R_{sheet}=R*W/L$

### [X-Y Graph]

X axis: Port1 output current I1 (LINEAR)

Y1 axis: Port1 measurement voltage V1 (LINEAR)

Y2 axis: Resistance R (LINEAR)

### [List Display]

Port1 output current I1

Port1 measurement voltage V1

Resistance R

Sheet resistance Rsheet

## **9.20 Rdiff-V kelvin: Diffusion resistor R-V characteristics, Kelvin connection (A.01.20)**

### [Description]

Measures the resistance vs voltage characteristics (R-V characteristic).

### [Device Under Test]

Diffusion resistor, 3 terminals

Connect the Port1 and VM1 modules to a terminal, the Port2 and VM2 modules to the other terminal.

### [Device Parameters]

Polarity: Ntype (SMUs force the specified value) or Ptype (SMUs force the negative specified value).

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep voltage output

V1Start: Primary sweep start voltage

V1Stop: Primary sweep stop voltage

V1Step: Primary sweep step voltage

I1Limit: Port1 current compliance

Subs: SMU connected to substrate, secondary sweep voltage output

VsubsStart: Secondary sweep start voltage

VsubsStop: Secondary sweep stop voltage

VsubsStep: Secondary sweep step voltage

IsubsLimit: Subs current compliance

Port2: SMU connected to resistor, constant voltage output

VM1: SMU connected to resistor, constant current output

VM2: SMU connected to resistor, constant current output

### [Extended Test Parameters]

V2: Port2 output voltage

IM1: VM1 output current

IM2: VM2 output current

HoldTime: Hold time

DelayTime: Delay time

Port1MinRng: Minimum range for the port1 current measurement

### [Measurement Parameters]

Port1 measurement current I1

VM1 measurement voltage Vm1

VM2 measurement voltage Vm2

### [User Function]

Voltage between terminals  $\Delta V = V_{m1} - V_{m2}$

Resistance  $R = \Delta V / I_1$

Sheet resistance  $R_{sheet} = R * W / L$

### [X-Y Graph]

X axis: Port1 output voltage V1 (LINEAR)

Y1 axis: Port1 measurement current I1 (LINEAR)

Y2 axis: Resistance R (LINEAR)

[List Display]

Port1 output voltage V1

Voltage between terminals DeltaV

Port1 measurement current I1

Resistance R

Sheet resistance Rsheet

## 9.21 Rdiff-V: Diffusion resistor R-V characteristics (A.01.20)

### [Description]

Measures the resistance vs voltage characteristics (R-V characteristic).

### [Device Under Test]

Diffusion resistor, 3 terminals

### [Device Parameters]

Polarity: Ntype (SMUs force the specified value) or Ptype (SMUs force the negative specified value).

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep voltage output

V1Start: Primary sweep start voltage

V1Stop: Primary sweep stop voltage

V1Step: Primary sweep step voltage

IILimit: Port1 current compliance

Subs: SMU connected to substrate, secondary sweep voltage output

VsubsStart: Secondary sweep start voltage

VsubsStop: Secondary sweep stop voltage

VsubsStep: Secondary sweep step voltage

IsubsLimit: Subs current compliance

Port2: SMU connected to resistor, constant voltage output

### [Extended Test Parameters]

V2: Port2 output voltage

HoldTime: Hold time

DelayTime: Delay time

Port1MinRng: Minimum range for the port1 current measurement

### [Measurement Parameters]

Port1 measurement current I1

### [User Function]

Resistance  $R=V1/I1$

Sheet resistance  $R_{sheet}=R*W/L$

### [X-Y Graph]

X axis: Port1 output voltage V1 (LINEAR)

Y1 axis: Resistance R (LINEAR)

Y2 axis: Port1 measurement current I1 (LINEAR)

### [List Display]

Port1 output voltage V1

Port1 measurement current I1

Resistance R

Sheet resistance Rsheet



## **9.22 R-I DVM: Low resistance measurement using 3458A, current force (A.01.20)**

### [Description]

Measures the low resistance of a 2-terminal device. SMU forces current and DVM (3458A) measures voltage between terminals. Resistance is calculated from the output value of a current and measured value of a voltage between terminals. For the purpose of excluding thermoelectric power, this test is designed to measure resistance again by switching the direction of voltage and to get the average value of resistance as a test result.

### [Device Under Test]

Resistor element, 2 terminals

### [Required Modules and Accessories]

Agilent 3458A digital multimeter 1 unit  
GPIB cable

### [Required Test Definition]

Measure Diff-V

### [Device Parameters]

L: Resistor length  
W: Resistor width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time  
Port1: SMU connected to resistor, current output  
I1: Applied current  
V1Limit: Port1 voltage compliance  
Port2: SMU connected to resistor, constant voltage output  
GPIB\_Adr: GPIB address of DVM

### [Extended Test Parameters]

V2: Port2 output voltage  
HoldTime: Hold time  
DelayTime: Delay time  
PortMinRng: Minimum range for port current measurement

### [Measurement Parameters]

[Measurement Parameters for first measurement (Vpos)]

Vport1: Port1 voltage

[Measurement Parameters for second measurement (Vneg)]

Vport2: Port2 voltage

### [X-Y Plot]

[X-Y Plot for first measurement (Vpos)]

X axis: Applied current Iport1 (LINEAR)

Y1 axis: Measured voltage Vport1 (LINEAR)

[X-Y Plot for second measurement (Vneg)]

X axis: Applied current Iport2 (LINEAR)

Y1 axis: Measured voltage Vport2 (LINEAR)

[List Display]

[X-Y Plot for first measurement (Vpos)]

Applied current Iport1

Measured voltage Vport1

[X-Y Plot for second measurement (Vneg)]

Applied current Iport2

Measured voltage Vport2

[Test Output: X-Y Graph]

X axis: Applied current IsmuList (LINEAR)

Y1 axis: DVM measurement result voltage VdvmList (LINEAR)

Y2 axis: Measured voltage VsmuList (LINEAR)

Y3 axis: Resistance value (LINEAR)

[Test Output: List Display]

IsmuList: Applied current

VsmuList: Measured voltage

VdvmList: DVM measured voltage

RList: Resistance value

[Test Output: Parameters]

Rav: Average resistance value of 2 measurements

### **9.23 R-I kelvin: Resistor R-I characteristics, Kelvin connection (A.01.11)**

[Description]

Measures the resistance vs current characteristics (R-I characteristic).

[Device Under Test]

Resistor, 2 terminals

Connect the Port1 and VM1 modules to a terminal, the Port2 and VM2 modules to the other terminal.

[Device Parameters]

L: Resistor length

W: Resistor width

Temp: Temperature

[Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep current output

I1Start: Sweep start current

I1Stop: Sweep stop current

I1Step: Sweep step current

V1Limit: Port1 voltage compliance

Port2: SMU connected to resistor, constant voltage output

VM1: SMU connected to resistor, constant current output

VM2: SMU connected to resistor, constant current output

[Extended Test Parameters]

V2: Port2 output voltage

IM1: VM1 output current

IM2: VM2 output current

HoldTime: Hold time

DelayTime: Delay time

[Measurement Parameters]

Port1 measurement voltage V1

VM1 measurement voltage Vm1

VM2 measurement voltage Vm2

[User Function]

Voltage between terminals  $\Delta V = V_{m1} - V_{m2}$

Resistance  $R = \Delta V / I_1$

Sheet resistance  $R_{sheet} = R * W / L$

[X-Y Graph]

X axis: Port1 output current I1 (LINEAR)

Y1 axis: Resistance R (LINEAR)

Y2 axis: Voltage between terminals  $\Delta V$  (LINEAR)

[List Display]

Port1 output current I1

Port1 measurement voltage V1

Resistance R

Voltage between terminals  $\Delta V$

## 9.24 R-I: Resistor R-I characteristics (A.01.11)

### [Description]

Measures the resistance vs current characteristics (R-I characteristic).

### [Device Under Test]

Resistor, 2 terminals

### [Device Parameters]

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep current output

I1Start: Sweep start current

I1Stop: Sweep stop current

I1Step: Sweep step current

V1Limit: Port1 voltage compliance

Port2: SMU connected to resistor, constant voltage output

### [Extended Test Parameters]

V2: Port2 output voltage

HoldTime: Hold time

DelayTime: Delay time

### [Measurement Parameters]

Port1 measurement voltage V1

### [User Function]

Resistance  $R=V1/I1$

Sheet resistance  $R_{sheet}=R*W/L$

### [X-Y Graph]

X axis: Port1 output current I1 (LINEAR)

Y1 axis: Port1 measurement voltage V1 (LINEAR)

Y2 axis: Resistance R (LINEAR)

### [List Display]

Port1 output current I1

Port1 measurement voltage V1

Resistance R

Sheet resistance  $R_{sheet}$

## **9.25 R-V DVM: Low resistance measurement using 3458A, voltage force (A.01.20)**

### [Description]

Measures the low resistance of a 2-terminal device. SMU forces voltage and measures current, and DVM (3458A) measures voltage between terminals. Resistance is calculated from the measured value of a current and that of a voltage between terminals. For the purpose of excluding thermoelectric power, this test is designed to measure resistance again by switching the direction of voltage and to get the average value of resistance as a test result.

### [Device Under Test]

Resistor element, 2 terminals

### [Required Modules and Accessories]

Agilent 3458A digital multimeter 1 unit  
GPIB cable

### [Required Test Definition]

Measure Diff-V

### [Device Parameters]

L: Resistor length  
W: Resistor width  
Temp: Temperature (deg)

### [Test Parameters]

IntegTime: Integration time  
Port1: SMU connected to resistor, voltage output  
V1: Applied voltage  
IILimit: Port1 current compliance  
Port2: SMU connected to resistor, constant voltage output  
GPIB-Adr: GPIB address of DVM

### [Extended Test Parameters]

V2: Output voltage  
HoldTime: Hold time  
DelayTime: Delay time  
PortMinRng: Minimum range for port current measurement

### [Measurement Parameters]

[Measurement Parameters for first measurement (Vpos)]  
Iport2: Measured current

[Measurement Parameters for second measurement (Vneg)]  
Iport1: Measured current

### [X-Y Plot]

[X-Y Plot for first measurement (Vpos)]  
X axis: Applied voltage on Port1 Vport1 (LINEAR)  
Y1 axis: Measured current Iport2 (LINEAR)

[X-Y Plot for second measurement (Vneg)]  
X axis: Applied voltage on Port2 Vport2 (LINEAR)

Y1 axis: Measured current Iport1 (LINEAR)

[List Display]

[X-Y Plot for first measurement (Vpos)]

Applied voltage Vport1

Measured current Iport2

[X-Y Plot for second measurement (Vneg)]

Applied voltage Vport2

Measured current Iport1

[Test Output: X-Y Graph]

X axis: Applied voltage VsmuList (LINEAR)

Y1 axis: DVM measurement result voltage VdvmList (LINEAR)

Y2 axis: Measured current IsmuList (LINEAR)

Y3 axis: Resistance value RList (LINEAR)

[Test Output: List Display]

VdvmList: DVM measured voltage

IsmuList: Measured current

RList: Resistance value

[Test Output: Parameters]

Rav: Average resistance value of 2 measurements

## 9.26 R-V kelvin: Resistor R-V characteristics, Kelvin connection (A.01.20)

### [Description]

Measures the resistance vs voltage characteristics (R-V characteristic).

### [Device Under Test]

Resistor, 2 terminals

Connect the Port1 and VM1 modules to a terminal, the Port2 and VM2 modules to the other terminal.

### [Device Parameters]

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep voltage output

V1Start: Sweep start voltage

V1Stop: Sweep stop voltage

V1Step: Sweep step voltage

I1Limit: Port1 current compliance

Port2: SMU connected to resistor, constant voltage output

VM1: SMU connected to resistor, constant current output

VM2: SMU connected to resistor, constant current output

### [Extended Test Parameters]

V2: Port2 output voltage

IM1: VM1 output current

IM2: VM2 output current

HoldTime: Hold time

DelayTime: Delay time

Port1MinRng: Minimum range for the port1 current measurement

### [Measurement Parameters]

Port1 measurement current I1

VM1 measurement voltage Vm1

VM2 measurement voltage Vm2

### [User Function]

Voltage between terminals  $\Delta V = V_{m1} - V_{m2}$

Resistance  $R = \Delta V / I_1$

Sheet resistance  $R_{sheet} = R * W / L$

### [X-Y Graph]

X axis: Port1 output voltage V1 (LINEAR)

Y1 axis: Resistance R (LINEAR)

Y2 axis: Port1 measurement current I1 (LINEAR)

### [List Display]

Port1 output voltage V1

Voltage between terminals  $\Delta V$

Port1 measurement current I1

Resistance R

Sheet resistance  $R_{sheet}$

## 9.27 R-V: Resistor R-V characteristics (A.01.20)

### [Description]

Measures the resistance vs voltage characteristics (R-V characteristic).

### [Device Under Test]

Resistor, 2 terminals

### [Device Parameters]

L: Resistor length

W: Resistor width

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time

Port1: SMU connected to resistor, primary sweep voltage output

V1Start: Sweep start voltage

V1Stop: Sweep stop voltage

V1Step: Sweep step voltage

IILimit: Port1 current compliance

Port2: SMU connected to resistor, constant voltage output

### [Extended Test Parameters]

V2: Port2 output voltage

HoldTime: Hold time

DelayTime: Delay time

Port1MinRng: Minimum range for the port1 current measurement

### [Measurement Parameters]

Port1 measurement current I1

### [User Function]

Resistance  $R=V1/I1$

Sheet resistance  $R_{sheet}=R*W/L$

### [X-Y Graph]

X axis: Port1 output voltage V1 (LINEAR)

Y1 axis: Resistance R (LINEAR)

Y2 axis: Port1 measurement current I1 (LINEAR)

### [List Display]

Port1 output voltage V1

Port1 measurement current I1

Resistance R

Sheet resistance  $R_{sheet}$



## 9.28 VanDerPauw Square: Van Der Pauw pattern sheet resistance (A.01.11)

### [Description]

Measures the sheet resistance of the Van Der Pauw pattern, and plots the sheet resistance vs input current characteristics.

### [Device Under Test]

Van Der Pauw pattern, 4 terminals

### [Device Parameters]

Temp: Temperature

### [Test Parameters]

IntegTime: Integration time  
Port1: SMU connected to pattern, primary sweep current output  
I1Start: Sweep start current  
I1Stop: Sweep stop current  
I1Step: Sweep step current  
V1Limit: Port1 voltage compliance  
Port2: SMU connected to pattern, constant voltage output  
VM1: SMU connected to pattern, constant current output  
VM2: SMU connected to pattern, constant current output

### [Extended Test Parameters]

V2: Port2 output voltage  
IM1: VM1 output current  
IM2: VM2 output current  
HoldTime: Hold time  
DelayTime: Delay time

### [Measurement Parameters]

VM1 measurement voltage Vm1  
VM2 measurement voltage Vm2

### [User Function]

Voltage between terminals  $\Delta V = V_{m1} - V_{m2}$   
Sheet resistance  $R_{sheet} = (3.141592 / \log(2)) * (\Delta V / I1)$

### [X-Y Graph]

X axis: Port1 output current I1 (LINEAR)  
Y1 axis: Voltage between terminals  $\Delta V$  (LINEAR)  
Y2 axis: Sheet resistance  $R_{sheet}$  (LINEAR)

### [List Display]

Port1 output current I1  
Voltage between terminals  $\Delta V$   
Sheet resistance  $R_{sheet}$



## 10 TFT

1. TFT Id-Vd: TFT Id-Vd characteristics (A.01.20)
2. TFT Id-Vg: TFT Id-Vg characteristics (A.01.20)

## ***10.1 TFT Id-Vd: TFT Id-Vd characteristics (A.01.20)***

### [Description]

Measures the drain current vs drain voltage characteristic of TFT.

### [Device Under Test]

Thin Film Transistor, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Drain: SMU connected to Drain terminal, primary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Gate: SMU connected to Gate terminal, secondary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

IgLimit: Gate current compliance

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

gds: Output conductance  $gds = \text{diff}(\text{Idrain}, \text{Vdrain})$

Rds: Output resistance  $Rds = 1/gds$

### [X-Y Graph]

X axis: Drain voltage Vdrain (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

### [List Display]

Drain voltage Vdrain

Gate voltage Vgate

Drain current Idrain

Output conductance gds

Output resistance Rds

## ***10.2 TFT Id-Vg: TFT Id-Vg characteristics (A.01.20)***

### [Description]

Measures the drain current vs gate voltage characteristics of TFT.

### [Device Under Test]

Thin Film Transistor, 3 terminals

### [Device Parameters]

Polarity: Nch (SMUs force the specified value) or Pch (SMUs force the negative specified value).

Lg: Gate length

Wg: Gate width

Temp: Temperature

IdMax: Drain current compliance

### [Test Parameters]

IntegTime: Integration time

Gate: SMU connected to Gate terminal, primary sweep voltage output

VgStart: Sweep start voltage for Gate terminal

VgStop: Sweep stop voltage for Gate terminal

VgStep: Sweep step voltage for Gate terminal

IgLimit: Gate current compliance

Drain: SMU connected to Drain terminal, secondary sweep voltage output

VdStart: Sweep start voltage for Drain terminal

VdStop: Sweep stop voltage for Drain terminal

VdStep: Sweep step voltage for Drain terminal

Source: SMU connected to Source terminal, constant voltage output

### [Extended Test Parameters]

Vs: Source voltage

HoldTime: Hold time

DelayTime: Delay time

DrainMinRng: Minimum range for the drain current measurement

### [Measurement Parameters]

Drain current Idrain

### [User Function]

IdrainPerWg: Drain current per unit gate width  $I_{\text{drainPerWg}} = I_{\text{drain}} / W_{\text{g}}$

gm: Transconductance  $g_{\text{m}} = \text{diff}(I_{\text{drain}}, V_{\text{gate}})$

gmPerWg: Transconductance per unit gate width  $g_{\text{mPerWg}} = \text{diff}(I_{\text{drainPerWg}}, V_{\text{gate}})$

### [X-Y Graph]

X axis: Gate voltage Vgate (LINEAR)

Y1 axis: Drain current Idrain (LINEAR)

Y2 axis: Drain current Idrain (LOG)

Y3 axis: Transconductance gm (LINEAR)

### [List Display]

Gate voltage Vgate

Drain voltage Vdrain

Drain current Idrain

Transconductance gm

Drain current per unit gate width IdrainPerWg

Transconductance per unit gate width gmPerWg

## 11 Utility

1. ForcePG1: PG Output1 (A.01.20)
2. ForcePG2: PG Output2 (A.01.20)
3. ForcePG2P: PG Output1/Output2 (A.01.20)
4. ForcePG12: PG Output1/Output2 (A.01.20)
5. ForcePG: PG OutputX (A.01.20)
6. ForcePGC: PG Output1 Continuous Output (A.01.20)
7. Measure Diff-V: Voltage measurement by 3458A (A.01.20)
8. ResetPG: PG reset (A.01.20)
9. Subsite move: Probing next subsite (A.02.00)

## ***11.1 ForcePG1: PG Output1 (A.01.20)***

### [Description]

Sets the Output1 of the Agilent 81110A Pulse Generator, and triggers it.

### [Input Parameters]

Address: GPIB address of the Agilent 81110A Pulse Generator

Period1: Output1 pulse period [s]

Delay1: Output1 delay time [s]

Dcyc1: Output1 duty cycle [%]

Level1: Output1 pulse level [V]

Base1: Output1 base level [V]

TrigCount: Number of output pulses (1 to 65536)



## ***11.2 ForcePG2: PG Output2 (A.01.20)***

### **[Description]**

Sets the Output2 of the Agilent 81110A Pulse Generator, and triggers it.

### **[Input Parameters]**

Address: GPIB address of the Agilent 81110A Pulse Generator

Period2: Output2 pulse period [s]

Delay2: Output2 delay time [s]

Dcyc2: Output2 duty cycle [%]

Level2: Output2 pulse level [V]

Base2: Output2 base level [V]

TrigCount: Number of output pulses (1 to 65536)

### ***11.3 ForcePG2P: PG Output1/Output2 (A.01.20)***

[Description]

Sets Output1 and Output2 of Agilent 81110A Pulse Generator, and triggers it. Pulse leading/trailing edge transition time can be set.

Execute ResetPG to stop pulse output before the specified pulses are applied.

[Required Modules and Accessories]

Agilent 81110A Pulse Generator (2-output, PGU1 and PGU2)  
GPIB cable

[Test Parameters]

Address: GPIB address of Agilent 81110A Pulse Generator

Period1: Pulse period [s] for port 1

Delay1: Pulse delay time [s] for port 1

Width1: Pulse width [s] for port 1

LeadTime1: Pulse leading edge transition time [s] for port 1

TrailTime1: Pulse trailing edge transition time [s] for port 1

Level1: Pulse High level [V] for port 1

Base1: Pulse Low level [V] for port 1

ExtImp1: Load impedance [ohm] for port 1

Period2: Pulse period [s] for port 2

Delay2: Pulse delay time [s] for port 2

Width2: Pulse width [s] for port 2

LeadTime2: Pulse leading edge transition time [s] for port 2

TrailTime2: Pulse trailing edge transition time [s] for port 2

Level2: Pulse High level [V] for port 2

Base2: Pulse Low level [V] for port 2

ExtImp2: Load impedance [ohm] for port 2

NoOfPulse12: Number of output pulses

## ***11.4 ForcePG12: PG Output1/Output2 (A.01.20)***

### [Description]

Sets Output1 and Output2 of Agilent 81110A Pulse Generator, and triggers it. Pulse leading/trailing edge transition time can be set.

Execute ResetPG to stop pulse output before the specified pulses are applied.

### [Required Modules and Accessories]

Agilent 81110A Pulse Generator (2-output, PGU1 and PGU2)

GPIB cable

### [Test Parameters]

Address: GPIB address of the Agilent 81110A Pulse Generator

Period1: Output1 pulse period [s]

Delay1: Output1 delay time [s]

Dcyc1: Output1 duty cycle [%]

LeadTime1: Output1 pulse leading edge transition time [s]

TrailTime1: Output1 pulse trailing edge transition time [s]

Level1: Output1 pulse high level [V]

Base1: Output1 pulse low level [V]

ExtImp1: Output1 load impedance [ohm]

NoOfPulse12: Number of output pulses (1~65536)。

Period2: Output2 pulse period [s]

Delay2: Output2 delay time [s]

Dcyc2: Output2 duty cycle [%]

LeadTime2: Output2 pulse leading edge transition time [s]

TrailTime2: Output2 pulse trailing edge transition time [s]

Level2: Output2 pulse high level [V]

Base2: Output2 pulse low level [V]

ExtImp2: Output2 load impedance [ohm]

## ***11.5 ForcePG: PG OutputX (A.01.20)***

### [Description]

Sets Output1 or Output2 of Agilent 81110A Pulse Generator, and triggers it. Pulse leading/trailing edge transition time can be set.

Execute ResetPG to stop pulse output before the specified pulses are applied.

### [Required Modules and Accessories]

Agilent 81110A Pulse Generator (2-output, PGU1 and PGU2)

GPIB cable

### [Test Parameters]

Address: GPIB address of Agilent 81110A Pulse Generator

SelectPort: Pulse output port

Period: Pulse period [s]

Delay: Pulse delay time [s]

Width: Pulse width [s]

LeadTime: Pulse leading edge transition time [s]

TrailTime: Pulse trailing edge transition time [s]

Level: Pulse High level [V]

Base: Pulse Low level [V]

ExtImp: Load impedance [ohm]

NoOfPulse: Number of output pulses

## ***11.6 ForcePGC: PG Output1 Continuous Output (A.01.20)***

### [Description]

Sets Output1 of Agilent 81110A Pulse Generator, and triggers continuous pulse output. Pulse leading/trailing edge transition time can be set.

Execute ResetPG to stop pulse output before the specified pulses are applied.

### [Required Modules and Accessories]

Agilent 81110A Pulse Generator (2-output, PGU1 and PGU2)

GPIB cable

### [Test Parameters]

Address: GPIB address of Agilent 81110A Pulse Generator

Period1: Pulse period [s]

Delay1: Pulse delay time [s]

Dcyc1: Duty cycle [%]

LeadTime1: Pulse leading edge transition time [s]

TrailTime1: Pulse trailing edge transition time [s]

Level1: Pulse High level [V]

Base1: Pulse Low level [V]

ExtImp1: Load impedance [ohm]

## ***11.7 Measure Diff-V: Voltage measurement by 3458A (A.01.20)***

### **[Description]**

Performs voltage measurement between two terminals by using Agilent 3458A Digital Multimeter. Measurement data is stored to DVM\_Val variable.

### **[Required Modules and Accessories]**

Agilent 3458A Digital Multimeter  
GPIB cable

### **[Input Parameters]**

Adrs: GPIB address of Agilent 3458A Digital Multimeter

### **[Test Output: Analysis Parameters]**

DVM\_Val: Voltage measurement data [V]

## ***11.8 ResetPG: PG reset (A.01.20)***

[Description]

Resets Agilent 81110A Pulse Generator.

[Required Modules and Accessories]

Agilent 81110A Pulse Generator (2-output, PGU1 and PGU2)  
GPIB cable

[Input Parameter]

GPIB address of Agilent 81110A Pulse Generator

## ***11.9 Subsite move: Probing next subsite (A.02.00)***

### **[Description]**

Moves wafer prober chuck to the next subsite, reads device ID from the prober, and sets it to the Device ID of the test record.

### **[Supported Probers]**

While this application test supports Cascade Microtech, SUSS MicroTec and Vector Semiconductor wafer prober drivers as standard basis, you may specify a command path name into the CustomProber entry field to operate with a non-standard wafer prober driver.

### **[Test Parameters]**

ProberType: Type of wafer prober  
CustomProber: Command path name for non-standard wafer probers

If CustomProber is not blank, ProberType field is ignored.